



**MODEL 8**  
**ADD-ON CORE MEMORY**  
**TECHNICAL MANUAL**

**(PDP 8 I and PDP 12)**

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## TABLE OF CONTENTS

|                                      |  |
|--------------------------------------|--|
| <b>SECTION I</b>                     | <b>GENERAL INFORMATION AND SPECIFICATIONS</b>          |
| General Description .....            | 1-1  |
| Capacity .....                       | 1-1  |
| Memory Cycle .....                   | 1-1  |
| System Specifications .....          | 1-1  |
| <b>SECTION II</b>                    | <b>INSTALLATION PROCEDURES</b>                         |
| CPU Modification .....               | 2-1  |
| Assembly .....                       | 2-2  |
| Final Considerations .....           | 2-2  |
| <b>SECTION III</b>                   | <b>PRINCIPLES OF OPERATION</b>                         |
| Multiplex Assembly .....             | 3-1  |
| Control Signals .....                | 3-1  |
| Multiplex Data Path .....            | 3-1  |
| Memory .....                         | 3-4  |
| Cycle Control .....                  | 3-4  |
| Current Drive .....                  | 3-4  |
| Data Loop .....                      | 3-6  |
| Memory Operation .....               | 3-9  |
| Read Portion of the Cycle .....      | 3-9  |
| Write Portion of the Cycle .....     | 3-9  |
| <b>SECTION IV</b>                    | <b>MAINTENANCE</b>                                     |
| Recommended Test Equipment .....     | 4-1  |
| Preventive Maintenance .....         | 4-1  |
| Corrective Maintenance .....         | 4-1  |
| Memory Test Patterns and Tests ..... | 4-1  |
| Ones .....                           | 4-1  |
| Zeros .....                          | 4-2  |
| Worst Pattern .....                  | 4-2  |
| Worst Pattern Complement .....       | 4-2  |
| Malfunction Analysis .....           | 4-2  |
| Memory Failures .....                | 4-2  |
| Control Oriented Errors .....        | 4-2  |
| Address Oriented Errors .....        | 4-4  |
| Data Oriented Errors .....           | 4-8  |
| Multiplex Assembly Failures .....    | 4-8  |
| <b>SECTION V</b>                     | <b>REPLACEMENT PARTS LIST</b>                          |
| FABRI-TEK Numbers .....              | 5-1  |
| FABRI-TEK Parts .....                | 5-1  |
| <b>SECTION VI</b>                    | <b>REFERENCE DOCUMENTS</b>                             |
| <b>APPENDIX A</b>                    | <b>ALPHABETICAL LISTING OF MEMORY SYSTEM MNEMONICS</b> |

## LIST OF ILLUSTRATIONS

| FIGURE | TITLE                          | PAGE |
|--------|--------------------------------|------|
| 1-1    | Model 8/I .....                | 1-2  |
| 3-1    | Functional Units .....         | 3-2  |
| 3-2    | Multiplex Data Path .....      | 3-3  |
| 3-3    | Information Flow Diagram ..... | 3-5  |
| 3-4    | Drive Line Selection .....     | 3-7  |
| 3-5    | Data Loop .....                | 3-8  |
| 4-1    | Control Oriented Errors .....  | 4-3  |
| 4-2    | Address Oriented Errors .....  | 4-5  |
| 4-3    | System Configuration .....     | 4-6  |
| 4-4    | Data Oriented Errors .....     | 4-9  |

| TABLE | TITLE                                | PAGE |
|-------|--------------------------------------|------|
| 1-1   | Specifications .....                 | 1-3  |
| 2-1   | Interface Signal Configuration ..... | 2-1  |
| 2-2   | Back Panel Modification .....        | 2-1  |
| 4-1   | Word Location .....                  | 4-4  |
| 4-2   | Circuit Decoding .....               | 4-7  |

## **SECTION I**

### **GENERAL INFORMATION AND SPECIFICATIONS**

The FABRI-TEK Model 8/I Add-On Memory System is a completely compatible 24K (24,576) word addition to main storage for the Digital Equipment Corporation PDP\*8/I and PDP 12 computers. This manual divides the technical information for the Model 8/I into the following sections.

- I GENERAL INFORMATION AND SPECIFICATIONS
- II INSTALLATION PROCEDURES
- III PRINCIPLES OF OPERATION
- IV MAINTENANCE PROCEDURES
- V REPLACEMENT PARTS LISTS
- VI REFERENCE DOCUMENTS

#### **GENERAL DESCRIPTION**

The Model 8/I consists of a memory unit, a multiplex unit, and a cable assembly. The memory unit, including a FABRI-TEK P3 power supply, and the multiplex unit are housed in a 5 1/4 inch enclosure which can be mounted in a standard 19 inch relay rack. The cable assembly attaches to connectors on the enclosure and to five connectors in the Central Processing Unit (CPU). Figure 1-1 is an outline drawing of the Model 8/I.

Power supply technical information is in a separate manual, FABRI-TEK Publication Number 400-0166-00.

#### **CAPACITY**

The multiplex unit transforms the 8192 36-bit word memory unit into a 24,576 12-bit word memory unit. The additional storage capacity to the CPU is 24K.

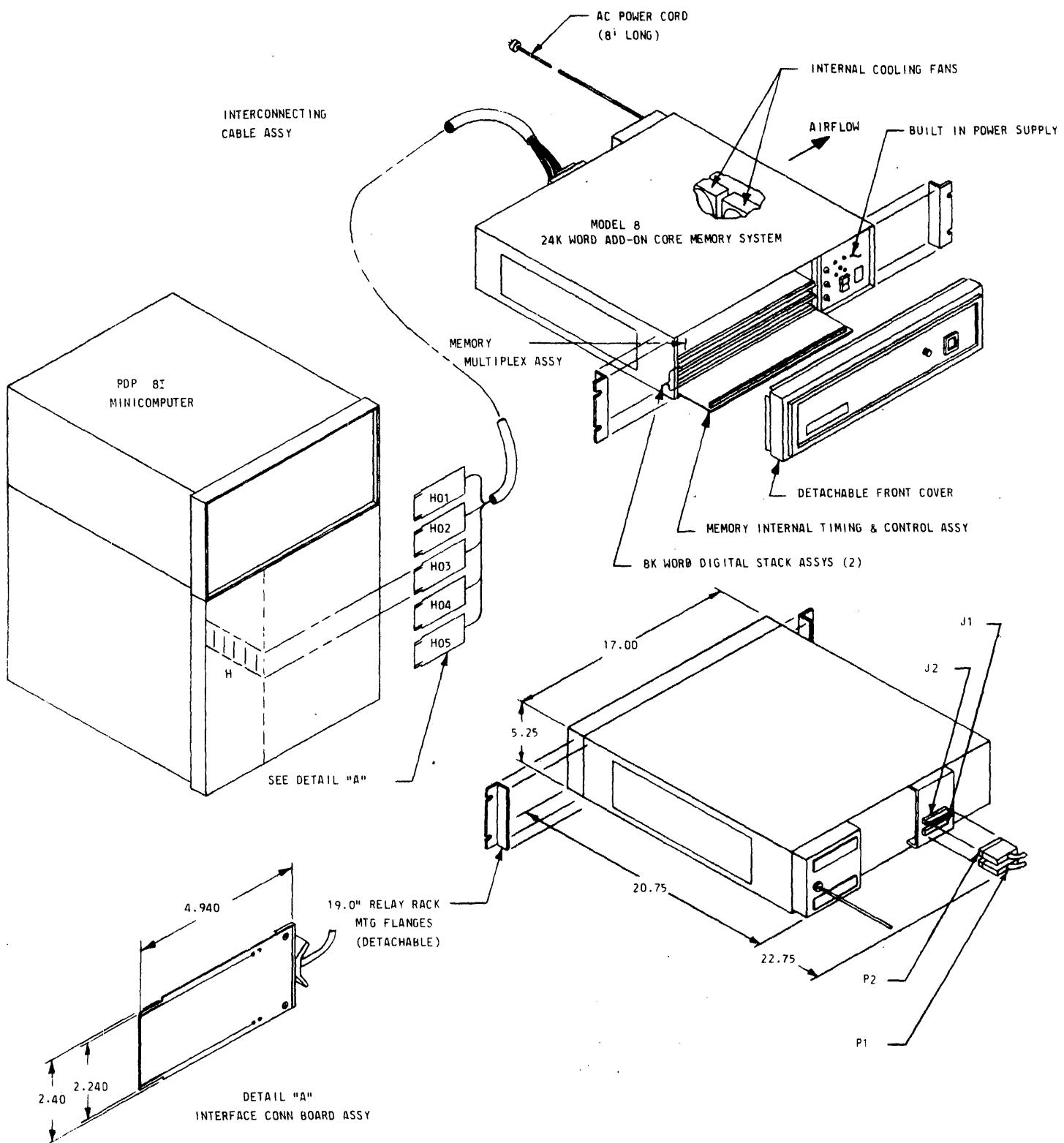
#### **MEMORY CYCLE**

The Model 8/I operates in the split cycle mode. The split memory cycle consists of a Read portion followed by a Write portion. The CPU starts both portions. The Read portion of the memory cycle unloads the contents of the storage location and the Write portion loads the storage location.

#### **SYSTEM SPECIFICATIONS**

Table 1-1 summarizes the system specifications.

\*PDP and DEC are registered trademarks of the Digital Equipment Corporation.



**Figure 1-1**  
**MODEL 8/I**

**Table 1-1.—SPECIFICATIONS**

|   |  |  |  |  |                |
|---|--|--|--|--|----------------|
| <b>MEMORY CYCLE AND OPERATION</b>                 |  |  |  | Logic Zero In                            | 0.0V to +0.8V  |
| Split Cycle                                       |  |  |  | Logic Zero Out                           | 0.0V to +0.5V  |
| <b>ADDRESSING</b>                                 |  |  |  | <b>ENVIRONMENT PARAMETERS</b>            |                |
| Method  |  |  |  | Operating                                | 0°C to +50°C   |
| Format  |  |  |  | Non-Operating                            | -40°C to +80°C |
| <b>MEMORY CAPACITY</b>                            |  |  |  | Humidity (Without Condensation)          |                |
| Address   |  |  |  | 90%                                      |                |
| Word Length                                       |  |  |  | <b>COOLING</b>                           |                |
| 24K   |  |  |  | Forced Air From Enclosure Fans           |                |
| <b>DIMENSIONS</b>                                 |  |  |  | <b>AC POWER REQUIREMENT</b>              |                |
| H.      W.      D.                                |  |  |  | 105 - 115 VAC, 60 Cycles                 |                |
| Enclosure*      5.25"      17.00"      20.75"     |  |  |  | <b>AC POWER CONSUMPTION</b>              |                |
| Module Assemblies      **      11.00"      14.75" |  |  |  | 450 Watts Maximum                        |                |
| <b>INTERFACE CONNECTORS</b>                       |  |  |  | <b>DC POWER REQUIREMENTS</b>             |                |
| Two 50-Pin Amphenol Connectors                    |  |  |  | +15 VDC From Power Supply                |                |
| <b>INTERFACE LOGIC VOLTAGES</b>                   |  |  |  | +5 VDC From Power Supply                 |                |
| Logic One In                                      |  |  |  | -15 VDC From Timing and Control Assembly |                |
| Logic One Out                                     |  |  |  |  |                |

\*Enclosure is 19.00 in. wide with rack mounting brackets attached, and 22.75 in. deep with allowance for cable bend.

\*\*Timing and Control Module mounts on 0.60 in. centers; Digital Stack Modules mount on 1.00 in. centers.

## SECTION II INSTALLATION PROCEDURES

The FABRI-TEK Model 8/I Add-On Memory System consists of a cable assembly and an enclosure containing the three printed circuit assemblies of the Memory and the Multiplexer printed circuit assembly.

### CPU MODIFICATION

Some early models of the CPU may have a different interface signal pin configuration from the cable assembly. The difference involves the Memory Buffer data bits and the Extended Address bits. The correct connections are described in Table 2-1. Verify continuity between the two points in the CPU with a VOM. If there is no continuity between the two points, change the wires to provide continuity.

Table 2-1.—INTERFACE SIGNAL CONFIGURATION

| CPU INTERFACE PIN | CPU INTERNAL PIN | SIGNAL NAME |
|-------------------|------------------|-------------|
| H01-D2            | B12-P2           | MCMB 03     |
| H01-E2            | B12-S1           | MCMB 04     |
| H01-H2            | B12-V2           | MCMB 05     |
| H03-D2            | B16-E1           | EA 0        |
| H03-E2            | B16-J2           | EA 1        |
| H03-H2            | B16-L1           | EA 2        |

If the resident storage capacity of the CPU is 4K, modify the CPU to change the address range of the resident storage from addresses 0 through 4095 to addresses 24,576 through 28,671. Expansions from 4K of resident storage require memory extension control circuitry which is available only from Digital Equipment Corporation. Modify the CPU by removing two wires from the back panel and adding two wires as described in Table 2-2.

Table 2-2.—BACK PANEL MODIFICATION

| REMOVE WIRES BETWEEN: | ADD WIRES BETWEEN:   |
|-----------------------|----------------------|
| 1. B16-S1 and B21-L1  | 1. B16-E1 and B21-L1 |
| 2. B16-V2 and B21-M1  | 2. B16-J2 and B21-M1 |

## **ASSEMBLY**

Insert the five printed circuit card connectors of the cable assembly into the CPU card rack assembly at the locations designated on each connector. The location designator is located near the handle on the ground plane side of the card. Insert the card with the A pin designator at the top and the V pin designator at the bottom of the card. Note, that when the card is properly oriented, the pin designators are upside down. Route the cable as illustrated in Figure 1-1. Attach P1 and P2 of the cable assembly to J1 and J2 respectively, on the enclosure.

## **FINAL CONSIDERATIONS**

Power both the CPU and the Model 8 from the same AC circuit to assure that during power failures both will lose power at the same time. The CPU has an auxiliary power outlet located behind the power supply, which can furnish power for the Model 8.

After the system is assembled, assure correct operation by running the diagnostic programs supplied with the CPU.

## SECTION III

### PRINCIPLES OF OPERATION

The Model 8/I Add-On Memory System accepts and retains data from the CPU or from Input-Output (I/O) units and delivers data to the CPU or the I/O units. The Model 8/I handles all inputs and outputs as information, making no distinction between program instructions and data.

The Model 8/I has two functional units, the Multiplex Assembly and the Memory. Figure 3-1 is a functional block diagram of the Model 8.

#### MULTIPLEX ASSEMBLY

The Multiplex Assembly is a printed circuit assembly which is placed into slot number four of the enclosure. Functionally, the Multiplexer transforms the 8192 36-bit word memory into a 24,576 12-bit word memory. Control signals, processed on the Multiplex Assembly, direct the data flow between the CPU and the Memory.

#### CONTROL SIGNALS

**DATA SAVE.** The Data Save signal halts the operation of the Model 8 if there is a power failure in either the CPU or the Model 8.

**MASTER RESET.** The Master Reset signal sets the internal control circuits to the state required to start a memory cycle.

**MEMORY START.** The Memory Start signal defines the beginning of a memory cycle by starting the Read portion of the memory cycle.

**WRITE.** The Write signal starts the Write portion of the memory cycle after the Read portion is complete.

**STROBE.** The Strobe signal notifies the CPU that data is available at the CPU.

**MEMORY DONE.** The Memory Done signal notifies the CPU that the memory cycle is complete.

#### MULTIPLEX DATA PATH

Figure 3-2 is a typical multiplex data path; there are 12 identical data paths. During Read operations, the Multiplexer receives 36 bits of data from the memory, selects one 12 bit segment, and sends it to the CPU. During Write operations, the Multiplexer receives a 12 bit word from the CPU, places it into the selected segment of the 36 bit word, and stores the 36 bits in the Memory.

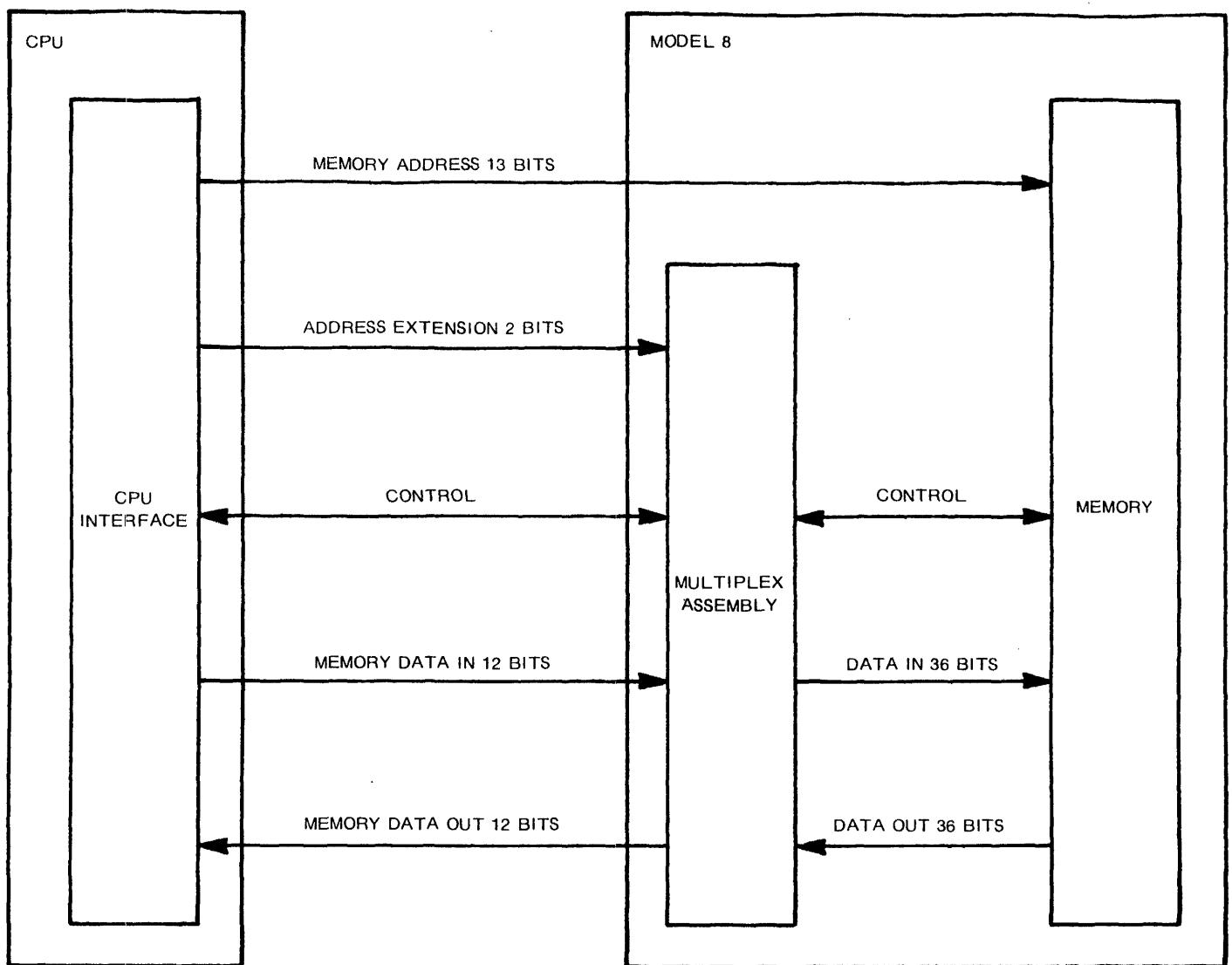


Figure 3-1  
FUNCTIONAL UNITS

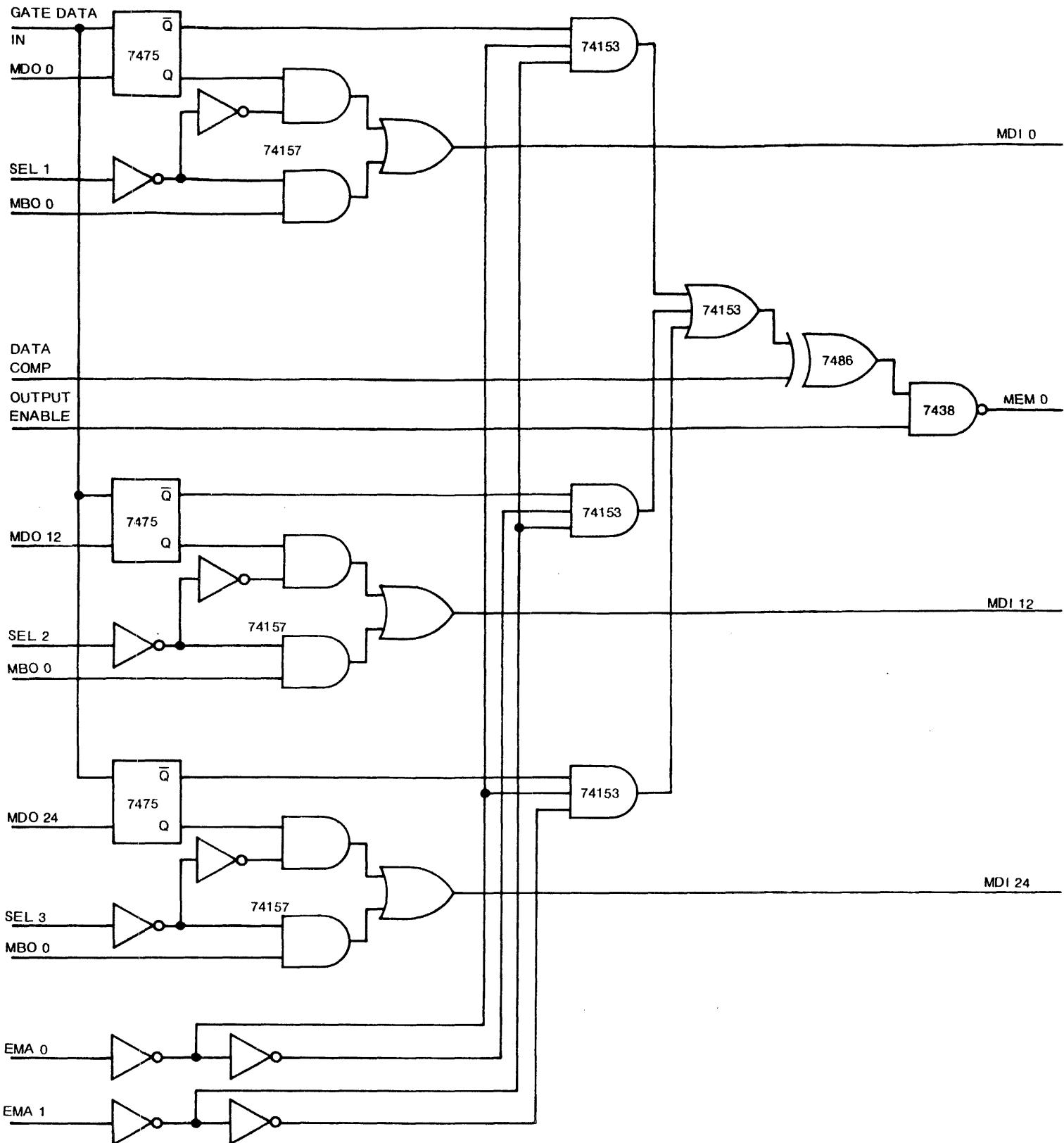


Figure 3-2  
MULTIPLEX DATA PATH

During the Read portion of the cycle, the Gate Data In signal latches the 36 bits of data from the Memory into the Multiplexer data register. The Multiplexer decodes address bits EA0 and EA1 to select the 12 bit segment of the 36 bit word which it sends to the CPU. The Data Comp signal logically complements the output data. The Output Enable signal transfers the 12 bits of data to the CPU.

During the Write portion of the cycle, the Multiplexer decodes address bits EA0 and EA1 to select the 12 bit segment of the 36 bit memory word which receives the new data from the CPU. This new data and the other 24 bits, which remain unchanged, are stored in the Memory.

## MEMORY

The Memory is a three wire, 3D, coincident current core memory with 8192 36 bit locations. The Memory consists of one Timing and Control Assembly located at the bottom of the enclosure in slot number one and two Digital Stack Assemblies in slots number two and three. Each Digital Stack consists of a Memory Electronics Assembly and a plug-in Core Array Assembly.

The Memory requires five control signals for operation: Cycle Initiate, Cycle Continue, Read/Write Control, Split Cycle Control and Data Save. Cycle Initiate and Cycle Continue are generated on the Interface Control Assembly. The power supply produces the Data Save signal. The Model 8 always operates in the split cycle mode, requiring the Split Cycle Control input and the Read/Write Control input to be grounded.

The Memory has three functional units: Cycle Control, Current Drive, and Data Loop. Figure 3-3 is a diagram of the Memory functional units.

## CYCLE CONTROL

The Cycle Control section directs the internal operations of the Memory. Two clocks and the control signals from the CPU produce internal control signals which direct the sequence of operation.

## CURRENT DRIVE

The Current Drive section decodes the address information, selects the proper drive lines, and drives Read and Write switching currents. The current compensation network adjusts drive currents to compensate ambient temperature changes.

**ADDRESS DECODE.** The address decoding network decodes input address bits  $2^0$  through  $2^{12}$  to select the proper drive lines on each axis. On the X axis, address bits  $2^0$ ,  $2^1$ , and  $2^2$  enable a read sink or a write source transistor and bits  $2^9$ ,  $2^{10}$ ,  $2^{11}$ , and  $2^{12}$  enable a read or write switch transistor. On the Y axis, address bits  $2^3$ ,  $2^4$ , and  $2^5$  enable a read source or a write sink transistor and bits  $2^6$ ,  $2^7$ , and  $2^8$  enable a read or write switch transistor. The Inhibit signal, when not active, selects Read paths and, when active, selects Write paths. Address bits  $2^{13}$  and  $2^{14}$  select the proper 8K section (Digital Stack) of storage.

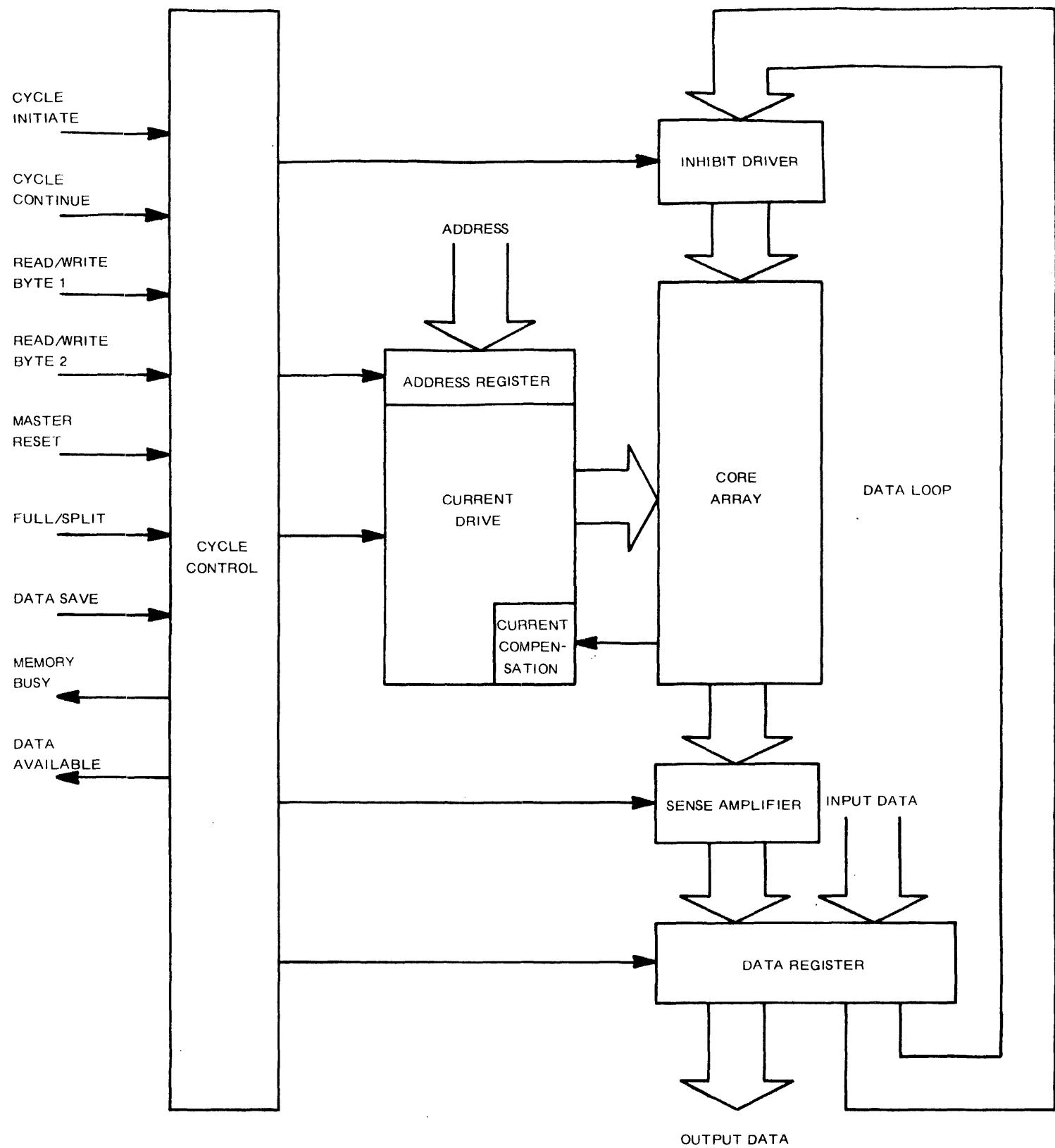


Figure 3-3  
INFORMATION FLOW DIAGRAM

**CURRENT SOURCE, SWITCH, AND SINK.** For each current path, three transistors determine the path of the switching current from source to sink. The transistor nearest the positive voltage source is the source transistor, the one nearest the negative voltage source is the sink transistor, and the one between is the switch transistor. Figure 3-4 shows the current paths for some of the drive lines. Decoded address signals enable one source, one switch, and one sink transistor for each axis for both Read and Write operations.

**DRIVE LINE SELECTION.** Figure 3-4 is a simplified drive line scheme which depicts all basic drive line selection electronics on the Memory Electronics Assembly, but only one-eighth of the Core Array Assembly. For complete drive line details consult the Core Array Schematic in Section VI, Reference Documents. The decoded address signals which control transistor operation are shown along both sides of the illustration.

The eight underlined signals define Read and Write switching current paths for both axes for address 14605. For this address, the three signals which control drive current in a Write direction through Y drive line 33 are the Y Source Write Timing signal to the base of Q18, the YWRXX6XX signal to the base of the switch transistor, and the YWRXXX0X signal to the base of the Y sink transistor. To trace the Y Write current path in Figure 3-4, begin at the +15VDC source at the top of the illustration. The current path is from –

- the +15VDC source,
- through the secondary of the switch core transformer,
- through transistor Q18,
- through the transformer,
- right and down the switch transistor common collector line,
- through the transistor controlled by signal YWRXX6XX,
- through Y drive line 33,
- through Y Write sink transistor controlled by signal YWRXXX0X,
- through the transformer, and
- to the -15VDC source.

Similarly, it is possible to trace the Read switching current path through Y drive line 33 using the Y Read Sink Timing signal, the YRDXXX0X signal, and the YRDXX6XX signal.

## **DATA LOOP**

The Data Loop is the data path from the input data interface through the inhibit drivers, Core Array and sense amplifiers to the output data interface. There are 36 parallel data loops. Data from the CPU enters the data register and is stored in the Core Array during a Write operation. Data from the Core Array enters the data register through the sense amplifiers, and is transferred to the CPU during a Read operation. Figure 3-5 is a simplified schematic diagram of a Data Loop.

**DATA REGISTER.** The data register is located on the Memory Electronics Assembly. The data register temporarily stores input data which will be stored in the Core Array and output data which will be sent to the Multiplex Assembly.

**SENSE AMPLIFIERS.** The sense amplifiers are located on the Memory Electronics Assembly. During Read operations, sense amplifiers detect the presence of a logical one stored in the Core Array. The output of the sense amplifiers enters the data register for transfer to the CPU.

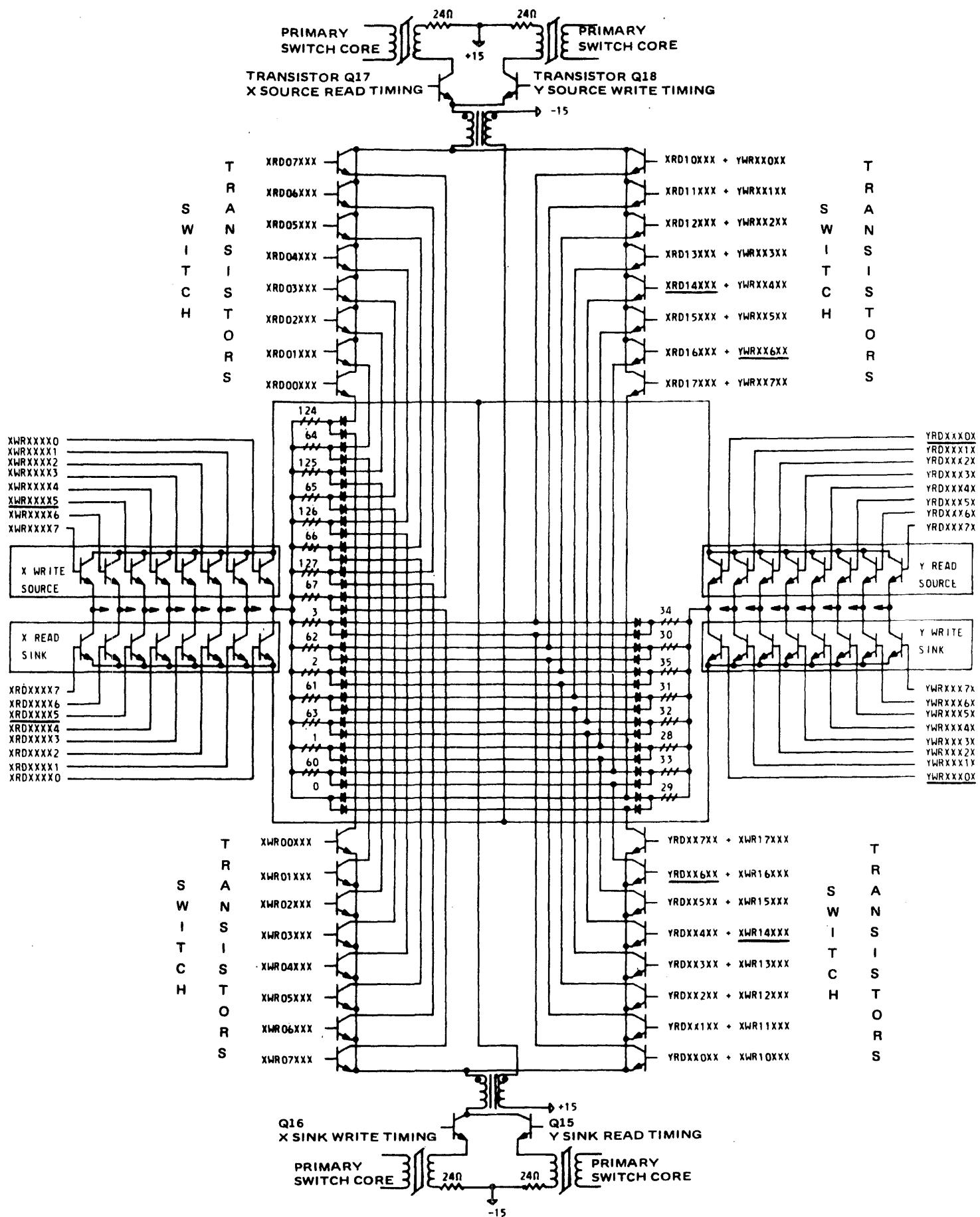


Figure 3-4  
DRIVE LINE SELECTION

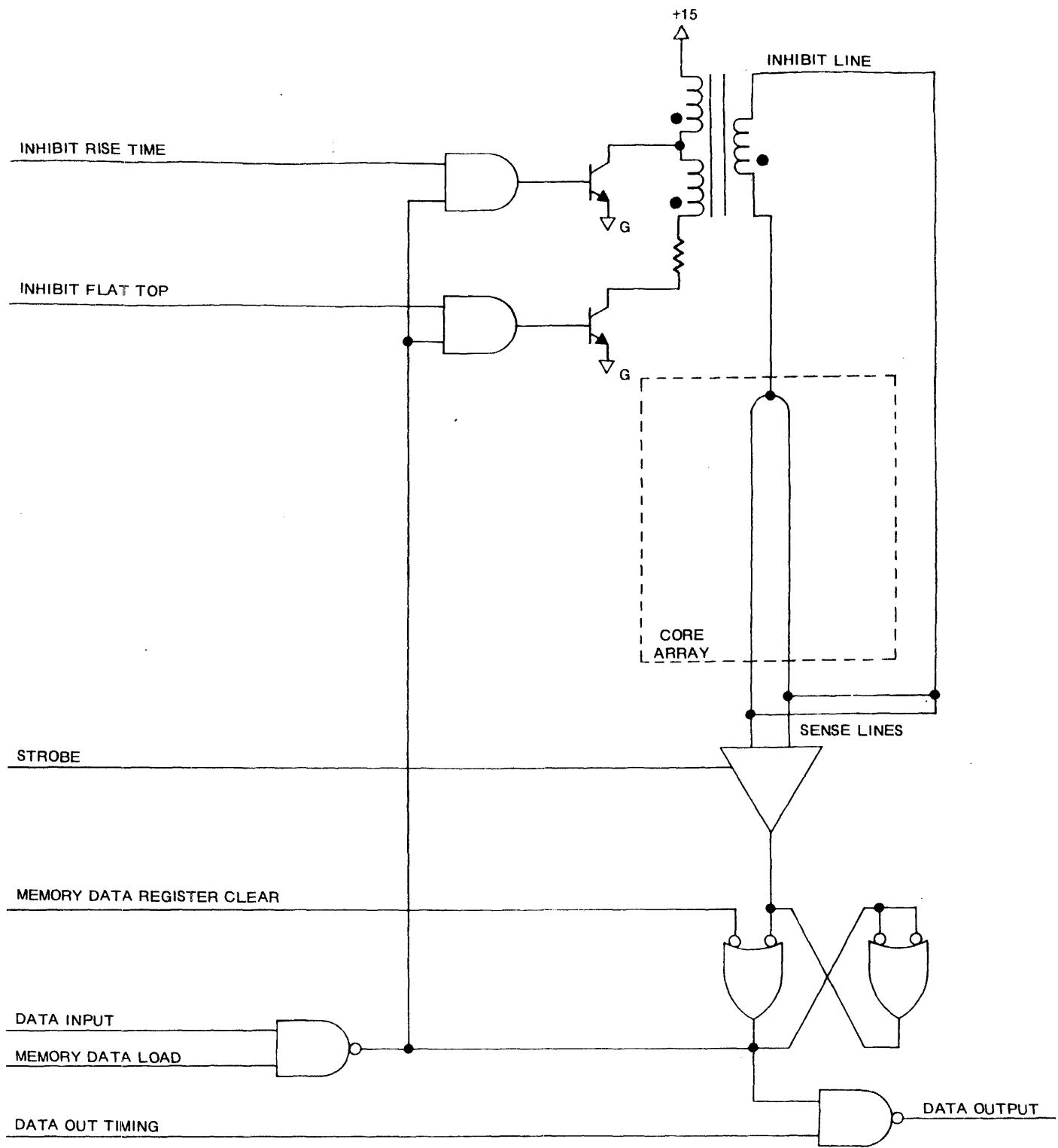


Figure 3-5  
DATA LOOP

**INHIBIT DRIVERS.** The inhibit drivers are located on the Memory Electronics Assembly. During Write operations, inhibit drivers prevent the switching of cores which are to store a logical zero. The data register controls the inhibit drivers.

**CORE ARRAY.** The Core Array Assembly contains the ferrite cores and the diode matrices. The Core Array is divided into two arrays with 18 core mats of 8192 cores. Each mat has 128 X axis drive lines and 64 Y axis drive lines. Three wires thread each core: an X axis drive line, a Y axis drive line, and a common sense-inhibit line. The diode matrix for each axis steers switching currents through the selected drive lines in the Core Array.

## **MEMORY OPERATION**

The Memory in the Model 8/I operates in the split cycle mode; each memory cycle has a Read portion followed by a Write portion. The CPU starts both the Read portion and the Write portion. At the beginning of a memory cycle the CPU also supplies the address of the data.

### **READ PORTION OF THE CYCLE**

The Memory Start signal from the CPU initiates the Read portion of the memory cycle. The Read portion unloads the 36 bits of data at the location specified by the CPU address. The Memory presents the data to the CPU and halts operation, waiting for the CPU to initiate the Write portion.

### **WRITE PORTION OF THE CYCLE**

The Write signal from the CPU initiates the Write portion of the memory cycle. The Write portion loads 36 bits of data into the location specified by the CPU address. The Memory halts operation and waits for the next request from the CPU.

## **SECTION IV MAINTENANCE**

Most memory system malfunctions develop characteristic symptoms. Maintenance procedures minimize down-time by providing information to analyze malfunctions, to understand their significance, and to direct troubleshooting to the most probable cause. When spare modules are available, substitution of the suspect module is the best troubleshooting procedure.

### **RECOMMENDED TEST EQUIPMENT**

| EQUIPMENT          | MANUFACTURER | TYPE                     |
|--------------------|--------------|--------------------------|
| Oscilloscope       | Tektronix    | 547 Series or Equivalent |
| Pre-Amp            | Tektronix    | 1A2 or Equivalent        |
| Voltage Probe      | Tektronix    | 10:1 Attenuation         |
| Digital Multimeter | Fairchild    | Model 7050 or Equivalent |
| VOM                | Triplet      | 630-NA or Equivalent     |

### **PREVENTIVE MAINTENANCE**

With a knowledge of the operating environment, the user determines the requirement for preventive maintenance.

### **CORRECTIVE MAINTENANCE**

Corrective maintenance is necessary to restore normal operation of the system if malfunctions develop. Control, address, and data oriented errors are the most common error classifications. In each classification the cause can be either external or internal to the memory system. Classification of an error does not eliminate the possibility of an interrelationship between classifications. Many apparent memory system problems are the result of program and timing errors.

Give the power supply primary consideration by assuring that it is properly furnishing all outputs, including the Data Save signal. Next assure that the interface cables are firmly attached and that all interface signals are present.

### **MEMORY TEST PATTERNS AND TESTS**

The Ones, Zeros, Worst Pattern, and Worst Pattern Complement are externally generated test patterns. Test procedures using these test patterns can either confirm reliable operation or aid error detection.

#### **ONES**

The Ones test pattern consists of logical ones in every location in the Core Array.

## **ZEROS**

The Zeros test pattern consists of logical zeros in every location in the Core Array.

## **WORST PATTERN**

Some memory malfunctions develop only under worst case conditions. The Worst Pattern produces the maximum disturb noise on the sense line during a Read operation. The Worst Pattern is the logical exclusive OR function of address bits  $2^7$  and  $2^{12}$ . Stated in another way: for the first 4096 words, blocks of 128 words containing zeros alternate with blocks of 128 words containing ones with the first block containing zeros. For the second 4096 words, blocks of 128 words containing zeros alternate with blocks of 128 words containing ones with the first block containing ones.

## **WORST PATTERN COMPLEMENT**

The Worst Pattern Complement is the logical complement of the Worst Pattern.

## **MALFUNCTION ANALYSIS**

Malfunctions can occur in any of one of four places in the system: the CPU, the interconnecting cable, the Multiplex Assembly, or the Memory. The first task is to locate the malfunctioning unit.

Determine if errors occur in the CPU resident memory, the Model 8, or both by removing the interconnecting cable and running the diagnostic programs. If errors still occur, troubleshoot the CPU. If errors occur only in the Model 8 assure that the control signals, address, and data are present at the Model 8. If all signals are present, troubleshoot the Multiplexer and the Memory.

## **MEMORY FAILURES**

Failures developed in the Memory while running diagnostic programs normally fall into one of the following classifications:

### **CONTROL ORIENTED ERRORS.**

Control oriented errors originate in the external equipment or in the Cycle Control section. Failure to initiate or complete an operation or erratic behavior with no recognizable pattern are characteristic of control oriented errors. Use Figure 4-1 as an aid to troubleshooting.

#### CONTROL ERROR SYMPTOMS

1. SYSTEM WILL NOT OPERATE, OR
2. SYSTEM WILL NOT READ, OR
3. SYSTEM WILL NOT WRITE, OR
4. ERRORS IN RANDOM DATA BITS, OR
5. ERRORS AT RANDOM ADDRESSES, OR
6. ERRATIC BEHAVIOR.

#### (1) INPUT CONTROL SIGNALS

1. CYCLE INITIATE
2. CYCLE CONTINUE
3. MEMORY DATA CLEAR

#### (2) INTERNAL CONTROL SIGNALS

1. MEMORY DATA REGISTER CLEAR
2. MEMORY DATA LOAD
3. STROBE
4. DATA OUT TIMING
5. INHIBIT FLAT TOP
6. INHIBIT RISE TIME
7. X SOURCE READ
8. Y SOURCE WRITE
9. Y SINK READ
10. X SINK WRITE
11. X SINK READ + WRITE SINK SOURCE TIME
12. Y SOURCE READ + WRITE SINK SOURCE TIME
13. READ SWITCH TIME
14. WRITE SWITCH TIME
15. MODULE SELECT

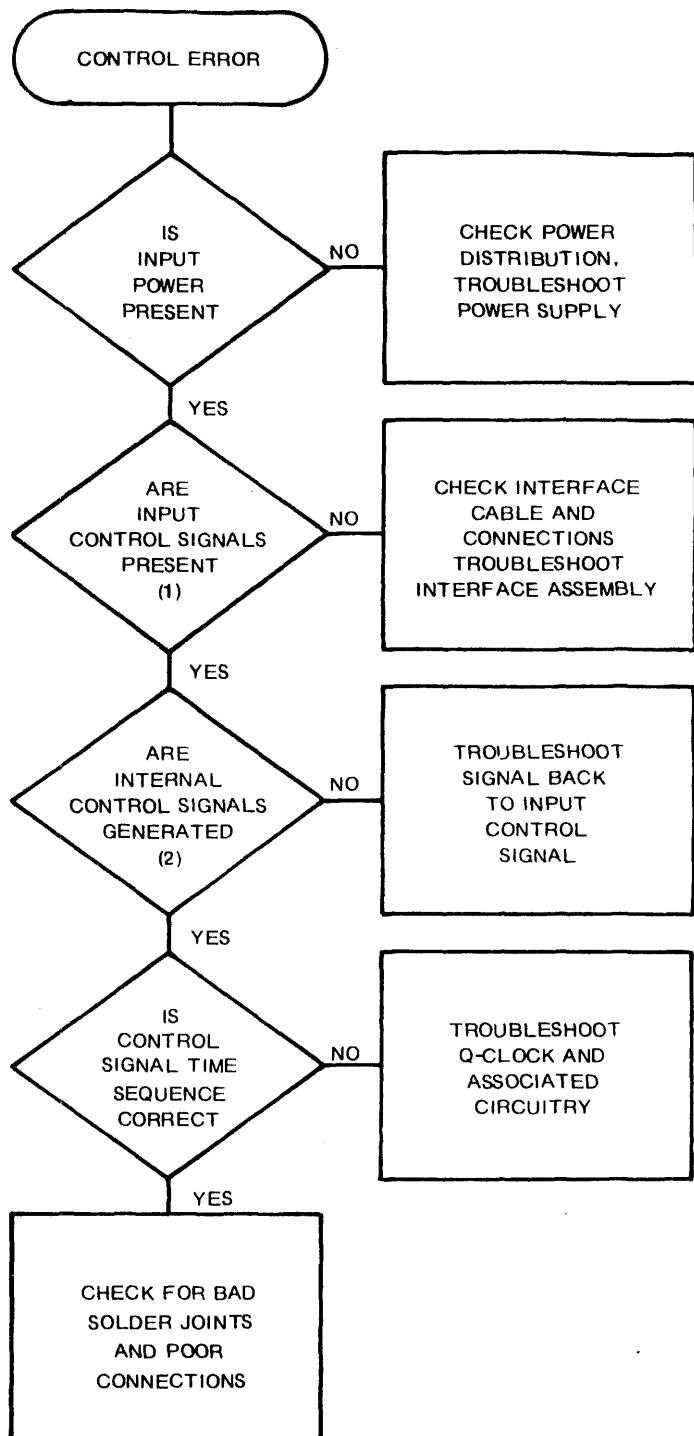


Figure 4-1  
CONTROL ORIENTED ERRORS

## ADDRESS ORIENTED ERRORS

Address oriented errors originate in the Current Drive section. All bits of a data word in error and addresses of errors with definite patterns are characteristics of address oriented errors. Use Figure 4-2 as an aid to troubleshooting. Figure 4-3 illustrates the configuration of the Core Arrays.

**WORD LOCATION.** Decode address bits  $2^{13}$  and  $2^{14}$  to identify the malfunctioning 12 bits of each 36 bit location in the Core Array. Table 4-1 and Figure 4-3 provide the corresponding bit positions for each decode. The remaining 13 address bits determine the location within the Core Array.

TABLE 4-1.—WORD LOCATION

| EA0 | EA1 | 4K-28K SYSTEM | 8K-32K SYSTEM |
|-----|-----|---------------|---------------|
| 0   | 0   | BITS 0-11     | CPU STACK     |
| 0   | 1   | BITS 12-23    | BITS 24-35    |
| 1   | 0   | BITS 24-35    | BITS 12-23    |
| 1   | 1   | CPU STACK     | BITS 0-11     |

Three 12 bit words are stored in each 36 bit location in the Core Array. Adjacent addresses reference adjacent locations in the Core Array. For example, with 4K of resident storage, bits 0-11 err only in the first 8K addresses, bits 12-23 err only in the second 8K addresses, bits 24-35 err only in third 8K addresses.

If the error is in the same bit position of every word, troubleshoot the data path on the Multiplex Assembly.

Interchange the two Digital Stack Assemblies. If the malfunction disappears, the cause was probably a poor connection. If the malfunction does not move, troubleshoot the connector and back panel wiring associated with the location of the malfunctioning assembly. If the malfunction follows the suspect module, troubleshoot the assembly to the circuit level.

**CIRCUIT DECODING.** Each Digital Stack Assembly identically decodes address bits  $2^0$  through  $2^{12}$ . The address is broken down into significant X axis and Y axis digits and synthesized into Read and Write signals for each axis. Table 4-2 provides a procedure to determine the signals for the sample address  $14605_8$ . The results of the procedure are listed in the summary. The page numbers refer to the schematics in the Reference Documents section. The underlined signals in Figure 3-2 relate to the circuit decoding example of Table 4-2.

ADDRESS ERROR SYMPTOMS

1. ALL BITS OF A DATA WORD ARE IN ERROR
2. ADDRESSES OF ERRORS HAVE DEFINITE PATTERN

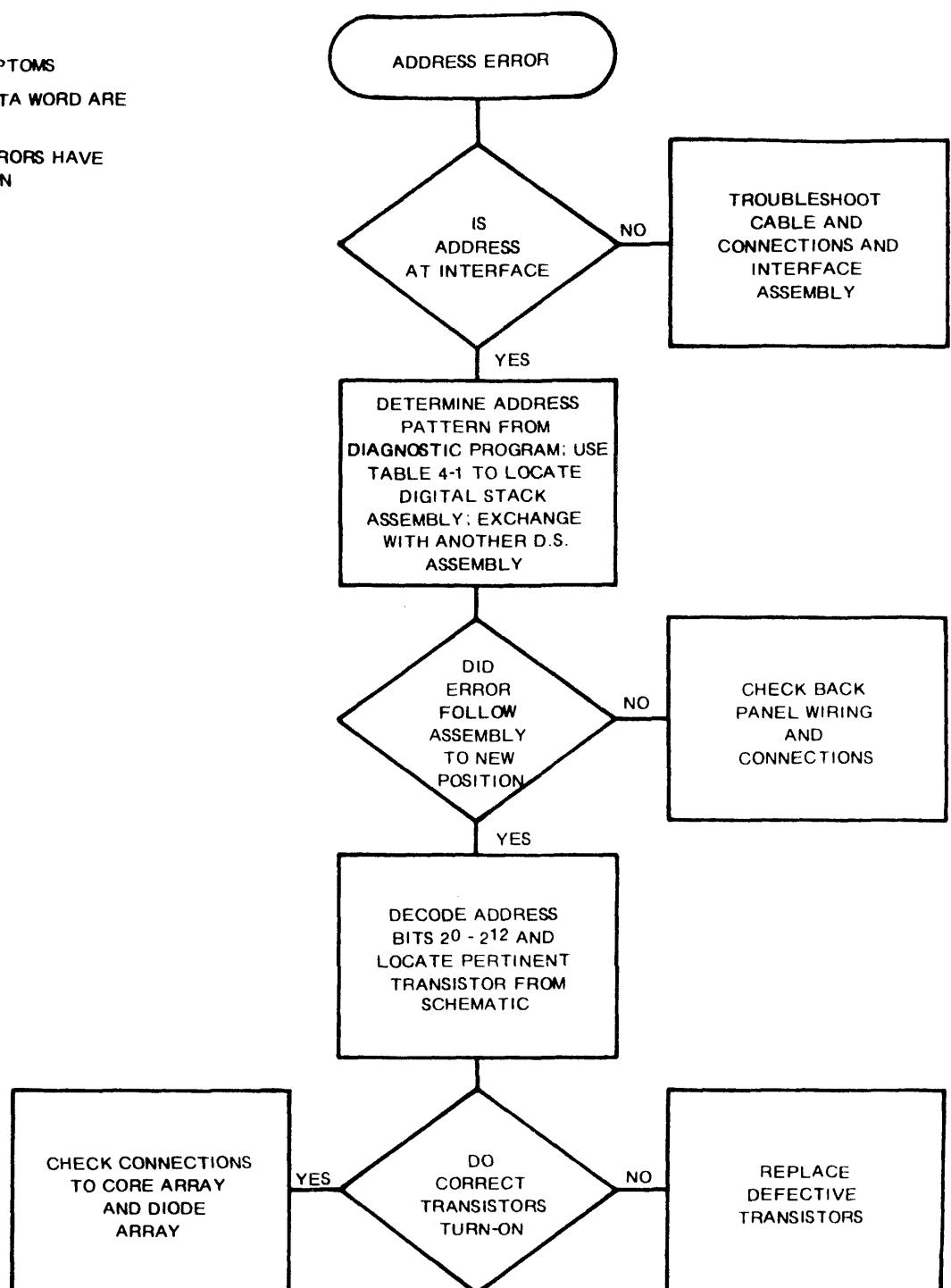


Figure 4-2  
ADDRESS ORIENTED ERRORS

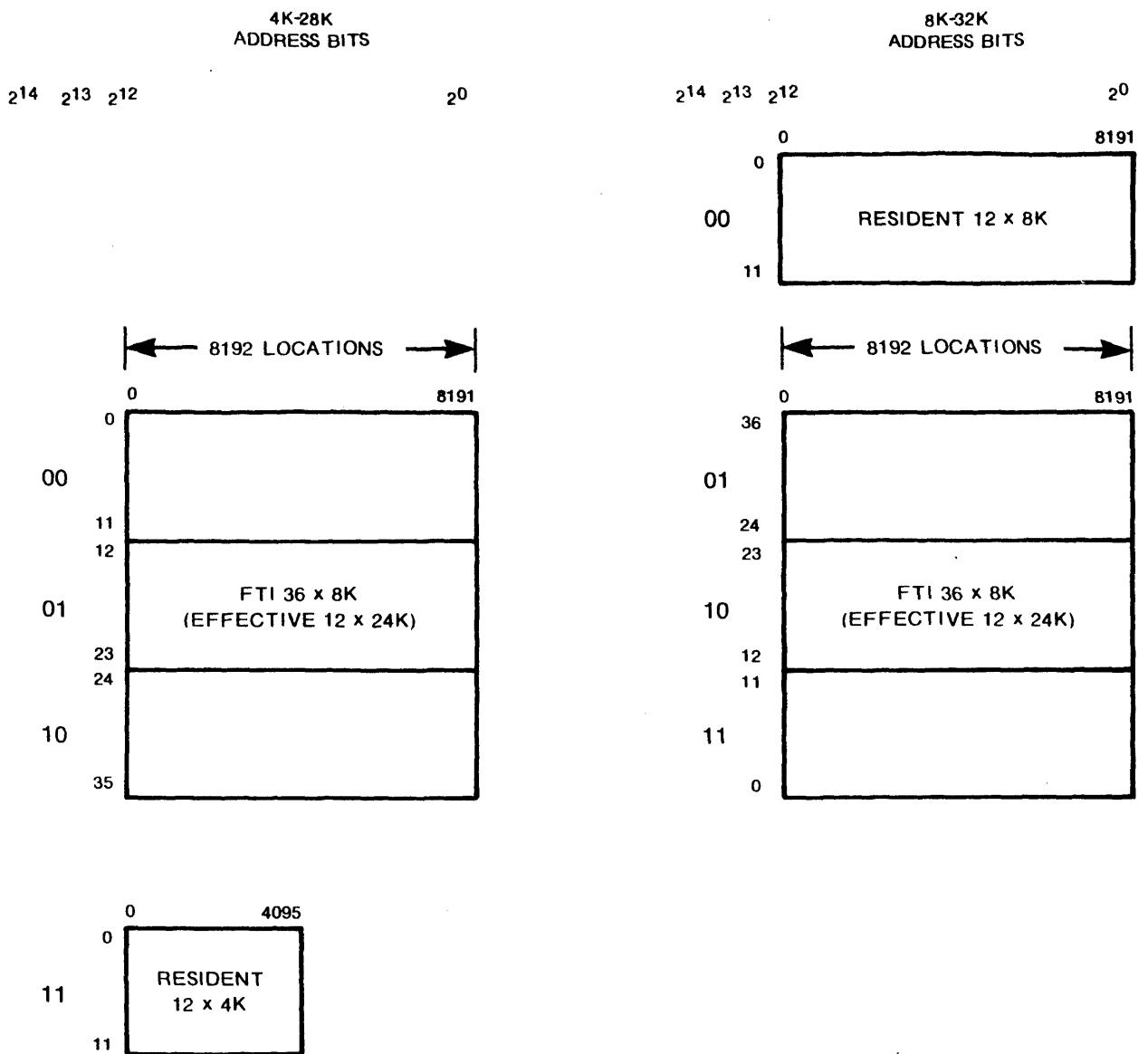


Figure 4-3  
SYSTEM CONFIGURATION

Table 4-2.—CIRCUIT DECODING

|                  |                 |                     |               |               |
|------------------|-----------------|---------------------|---------------|---------------|
| X AXIS WRITE     | XWR14XXX        | XWRXXXX5            |               |               |
| X AXIS READ      | XRD14XXX        | XRDXXXX5            |               |               |
| X AXIS BREAKOUT  |                 | 14XXXX              |               | XXXX5         |
| X AXIS           | 1               | 4                   | X             | X             |
| ADDRESS REGISTER | $2^{14} 2^{13}$ | $2^{12}$            | $2^8 2^7 2^6$ | $2^5 2^4 2^3$ |
|                  |                 | $2^{11} 2^{10} 2^9$ |               | $2^2 2^1 2^0$ |
| Y AXIS           | X               | X                   | 6             | 0             |
| Y AXIS BREAKOUT  |                 |                     | XX6XX         | XXX0X         |
| Y AXIS READ      | YRDXX6XX        | YRDXXX0X            |               |               |
| Y AXIS WRITE     | YWRXX6XX        | YWRXXX0X            |               |               |

TABLE 4-1

### SUMMARY

| SIGNAL   | MEMORY ELECTRONICS ASSEMBLY<br>SCHEMATIC PAGE | PIN NO. | TRANSISTOR |
|----------|---|---------|------------|
| XRD14XXX | 17  | 19      | QM12       |
| XRDXXXX5 | 12  | 53      | QM1        |
| XWR14XXX | 19  | 3       | QM14       |
| XWRXXXX5 | 12  | 53      | QM1        |
| YRDXX6XX | 19  | 9       | Q28        |
| YRDXXX0X | 13  | 39      | Q25        |
| YWRXX6XX | 17  | 13      | QM13       |
| YWRXXX0X | 13  | 39      | Q26        |

## **DATA ORIENTED ERRORS**

Data oriented errors originate in the Data Loop. Errors occurring in the same bit position of data words during a Read or Write operation is characteristic of data oriented errors. Troubleshoot the inhibit driver and related circuits for errors during a Write operation; troubleshoot the sense amplifier and related circuits for errors during a Read operation. Use Figure 4-4 as a guide for troubleshooting data oriented errors.

## **MULTIPLEX ASSEMBLY FAILURES**

Failures developed on the Multiplex Assembly while running the diagnostic programs occur in either the control signal circuitry or in the data path. Control signal failures affect all data paths identically. The control signals direct the data through the data path.

If errors occur in all data paths, troubleshoot the control signal section. If errors occur in specific paths, troubleshoot only those paths.

DATA ERROR SYMPTOM

1. SAME BIT OF EVERY DATA WORD WILL BE IN ERROR

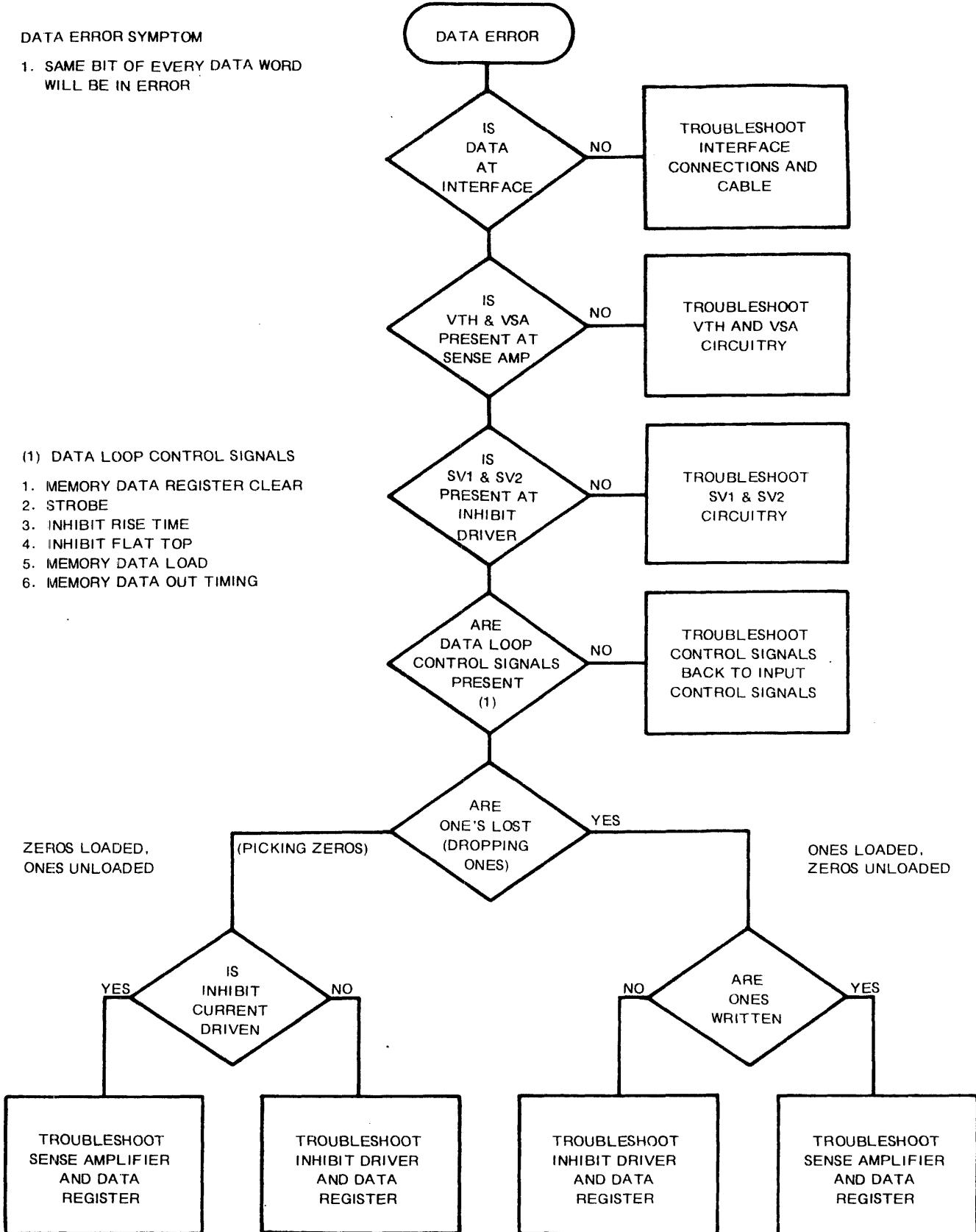


Figure 4-4  
DATA ORIENTED ERRORS

## **SECTION V**

### **REPLACEMENT PARTS LIST**

This section lists the electronic components on the printed circuit assemblies. The component list for each assembly is in alphabetic order. For each component the lists provide a reference designation, description, FABRI-TEK part number, manufacturer's part number, and quantity.

#### **FABRI-TEK NUMBERS**

When suppliers manufacture a component to FABRI-TEK specifications, the listed manufacturer's part number corresponds to the FABRI-TEK part number. These parts are available from the Memory Products Division of FABRI-TEK INCORPORATED.

#### **FABRI-TEK PARTS**

When ordering from a replacement parts list, specify the product number, system or assembly serial number, and FABRI-TEK part number.

### REPLACEMENT PARTS LIST

**MEMORY ASSEMBLY**

**ASSEMBLY NO.** 190-1375-00  
**SCHEMATIC NO.** 138-001706

| REFERENCE DESIGNATION                         | COMPONENT DESCRIPTION                                  | FABRI-TEK IDENT NUMBER | MANUFACTURER AND IDENT NUMBER | QUANTITY |
|---|--|------------------------|-------------------------------|----------|
| C1,3,7,9,11,12                                | CAPACITOR, Fixed 150 UUF, $\pm 2\%$ , 500V Silver Mica | 023-0472-00            | Sangamo D105D151G0            | 6        |
| C2,5,6,13,14,19, 20,39-47, 66-76, 79          | CAPACITOR, Fixed 15 UF, $\pm 20\%$ , 20V Tantalum      | 023-0518-00            | Dickson D15ZLX20M             | 28       |
| C4,8,10                                       | CAPACITOR, Fixed 100 UUF, $\pm 2\%$ , 500V Silver Mica | 023-0471-00            | Sangamo D105D101G0            | 3        |
| C15,16,17,18,48- 65,77,78                     | CAPACITOR, Fixed 0.01 UF, $\pm 20\%$ , 50V Ceramic     | 023-0455-00            | Centralab UK50-103            | 24       |
| C21-38  | CAPACITOR, Fixed 220 UUF, $\pm 2\%$ , 300V Silver Mica | 023-0469-00            | Sangamo D105D221G0            | 18       |
| C80-84  | CAPACITOR, Fixed 0.01 UF, +80%-20%, 10V Ceramic        | 023-0362-00            | Centralab UK10-103            | 5        |
| CR1-109                                       | DIODE, Switching 1N4607                                | 022-0309-00            | Fairchild 1N4607              | 109      |
| L1,2  | INDUCTOR<br>1.2 mh $\pm$ 0.2 mh @ 400 ma               | 019-0218-00            | FABRI-TEK 019-0218-00         | 2        |
| Q1,4,5,9,10,11, 12,13,14                      | TRANSISTOR, Similar to 2N2369                          | 021-0121-00            | FABRI-TEK 021-0121-00         | 9        |
| Q2,3,6,7,8,19, 20,21,22,27,28, 29,30,35,54-71 | TRANSISTOR, 2N4014                                     | 021-0223-00            | Sprague 2N4014                | 32       |
| Q15,16,17,18,23, 24,25,26,31,32, 33,34,36-53  | TRANSISTOR, Similar to 2N3725                          | 021-0137-00            | FABRI-TEK 021-0137-00         | 30       |
| QM1,2,3,5-14                                  | INTEGRATED CIRCUIT Quad, High Current Core Driver      | 134-0214-00            | Sprague UHP-021               | 13       |

## REPLACEMENT PARTS LIST

ASSEMBLY NO. 190-1375-00  
 SCHEMATIC NO. 138-001706

## MEMORY ASSEMBLY

| REFERENCE DESIGNATION                      | COMPONENT DESCRIPTION   | FABRI-TEK IDENT NUMBER | MANUFACTURER AND IDENT NUMBER | QUANTITY |
|--|---|------------------------|-------------------------------|----------|
| R1,8,11,15,17,<br>26,32,43,201-254         | RESISTOR, Fixed<br>470 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0471-00            | Allen-Bradley<br>CB-4715      | 62       |
| R2,91,92                                   | RESISTOR, Fixed<br>1210 Ohms, $\pm 1\%$ , 1/8 W<br>Film               | 201-1211-00            | IRC<br>RN55D1211F             | 3        |
| R3,10,13,31,37,<br>46,48,111-128           | RESISTOR, Fixed<br>220 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0221-00            | Allen-Bradley<br>CB-2215      | 25       |
| R4,16                                      | RESISTOR, Fixed<br>330 Ohms, $\pm 3\%$ , 2.5 W<br>Wirewound           | 106-0473-00            | Dale<br>NS2C-330 Ohms-3%      | 2        |
| R5,7,18,19,30,<br>36,47,74,75,78,<br>79,81 | RESISTOR, Fixed<br>1000 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0102-00            | Allen-Bradley<br>CB-1025      | 12       |
| R6,77,80,93-110                            | RESISTOR, Fixed<br>100 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0101-00            | Allen-Bradley<br>CB-1015      | 21       |
| R9,12,28,34,45                             | RESISTOR, Fixed<br>*Ohms, $\pm 1\%$ , 1/8 W<br>Film                   | 201-0000-99            | IRC<br>RN55D*F                | 5        |
| R14,40,53,183-<br>200                      | RESISTOR, Fixed<br>4700 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0472-00            | Allen-Bradley<br>CB-4725      | 21       |
| R20  | RESISTOR, Fixed<br>20 Ohms, $\pm 1\%$ , 2.5 W<br>Wirewound            | 106-0472-00            | Dale<br>NS2C-20 Ohms-1%       | 1        |
| R21,29,35                                  | RESISTOR, Fixed<br>150 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0151-00            | Allen-Bradley<br>CB-1515      | 3        |
| R22,24                                     | RESISTOR, Fixed<br>390 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0391-00            | Allen-Bradley<br>CB-3915      | 2        |
|  | *Value selected during<br>final checkout.                             |                        |                               |          |

## REPLACEMENT PARTS LIST

MEMORY ASSEMBLY

ASSEMBLY NO. 190-1375-00  
 SCHEMATIC NO. 138-001706

| REFERENCE DESIGNATION  | COMPONENT DESCRIPTION   | FABRI-TEK IDENT NUMBER | MANUFACTURER AND IDENT NUMBER | QUANTITY |
|------------------------|---|------------------------|-------------------------------|----------|
| R23,25                 | RESISTOR, Fixed<br>330 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0331-00            | Allen-Bradley<br>CB-3315      | 2        |
| R27                    | RESISTOR, Fixed<br>1070 Ohms, $\pm 1\%$ , 1/8 W<br>Film               | 201-1071-00            | IRC<br>RN55D1071F             | 1        |
| R33                    | RESISTOR, Fixed<br>1300 Ohms, $\pm 1\%$ , 1/8 W<br>Film               | 201-1301-00            | IRC<br>RN55D1301F             | 1        |
| R38,49,255             | RESISTOR, Fixed<br>680 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0681-00            | Allen-Bradley<br>CB-6815      | 3        |
| R39,50,256             | RESISTOR, Fixed<br>820 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0821-00            | Allen-Bradley<br>CB-8215      | 3        |
| R44                    | RESISTOR, Fixed<br>2700 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0272-00            | Allen-Bradley<br>CB-2725      | 1        |
| R54,55,57,58           | RESISTOR, Fixed<br>270 Ohms, $\pm 5\%$ , 1/2 W<br>Carbon Composition  | 101-0271-00            | Allen-Bradley<br>EB-2715      | 4        |
| R56,59,62,63,64,<br>65 | RESISTOR, Fixed<br>39 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition   | 108-0390-00            | Allen-Bradley<br>CB-3905      | 6        |
| R60,61                 | RESISTOR, Fixed<br>390 Ohms, $\pm 5\%$ , 1/2 W<br>Carbon Composition  | 101-0391-00            | Allen-Bradley<br>EB-3915      | 2        |
| R66,68,70,72           | RESISTOR, Fixed<br>24 Ohms, $\pm 3\%$ , 2.5 W<br>Wirewound            | 106-0478-00            | Dale<br>NS2C-24 Ohms-3%       | 4        |
| R67,69,71,73           | RESISTOR, Fixed<br>24 Ohms, $\pm 3\%$ , 5 W<br>Wirewound              | 106-0471-00            | Dale<br>NS5-24 Ohms-3%        | 4        |
| R76                    | RESISTOR, Fixed<br>2000 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0202-00            | Allen-Bradley<br>CB-2025      | 1        |

## REPLACEMENT PARTS LIST

MEMORY ASSEMBLY

ASSEMBLY NO. 190-1375-00  
 SCHEMATIC NO. 138-001706

| REFERENCE DESIGNATION | COMPONENT DESCRIPTION   | FABRI-TEK IDENT.NUMBER | MANUFACTURER AND IDENT.NUMBER | QUANTITY |
|-----------------------|---|------------------------|-------------------------------|----------|
| R82-89,257            | RESISTOR, Fixed<br>560 Ohms, $\pm 5\%$ , 1/2 W<br>Carbon Composition  | 101-0561-00            | Allen-Bradley<br>EB-5615      | 9        |
| R90                   | RESISTOR, Fixed<br>10 Ohms, $\pm 5\%$ , 1/2 W<br>Carbon Composition   | 101-0100-00            | Allen-Bradley<br>EB-1005      | 1        |
| R129-146              | RESISTOR, Fixed<br>1000 Ohms, $\pm 5\%$ , 1/2 W<br>Carbon Composition | 101-0102-00            | Allen-Bradley<br>EB-1025      | 18       |
| R147-164              | RESISTOR, Fixed<br>8 Ohms, $\pm 1\%$ , 3 W<br>Wirewound               | 106-0475-00            | Dale<br>NS2B-8 Ohms-1%        | 18       |
| R165-182              | RESISTOR, Fixed<br>100 Ohms, $\pm 5\%$ , 1/2 W<br>Carbon Composition  | 101-0101-00            | Allen-Bradley<br>EB-1015      | 18       |
| R258,259              | RESISTOR, Fixed<br>750 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0751-00            | Allen-Bradley<br>CB-7515      | 2        |
| RM1-9                 | INTEGRATED ASSEMBLY<br>Resistor Package                               | 151-0002-00            | Sprague<br>914C17             | 9        |
| T1,2                  | INTEGRATED ASSEMBLY<br>Transformer Package                            | 151-0004-00            | Sprague<br>23Z811             | 2        |
| T3,21,23-31           | INTEGRATED ASSEMBLY<br>Transformer Package                            | 151-0003-00            | Sprague<br>914C17             | 11       |
| T4-20,22              | INTEGRATED ASSEMBLY<br>Switch Transformer                             | 151-0001-00            | Sprague<br>SK9072             | 18       |
| U1,2,4,5,43-48        | INTEGRATED CIRCUIT<br>BCD to DEC<br>DCDR-DRV                          | 134-0211-00            | Texas Instruments<br>SN74145N | 10       |

**REPLACEMENT PARTS LIST**

ASSEMBLY NO. 190-1375-00  
 SCHEMATIC NO. 138-001706

**MEMORY ASSEMBLY**

| REFERENCE DESIGNATION            | COMPONENT DESCRIPTION                                      | FABRI-TEK IDENT. NUMBER | MANUFACTURER AND IDENT. NUMBER | QUANTITY |
|----------------------------------|--|-------------------------|--------------------------------|----------|
| U3,21,22,26,33                   | INTEGRATED CIRCUIT<br>Triple, 3-Input<br>NAND Gate         | 134-0167-00             | Texas Instruments<br>SN74H10N  | 5        |
| U6,30                            | INTEGRATED CIRCUIT<br>Triple, 3-Input<br>Pos. AND Gate     | 134-0213-00             | Texas Instruments<br>SN74S11N  | 2        |
| U7,36,42                         | INTEGRATED CIRCUIT<br>HEX Inverter                         | 134-0209-00             | Texas Instruments<br>SN74S04N  | 3        |
| U8,9,10,11,32,37,<br>38,39,40,41 | INTEGRATED CIRCUIT<br>Quad, 2-Input<br>NAND Buffer         | 134-0195-00             | Texas Instruments<br>SN7438N   | 10       |
| U12,13,14                        | INTEGRATED CIRCUIT<br>Dual Peripheral<br>Pos. NAND Driver  | 134-0212-00             | Texas Instruments<br>SN75452P  | 3        |
| U15,23,31                        | INTEGRATED CIRCUIT<br>HEX Inverter                         | 134-0173-00             | Texas Instruments<br>SN74H04N  | 3        |
| U16,28                           | INTEGRATED CIRCUIT<br>Dual, 4-Input<br>NAND, Buffer-Driver | 134-0205-00             | Texas Instruments<br>SN74S40N  | 2        |
| U17,20                           | INTEGRATED CIRCUIT<br>Dual, 4-Input<br>NAND/NOR Gate       | 134-0206-00             | Texas Instruments<br>SN74S20N  | 2        |
| U18,35                           | INTEGRATED CIRCUIT<br>Triple, 3-Input<br>NAND/NOR Gate     | 134-0168-00             | Texas Instruments<br>SN74H11N  | 2        |
| U19,24,34                        | INTEGRATED CIRCUIT<br>Quad, 2-Input<br>NAND/NOR Gate       | 134-0165-00             | Texas Instruments<br>SN74H00N  | 3        |
| U25, 49-66                       | INTEGRATED CIRCUIT<br>Dual Driver                          | 134-0189-00             | Texas Instruments<br>SN75451P  | 19       |
| U27,29                           | INTEGRATED CIRCUIT<br>Quad, 2-Input<br>NAND/NOR Gate       | 134-0207-00             | Texas Instruments<br>SN74S00N  | 2        |

**REPLACEMENT PARTS LIST**

**MEMORY ASSEMBLY**

**ASSEMBLY NO.** 190-1375-00  
**SCHEMATIC NO.** 138-001706

| REFERENCE<br>DESIGNATION | COMPONENT<br>DESCRIPTION                             | FABRI-TEK<br>IDENT.NUMBER | MANUFACTURER<br>AND IDENT.NUMBER    | QUANTITY |
|--------------------------|--|---------------------------|-------------------------------------|----------|
| U67-75                   | INTEGRATED CIRCUIT<br>Quad, 2-Input<br>NAND/NOR Gate | 134-0166-00               | Texas Instruments<br>SN74H01N       | 9        |
| U76-93                   | INTEGRATED CIRCUIT<br>Dual Comparator                | 134-0131-00               | Fairchild<br>U5F771139X<br>(NA711C) | 18       |

## REPLACEMENT PARTS LIST

TIMING AND CONTROL MODULE

ASSEMBLY NO. 190-1376-00  
SCHEMATIC NO. 138-001707

| REFERENCE DESIGNATION                        | COMPONENT DESCRIPTION                                  | FABRI-TEK IDENT. NUMBER | MANUFACTURER AND IDENT. NUMBER | QUANTITY |
|--|--|-------------------------|--------------------------------|----------|
| C1,4,5,7                                     | CAPACITOR, Fixed 0.01 UF, $\pm 20\%$ , 50V Ceramic     | 023-0455-00             | Centralab UK50-103             | 4        |
| C2,3,9,10,11,12, 13,17,18,20,23, 24          | CAPACITOR, Fixed 15 UF, $\pm 20\%$ , 20V Tantalum      | 023-0518-00             | Dickson D15ZLX20M              | 12       |
| C6,14,15,16                                  | CAPACITOR, Fixed 220 UUF, $\pm 2\%$ , 500V Silver Mica | 023-0469-00             | Sangamo D105D221G0             | 4        |
| C8,19  | CAPACITOR, Fixed 33 UUF, $\pm 20\%$ , 1000V Ceramic    | 023-0128-00             | Aerovox CK60BX330M             | 2        |
| C21  | CAPACITOR, Fixed 1.0 UF, $\pm 10\%$ , 35V Tantalum     | 023-0106-00             | CS13AF010K                     | 1        |
| C22  | CAPACITOR, Fixed 1000 UUF, $\pm 20\%$ , 1000V Ceramic  | 023-0132-00             | CK60AW102M                     | 1        |
| C25  | CAPACITOR, Fixed 390 UUF, $\pm 2\%$ , 100V Silver Mica | 023-0465-00             | CDE CD7FA391G03                | 1        |
| CR1,2,3,4,5,6,8, 9,10,11                     | DIODE, Switching 1N4607                                | 022-0309-00             | Fairchild 1N4607               | 10       |
| CR7  | DIODE, Zener 5.1V                                      | 022-0018-00             | Motorola 1N751A                | 1        |
| Q1,2,3,4,5,6,7, 8,9,14,16,17,26, 31          | TRANSISTOR, NPN 2N4014<br>Low Power Switching          | 021-0223-00             | Sprague 2N4014                 | 14       |
| Q10,11,12,13,15, 18,19,20,21,22, 23,24,25,35 | TRANSISTOR 2N3467                                      | 021-0224-00             | Motorola 2N3467                | 14       |
| Q27,28,29,30,32, 33,34,36,37,38              | TRANSISTOR, Similar to 2N3725                          | 021-0137-00             | FABRI-TEK 021-0137-00          | 10       |

# REPLACEMENT PARTS LIST

TIMING AND CONTROL MODULE

ASSEMBLY NO. 190-1376-00  
SCHEMATIC NO. 138-001707

| REFERENCE DESIGNATION  | COMPONENT DESCRIPTION   | FABRI-TEK IDENT.NUMBER | MANUFACTURER AND IDENT.NUMBER | QUANTITY |
|--|---|------------------------|-------------------------------|----------|
| R1,2,22,25,26,<br>27,28,29,34,35,<br>64,67,72,73,88,<br>92,101,105,110,<br>113,117,118,119 | RESISTOR, Fixed<br>1000 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0102-00            | Allen-Bradley<br>CB-1025      | 23       |
| R3,20,65,66  | RESISTOR, Fixed<br>4700 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0472-00            | Allen-Bradley<br>CB-4725      | 4        |
| R4,8,10,12,14,16<br>18,36,38,40,42,<br>44,46,48,50,52,<br>54,56,58,60,62,<br>69,139        | RESISTOR, Fixed<br>330 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0331-00            | Allen-Bradley<br>CB-3315      | 23       |
| R5,9,11,13,15,<br>17,19,37,39,41,<br>43,45,47,49,51,<br>53,55,57,59,61,<br>63,70,140       | RESISTOR, Fixed<br>390 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0391-00            | Allen-Bradley<br>CB-3915      | 23       |
| R6,89,102,116  | RESISTOR, Fixed<br>180 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0181-00            | Allen-Bradley<br>CB-1815      | 4        |
| R7,21,80,86,99   | RESISTOR, Fixed<br>220 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0221-00            | Allen-Bradley<br>CB-2115      | 5        |
| R23,24,30,31,32,<br>33   | RESISTOR, Fixed<br>2000 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0202-00            | Allen-Bradley<br>CB-2025      | 6        |
| R71,85,98  | RESISTOR, Fixed<br>100 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0101-00            | Allen-Bradley<br>CB-1015      | 3        |
| R74  | RESISTOR, Fixed<br>510 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0511-00            | Allen-Bradley<br>CB-5115      | 1        |
| R75  | RESISTOR, Fixed<br>221 Ohms, $\pm 1\%$ , 1/4 W<br>Film                | 202-2210-00            | IRC<br>RN60D2210F             | 1        |

## REPLACEMENT PARTS LIST

ASSEMBLY NO. 190-1376-00  
 SCHEMATIC NO. 138-001707

TIMING AND CONTROL MODULE

| REFERENCE DESIGNATION            | COMPONENT DESCRIPTION  | FABRI-TEK IDENT NUMBER | MANUFACTURER AND IDENT. NUMBER | QUANTITY |
|----------------------------------|--|------------------------|--------------------------------|----------|
| R76,81,82,84,87,<br>97,100       | RESISTOR, Fixed<br>39 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0390-00            | Allen-Bradley<br>CB-3905       | 7        |
| R77                              | RESISTOR, Fixed<br>82 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0820-00            | Allen-Bradley<br>CB-8205       | 1        |
| R78,130                          | RESISTOR, Fixed<br>Value determined during<br>final testing.         | 108-0000-99            |                                | 2        |
| R79                              | RESISTOR, Fixed<br>68 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0680-00            | Allen-Bradley<br>CB-6805       | 1        |
| R83,91,96,104                    | RESISTOR, Fixed<br>8 Ohms, $\pm 1\%$ , 3 W<br>Wirewound              | 106-0475-00            | Dale<br>NS2B-8 Ohms-1%         | 4        |
| R90,93,94,95,103,<br>106,107,108 | RESISTOR, Fixed<br>10 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0100-00            | Allen-Bradley<br>CB-1005       | 8        |
| R109,111,112                     | RESISTOR, Fixed<br>470 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0471-00            | Allen-Bradley<br>CB-4715       | 3        |
| R114,115                         | RESISTOR, Fixed<br>910 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0911-00            | Allen-Bradley<br>CB-9115       | 2        |
| R120,125                         | RESISTOR, Fixed<br>150 Ohms, $\pm 3\%$ , 1 W<br>Wirewound            | 106-0480-00            | Dale<br>NS-1A-150 Ohms-1W-3%   | 2        |
| R121,137                         | RESISTOR, Fixed<br>910 Ohms, $\pm 5\%$ , 1/2 W<br>Carbon Composition | 101-0911-00            | Allen-Bradley<br>EB-9115       | 2        |
| R122,123,124,<br>126,127,128     | RESISTOR, Fixed<br>1.0 Ohms, $\pm 5\%$ , 1/2 W<br>Carbon Composition | 101-0109-00            | Allen-Bradley<br>EB-0105       | 6        |

## REPLACEMENT PARTS LIST

TIMING AND CONTROL MODULE

ASSEMBLY NO. 190-1376-00  
 SCHEMATIC NO. 138-001707

| REFERENCE DESIGNATION                           | COMPONENT DESCRIPTION   | FABRI-TEK IDENT.NUMBER | MANUFACTURER AND IDENT.NUMBER   | QUANTITY |
|---|---|------------------------|---------------------------------|----------|
| R129  | RESISTOR, Fixed 8250 Ohms, $\pm 1\%$ , 1/4 W Film               | 202-8251-00            | IRC RN60D8251F                  | 1        |
| R131  | RESISTOR, Fixed 2430 Ohms, $\pm 1\%$ , 1/4 W Film               | 202-2431-00            | IRC RN60D2431F                  | 1        |
| R132  | RESISTOR, Fixed 0.8 Ohm, $\pm 3\%$ , 1 W Wirewound              | 106-0481-00            | Dale NS1A-0.8 Ohm- $\pm 3\%-1W$ | 1        |
| R133,134,135,<br>136                            | RESISTOR, Fixed 4700 Ohms, $\pm 5\%$ , 1/2 W Carbon Composition | 101-0479-00            | Allen-Bradley EB-4715           | 4        |
| R138  | RESISTOR, Fixed 68 Ohms, $\pm 5\%$ , 1/4 W Carbon Composition   | 108-0680-00            | Allen-Bradley CB-6805           | 1        |
| RT1   | THERMISTOR 100 Ohms, $\pm 10\% @ 25^\circ C$                    | 037-0042-00            | General Electric 2D204          | 1        |
| T1  | INTEGRATED ASSEMBLY Switch Transformer                          | 151-0007-00            | Sprague SK9093                  | 1        |
| T2,3  | TRANSFORMER, Pulse  | 019-0223-00            | FABRI-TEK 019-0223-00           | 2        |
| U1,2,3,4,8,9,10,<br>12,13,14,18,20,<br>23,24,35 | INTEGRATED CIRCUIT Dual, 4-Input NAND/NOR Gate                  | 134-0171-00            | Texas Instruments SN74H40N      | 15       |
| U5,39,40,74,77                                  | INTEGRATED CIRCUIT Triple, 3-Input NAND/NOR Gate                | 134-0168-00            | Texas Instruments SN74H11N      | 5        |
| U6,7,16,17,25,87                                | INTEGRATED CIRCUIT Dual, 4-Input NAND, Buffer-Driver            | 134-0205-00            | Texas Instruments SN74S40N      | 6        |
| U11,21,62                                       | INTEGRATED CIRCUIT Dual, 4-Input AND Gate                       | 134-0170-00            | Texas Instruments SN74H21N      | 3        |

**REPLACEMENT PARTS LIST**

TIMING AND CONTROL MODULE

ASSEMBLY NO. 190-1376-00  
SCHEMATIC NO. 138-001707

| REFERENCE DESIGNATION              | COMPONENT DESCRIPTION                               | FABRI-TEK IDENT.NUMBER | MANUFACTURER AND IDENT.NUMBER | QUANTITY |
|------------------------------------|---|------------------------|-------------------------------|----------|
| U15,19,22,73                       | INTEGRATED CIRCUIT HEX Inverter                     | 134-0173-00            | Texas Instruments SN74H04N    | 4        |
| U26,56                             | INTEGRATED CIRCUIT HEX Inverter                     | 134-0209-00            | Texas Instruments SN74S04N    | 2        |
| U27,28,29,30,31,<br>32,33,34,36,37 | INTEGRATED CIRCUIT Dual, 2-Input AND/OR Inverter    | 134-0220-00            | Texas Instruments SN74H51N    | 10       |
| U38                                | INTEGRATED CIRCUIT Quad, 2-Input NAND Buffer        | 134-0195-00            | Texas Instruments SN7438N     | 1        |
| U41,42,53,54,63,<br>65             | INTEGRATED CIRCUIT Dual, 4-Input NAND/NOR Gate      | 134-0169-00            | Texas Instruments SN74H20N    | 6        |
| U43,44,45,46,47,<br>48,61,71       | INTEGRATED CIRCUIT Dual Flip-Flop Edge Triggered    | 134-0188-00            | Texas Instruments SN74H74N    | 8        |
| U51,52,57,58,89                    | INTEGRATED CIRCUIT Triple, 3-Input NAND Gate        | 134-0167-00            | Texas Instruments SN74H10N    | 5        |
| U55,64,66,68,83,<br>84,92          | INTEGRATED CIRCUIT Quad, 2-Input NAND/NOR Gate      | 134-0165-00            | Texas Instruments SN74H00N    | 7        |
| U72                                | INTEGRATED CIRCUIT Dual Peripheral Pos. NAND Driver | 134-0212-00            | Texas Instruments SN75452F    | 1        |
| U75,78                             | INTEGRATED CIRCUIT Triple, 3-Input Pos. AND Gate    | 134-0213-00            | Texas Instruments SN74S11N    | 2        |
| U79                                | INTEGRATED CIRCUIT Quad, 2-Input NAND/NOR Gate      | 134-0207-00            | Texas Instruments SN74S00N    | 1        |
| U82                                | INTEGRATED CIRCUIT HEX Inverter                     | 134-0191-00            | Texas Instruments SN74H05N    | 1        |

**REPLACEMENT PARTS LIST**

ASSEMBLY NO. 190-1376-00  
 SCHEMATIC NO. 138-001707

TIMING AND CONTROL MODULE

| REFERENCE DESIGNATION | COMPONENT DESCRIPTION                                | FABRI-TEK IDENT.NUMBER | MANUFACTURER AND IDENT.NUMBER   | QUANTITY |
|-----------------------|--|------------------------|---------------------------------|----------|
| U86                   | INTEGRATED CIRCUIT<br>Dual, 4-Input<br>NAND/NOR Gate | 134-0206-00            | Texas Instruments<br>SN74S20N   | 1        |
| U93                   | INTEGRATED CIRCUIT<br>Voltage Regulator              | 134-0255-00            | National Semiconductor<br>LM304 | 1        |

# REPLACEMENT PARTS LIST

TERMINATION BOARD ASSEMBLY

**ASSEMBLY NO.** 190-1391-TAB\*  
**SCHEMATIC NO.** N/A

| REFERENCE DESIGNATION | COMPONENT DESCRIPTION   | FABRI-TEK IDENT.NUMBER | MANUFACTURER AND IDENT.NUMBER | QUANTITY |
|-----------------------|---|------------------------|-------------------------------|----------|
| Component 1**         | CAPACITOR, Fixed<br>15 UF, <u>+10%</u> , 20V<br>Tantalum              | 023-0105-00            | Sangamo<br>CS13BE156K         | ***      |
| Component 2**         | RESISTOR, Fixed<br>330 Ohms, <u>+5%</u> , 1/4 W<br>Carbon Composition | 108-0331-00            | Allen-Bradley<br>CB-3315      | ***      |
| Component 3**         | RESISTOR, Fixed<br>390 Ohms, <u>+5%</u> , 1/4 W<br>Carbon Composition | 108-0391-00            | Allen-Bradley<br>CB-3915      | ***      |

\* 190-1391-TAB represents the following assemblies:

190-1391-01  
 190-1391-02  
 190-1391-03  
 190-1391-04

\*\* Standard component reference designations not assigned.

\*\*\* Component quantity for each assembly TAB number.

| COMPONENT | -01 | -02 | -03 | -04 |
|-----------|-----|-----|-----|-----|
| 1         | 1   | 1   | 1   | 1   |
| 2         | 15  | 14  | 11  | 11  |
| 3         | 15  | 14  | 11  | 11  |

**REPLACEMENT PARTS LIST**

24K MULTIPLEX/8E ASSEMBLY

ASSEMBLY NO. 190-1601-00  
SCHEMATIC NO. 138-001880

| REFERENCE DESIGNATION  | COMPONENT DESCRIPTION  | FABRI-TEK IDENT.NUMBER | MANUFACTURER AND IDENT.NUMBER | QUANTITY |
|--|--|------------------------|-------------------------------|----------|
| A1R2,A1R4,A1R6,<br>A2R2,A2R4,A2R6,<br>A2R8,A2R10,<br>A2R12,A2R14,A3R2,<br>A3R4,A3R6,A3R8,<br>A3R10,A3R12,A4R2,<br>A4R4,A4R6,A4R8,<br>A4R10,A5R2,A6R2,<br>A6R4,A6R6,A6R8,<br>A6R10,A6R12,<br>A6R14,A6R16,<br>A7R2,A7R4,A7R6,<br>A7R8,A7R10,A8R2,<br>A8R4,A8R6,A8R8,<br>A8R10,A8R12,<br>A8R14,A9R2,A9R4,<br>A9R6,A9R8,A9R10,<br>A9R12,A10R2,<br>A10R4,A10R6,<br>B8R1,D1R1,D10R1,<br>E9R1,F10R1,<br>F10R3 | RESISTOR, Fixed<br>390 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0391-00            | Allen-Bradley<br>CB-3915      | 57       |
| A7R11,D8R1,E8R1,<br>F9R1   | RESISTOR, Fixed<br>1K Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition  | 108-0102-00            | Allen-Bradley<br>CB-1025      | 4        |
| E1R1,E2R1,E10R1  | RESISTOR, Fixed<br>4.75K Ohms, $\pm 1\%$ , 1/8W<br>Film              | 201-4751-00            | Mepco<br>RN55D4751F           | 3        |
| E2R2,E3R1  | RESISTOR, Fixed<br>8.25K Ohms, $\pm 1\%$ , 1/8W                      | 201-8251-00            | Mepco<br>RN55D8251F           | 2        |
| E9R2   | RESISTOR, Fixed<br>10.0K Ohms, $\pm 1\%$ , 1/8W<br>Film              | 201-1002-00            | Mepco<br>RN55D1002F           | 1        |
| B1U1,B2U1,B3U1,<br>B4U1,B5U1,B6U1,<br>B7U1,B8U1,B9U1   | INTEGRATED CIRCUIT<br>Quad Latch                                     | 134-0197-00            | Texas Instruments<br>SN7475N  | 9        |
| C1U1,C2U1,C3U1,<br>C4U1,C5U1,C6U1,<br>C7U1,C8U1,C9U1   | INTEGRATED CIRCUIT<br>Quad Selector/<br>Multiplexer                  | 134-0263-00            | Texas Instruments<br>SN74157N | 9        |

**REPLACEMENT PARTS LIST**

24K MULTIPLEX/8E ASSEMBLY

ASSEMBLY NO. 190-1601-00  
SCHEMATIC NO. 138-001880

| REFERENCE DESIGNATION             | COMPONENT DESCRIPTION                                  | FABRI-TEK IDENT.NUMBER | MANUFACTURER AND IDENT.NUMBER  | QUANTITY |
|-----------------------------------|--|------------------------|--------------------------------|----------|
| D1U1,D2U1,D5U1,<br>D6U1,D8U1,D9U1 | INTEGRATED CIRCUIT<br>Dual Selector/<br>Multiplexer    | 134-0281-00            | Texas Instruments<br>SN74S153N | 6        |
| D3U1,D4U1,D7U1                    | INTEGRATED CIRCUIT<br>Quad Exclusive OR                | 134-0185-00            |                                | 3        |
| E1U1,E2U1,E9U1                    | INTEGRATED CIRCUIT<br>Dual Monostable<br>Multivibrator | 134-0198-00            | Texas Instruments<br>SN74123N  | 3        |
| E3U1,E4U1,E6U1,<br>E7U1,E8U1      | INTEGRATED CIRCUIT<br>Quad NAND OC                     | 134-0195-00            | Texas Instruments<br>SN7438N   | 5        |
| E5U1                              | INTEGRATED CIRCUIT<br>Hex Inverter                     | 134-0173-00            | Texas Instruments<br>SN74H04N  | 1        |
| F8U1                              | INTEGRATED CIRCUIT<br>BCD to DEC Decoder               | 134-0199-00            | Texas Instruments<br>SN7442N   | 1        |
| F9U1                              | INTEGRATED CIRCUIT<br>Dual D Flip-Flop                 | 134-0188-00            | Texas Instruments<br>SN74H74N  | 1        |

## REPLACEMENT PARTS LIST

STACK ELECTRICAL ASSEMBLY

ASSEMBLY NO. 250-0364-00  
 SCHEMATIC NO. 138-001700

| REFERENCE DESIGNATION | COMPONENT DESCRIPTION  | FABRI-TEK IDENT.NUMBER | MANUFACTURER AND IDENT.NUMBER | QUANTITY |
|-----------------------|--|------------------------|-------------------------------|----------|
| *                     | RESISTOR, Fixed<br>470 Ohms, $\pm 5\%$ , 1/2 W<br>Carbon Composition | 101-0471-00            | Allen-Bradley<br>EB-4715      | 16       |
| *                     | RESISTOR, Fixed<br>470 Ohms, $\pm 5\%$ , 1/4 W<br>Carbon Composition | 108-0471-00            | Allen-Bradley<br>CB-4715      | 96       |
| *                     | DIODE ARRAY<br>16 Diodes per Array                                   | 022-0324-00            | Texas Instruments<br>TID126   | 24       |

\*Reference designations not assigned.

## REPLACEMENT PARTS LIST

ASSEMBLY NO. 256-0232-00  
 SCHEMATIC NO. N/A

DIGITAL STACK ASSEMBLY

| REFERENCE DESIGNATION | COMPONENT DESCRIPTION                   | FABRI-TEK IDENT.NUMBER | MANUFACTURER AND IDENT.NUMBER | QUANTITY |
|-----------------------|---|------------------------|-------------------------------|----------|
| *                     | *ASSEMBLY, Memory Printed Circuit Board | 190-1375-00            | FABRI-TEK<br>190-1375-00      | 1        |
| *                     | *ASSEMBLY Stack, 8K x 18                | 250-0364-00            | FABRI-TEK<br>250-0364-00      | 1        |

\*Reference designations not assigned.

\*Refer to the component lists for these assemblies.

## **SECTION VI REFERENCE DOCUMENTS**

| <b>DRAWING NUMBER</b> | <b>TITLE</b>               | <b>PAGES</b> |
|-----------------------|----------------------------|--------------|
| 138-001700            | Stack Electrical Assembly  | 1-4          |
| 138-001706            | Memory Assembly            | 1-28         |
| 138-001707            | Timing and Control Module  | 1-15         |
| 138-001880            | 24K Multiplex 8/I Assembly | 1-12         |

E.C.O. #15541 REV B  
MIST. REVISED & REDRAWN

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5

1. UNLESS OTHERWISE SPECIFIED:
  - A. ALL RESISTORS 1/4W, 5% AND IN OHMS.
  - B. ALL DIODES 1N4607.
2. ← THIS SYMBOL REPRESENTS THE PINS WHICH ARE PART OF THE CORE ARRAY ASSEMBLY. IT INDICATES A MALE CONNECTOR. IT DOES NOT NECESSARILY INDICATE SIGNAL DIRECTION.
3. REFERENCE PAGE 3. THE RESISTORS IN PARALLEL WITH THE Y LINES ARE 470 OHMS, 5%, 1/4W, AND CARRY AN R DESIGNATION 100 HIGHER THAN THE Y LINE IT PARALLELS.  
EXAMPLE: Y LINE 5 IS PARALLELED BY R105.

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| REVISION STATUS OF SHEETS |   |   |   |   |     |   |   |   |   |   |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |  |  |  |
|---------------------------|---|---|---|---|-----|---|---|---|---|---|---|---|---|---|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|--|--|--|
|                           | R | B | C | B | END | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 | 19 | 20 | 21 | 22 | 23 | 24 | 25 | 26 | 27 | 28 | 29 | 30 | 31 | 32 | 33 | 34 | 35 | 36 |  |  |  |
|                           |   |   |   |   |     |   |   |   |   |   |   |   |   |   |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |    |  |  |  |

F

APPROVED  
*R. Dodge*

DATE  
2/17/72

TITLE

SCHEMATIC CORE ARRAY ASSEMBLY

DWG. NO.

C 138-001700

MODEL

VERS.

PAGE 1 OF 4



E.C.O.  
HIST.

2

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A

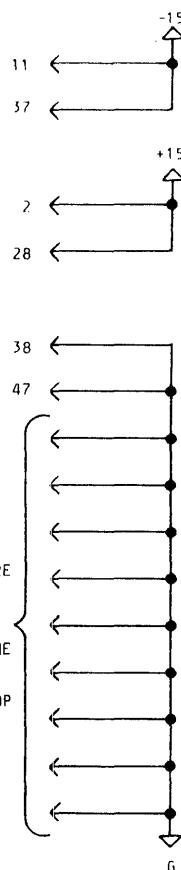
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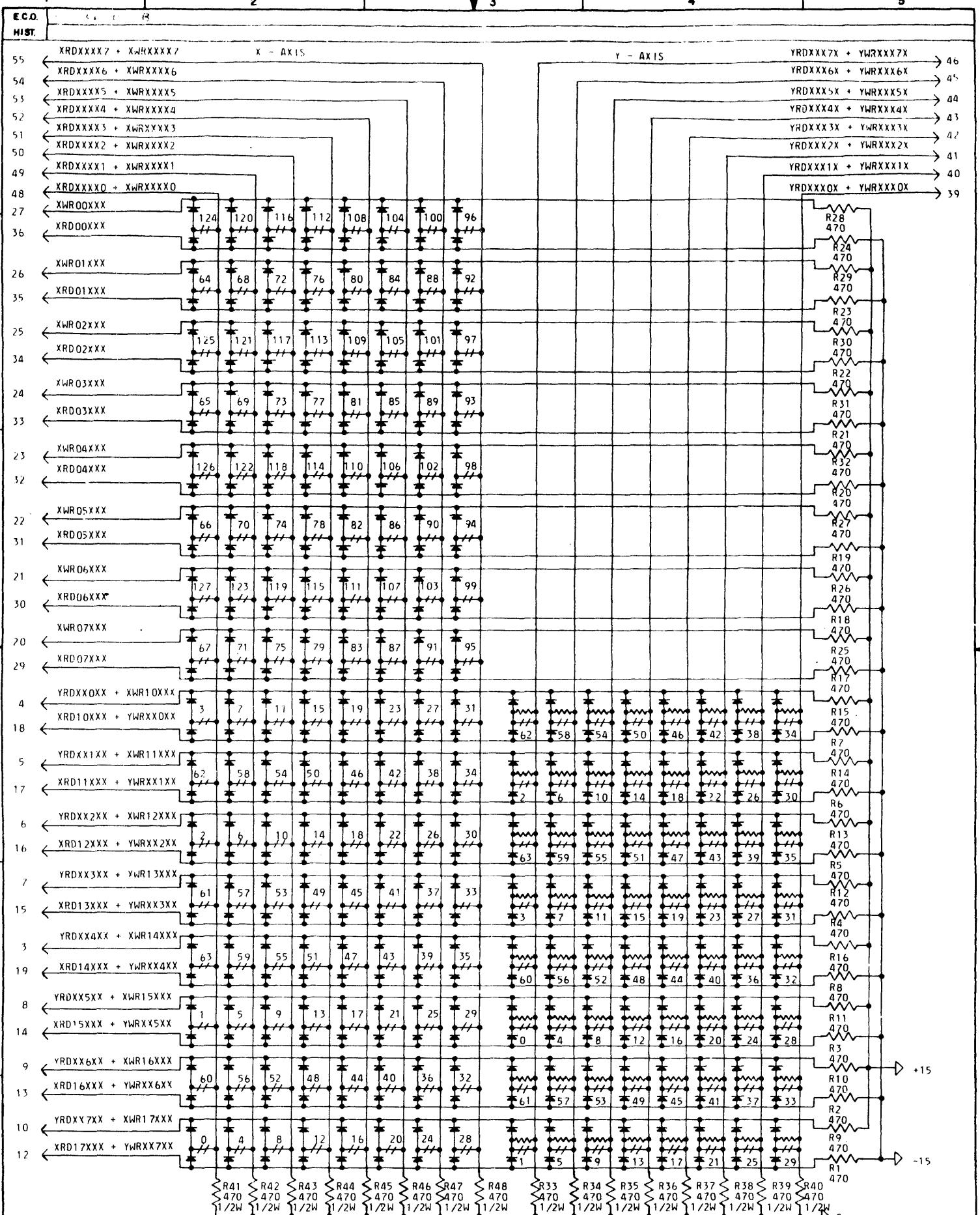
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**FABRI-TEK INC.**  
MEMORY PRODUCTS DIVISION

**TITLE**      SCHEMATIC CORE ARRAY ASSEMBLY

DWG. NO.

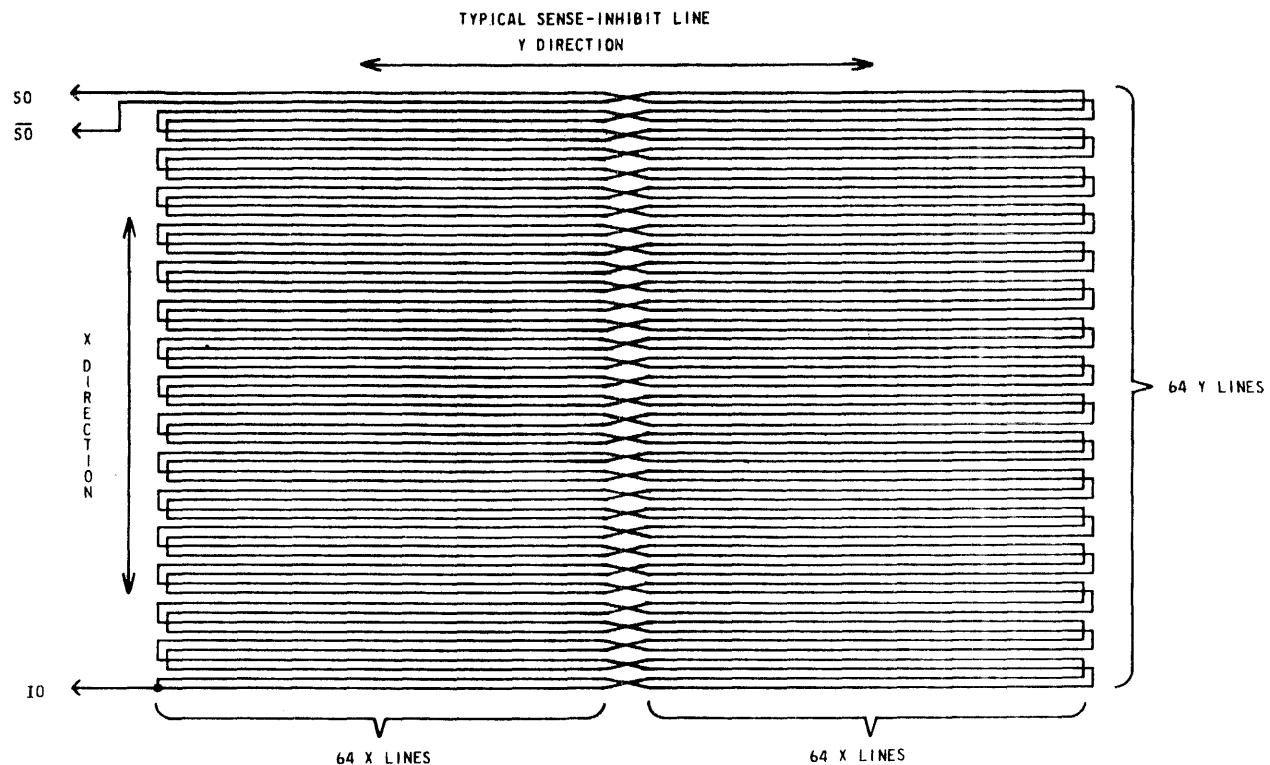
C 138-001700

MODEL

VERS.

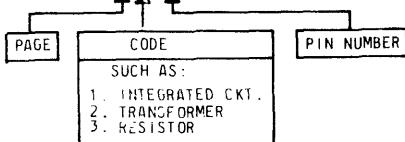
PAGE

3



| E.C.O. | # 15342 | ECO 15923 | EC 15935 | <b>EC 16339</b> | <b>EC 17034</b> | EC 17634 | EC 18049 | EC 18316 |  |
|--------|---------|-----------|----------|-----------------|-----------------|----------|----------|----------|--|
| HIST.  | A       | B         | OOC      | OOD             | OIE             | 01F      | 01G      | 01H      |  |

1. UNLESS OTHERWISE SPECIFIED:
    - A. ALL RESISTORS 1/4W, 5% AND IN OHMS.
    - B. ALL CAPACITORS IN MICROFARADS.
    - C. ALL TRANSISTORS 2N4014.
    - D. ALL DIODES 1N4607.
  2. LAST REFERENCE DESIGNATION USED C84, CR109, Q71, R259, U93, T31, L2, QM14, RM9.
  3. RESISTOR DESIGNATION R45 WAS NOT USED.
  4. TRANSISTOR MODULE DESIGNATION QM4 WAS NOT USED.
  5. ← THIS SYMBOL REPRESENTS THE CARD EDGE CONNECTOR IT INDICATES A MALE CONNECTOR. IT DOES NOT NECESSARILY INDICATE SIGNAL DIRECTION.
  6. → THIS SYMBOL REPRESENTS THE FEMALE CONNECTOR PINS MOUNTED ON THE MEMORY BOARD. THE STICK PLUGS INTO THESE PINS.
  7. → THIS SYMBOL WILL BE FOUND ON THE LEFT BORDER. IT INDICATES DIRECTION OF SIGNAL FLOW. TO THE LEFT OF THE ARROWHEAD WILL BE THE SIGNAL MNEMONIC, EXAMPLE: MODS, AND THE POINT OF ORIGIN CODE. EXAMPLE: 4U2B-8



8. → THIS SYMBOL WILL BE FOUND ON THE RIGHT BORDER. IT INDICATES DIRECTION OF SIGNAL FLOW. TO THE RIGHT OF THE ARROWHEAD WILL BE THE FULL ENGLISH NAME, IF IT IS THE ORIGIN OF A NEW SIGNAL, AND THE LETTERS UNDERLINED THAT WILL MAKE UP THE MNEMONIC. EXAMPLE: MODULE SELECT. A LIST OF ALL DESTINATIONS WILL BE PRESENT.

| CODE | MANUFACTURER'S PART NUMBER | FTI PART NUMBER |
|------|----------------------------|-----------------|
| 711  | SN72711L                   | 134-0131-00     |
| 38   | SN7438N                    | 134-0195-00     |
| 145  | SN74145N                   | 134-0211-00     |
| H00  | SN74H00N                   | 134-0165-00     |
| H01  | SN74H01N                   | 134-0166-00     |
| H04  | SN74H04N                   | 134-0173-00     |
| H10  | SN74H10N                   | 134-0167-00     |
| H11  | SN74H11N                   | 134-0168-00     |
| S00  | SN74S00N                   | 134-0207-00     |
| S04  | SN74S04N                   | 134-0209-00     |
| S11  | SN74S11N                   | 134-0213-00     |
| S20  | SN74S20N                   | 134-0206-00     |
| S40  | SN74S40N                   | 134-0205-00     |
| 451  | SN75451AN                  | 134-0189-00     |
| 452  | SN75452N                   | 134-0212-00     |

TRANSFORMER BREAKDOWN BY REFERENCE DESIGNATION

|  |             |
|--|-------------|
| T4, T5, T6, T7, T8, T9,<br>T10, T11, T12, T13, T14,<br>T15, T16, T17, T18, T19,<br>T20, T22. | 151-0001-00 |
| T3, T21, T23, T31.   | 151-0003-00 |
| T1, T2.  | 151-0004-00 |

INDUCTOR BREAKDOWN BY REFERENCE DESIGNATION.

L1, L2. 019-0218-00

TRANSISTOR MODULE BREAKDOWN BY REFERENCE DESIGNATION

|   |             |
|---|-------------|
| QM1, QM2, QM3, QM5, QM6,<br>QM7, QM8, QM9, QM10, QM11,<br>QM12, QM13, QM14. | 134-0214-00 |
|---|-------------|

## RESISTOR MODULE BREAKDOWN BY REFERENCE DESIGNATION

|   |             |
|---|-------------|
| RM1, RM2, RM3, RM4, RM5,<br>RM6, RM7, RM8, RM9. | 151-0002-00 |
|---|-------------|

F APPROVED DATE



**FABRI-TEK INC.**  
MEMORY PRODUCTS DIVISION

**TITLE** SCHEMATIC MEMORY ELECTRONICS ASSEMBLY

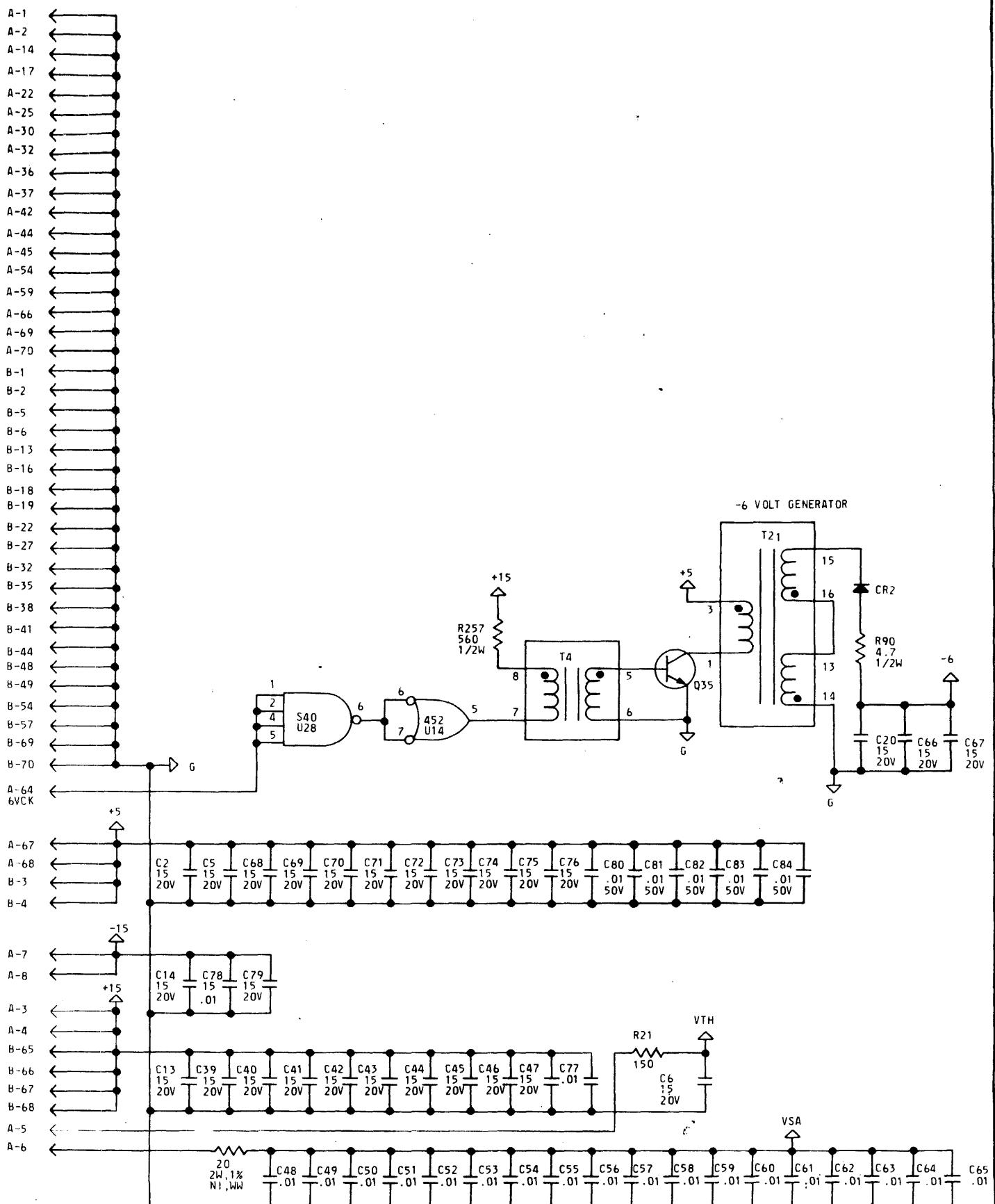
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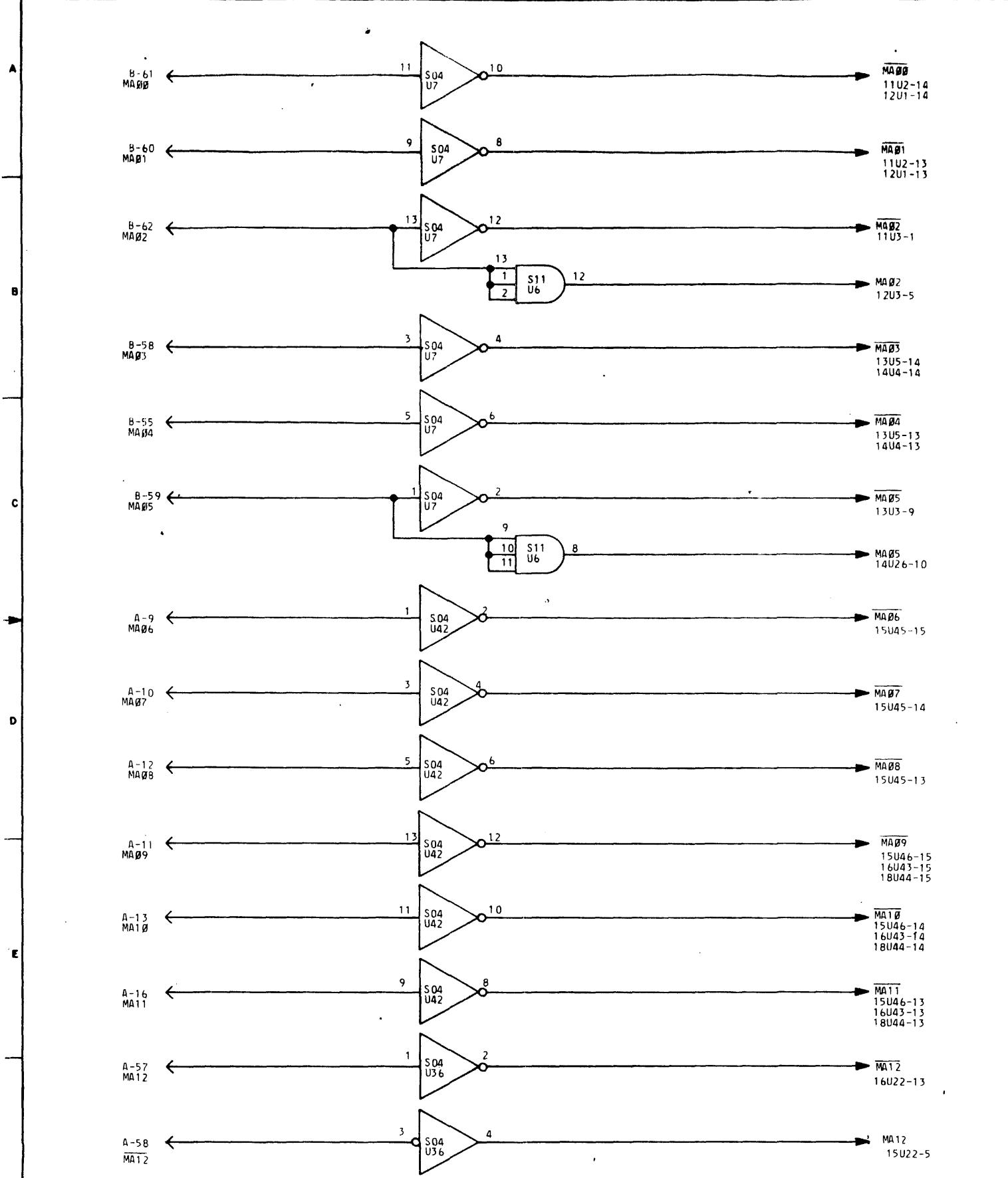
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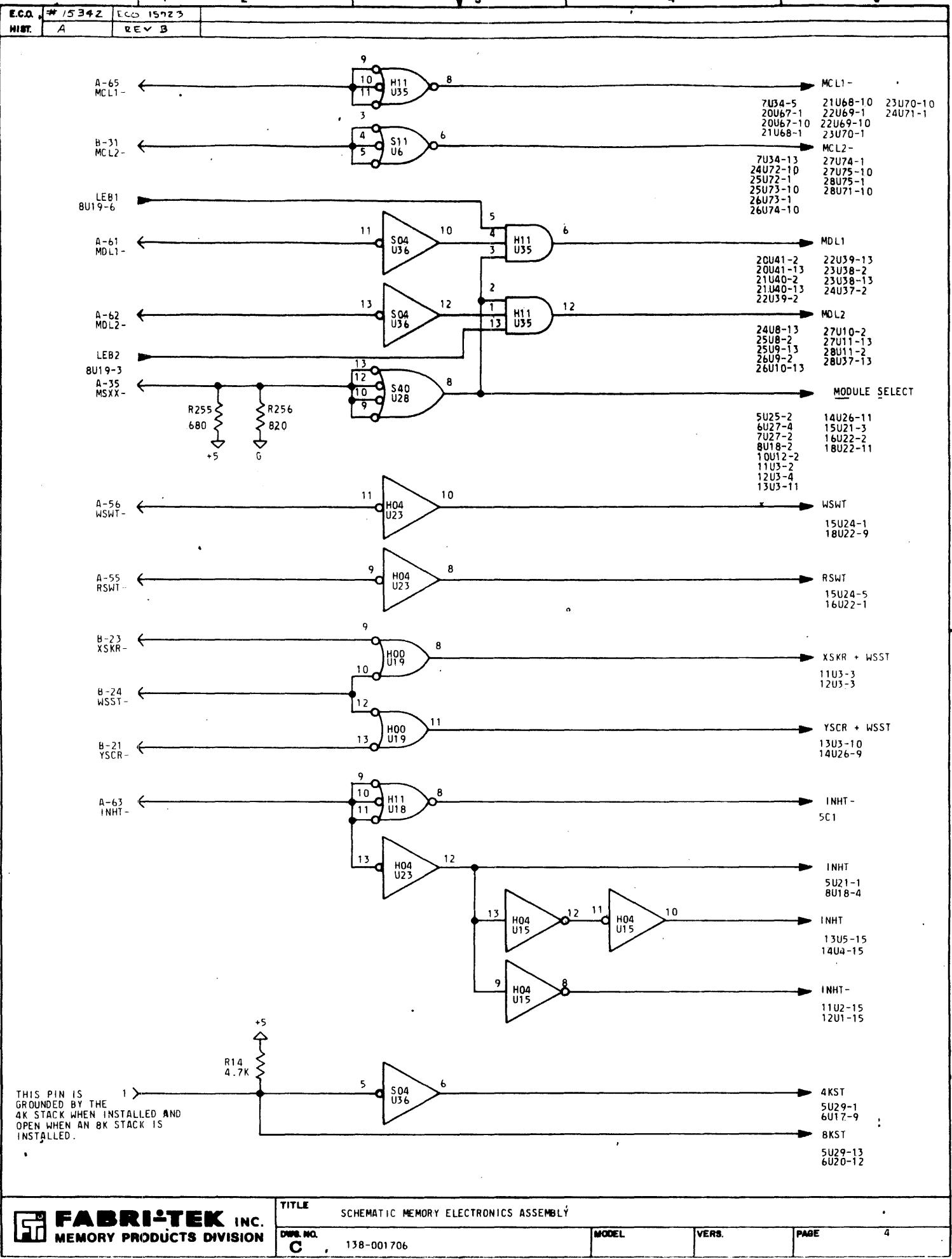
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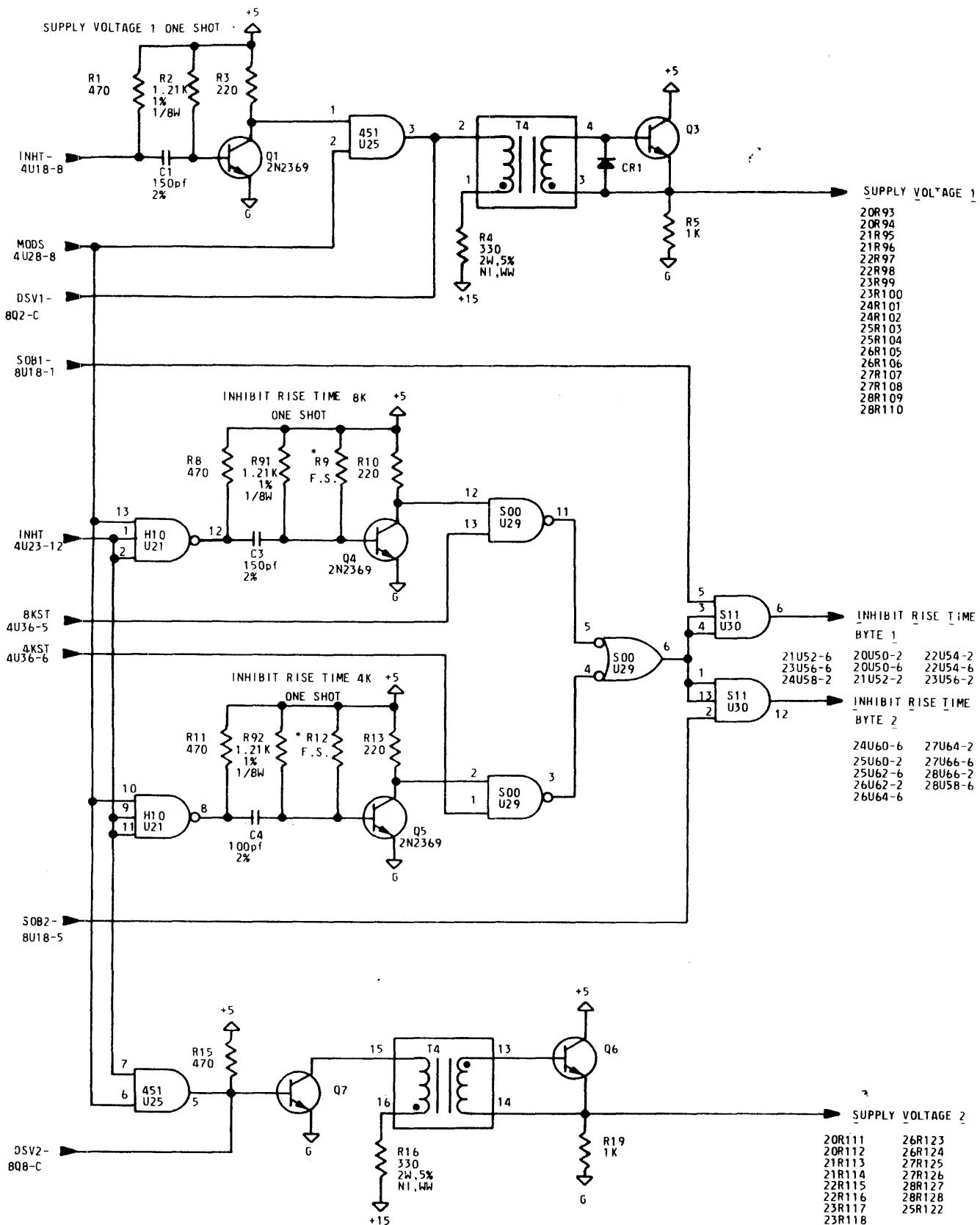
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|      |         |          |
|------|---------|----------|
| ECA  | # 15342 | EC 16339 |
| WIRE | A       | D        |



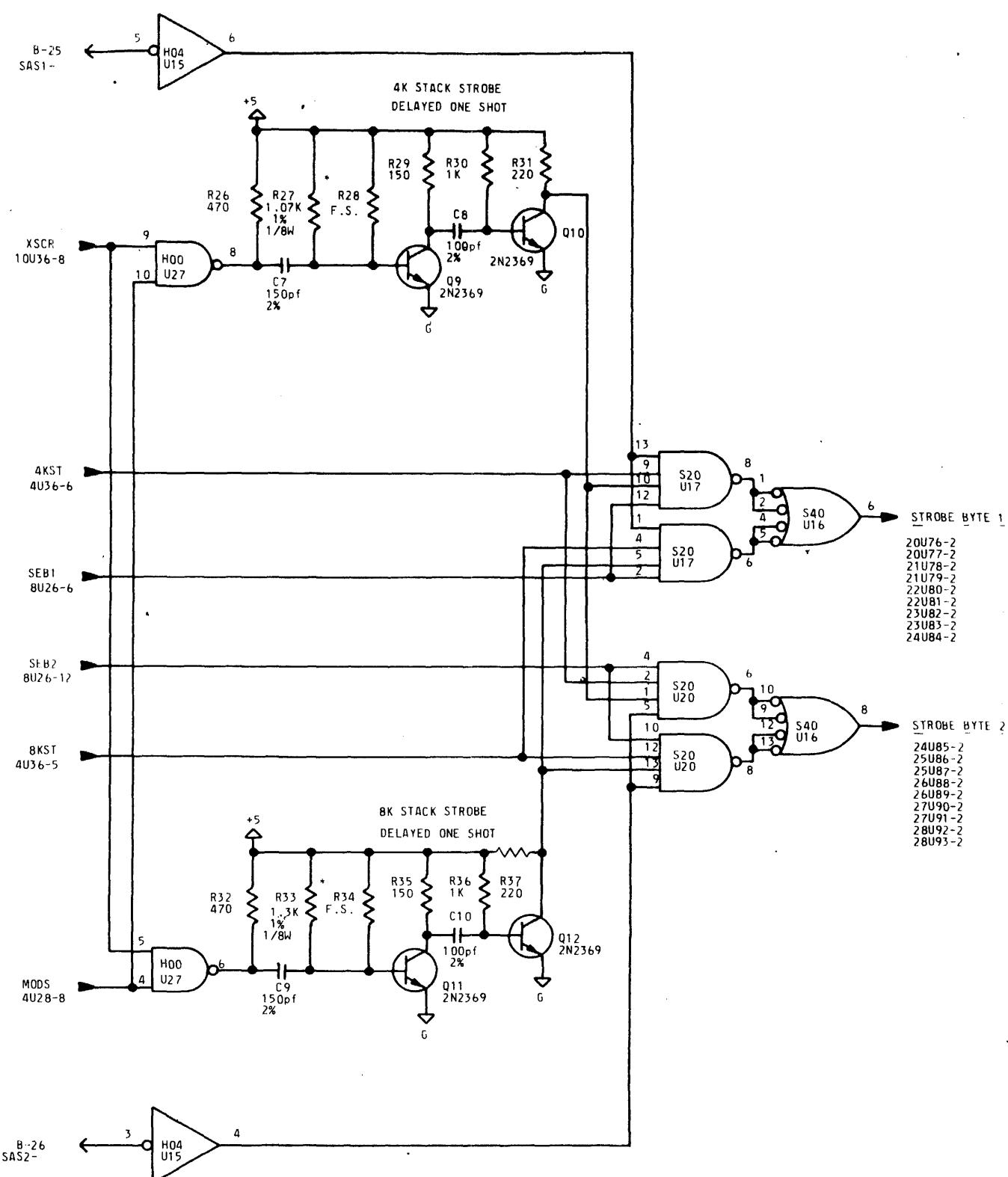




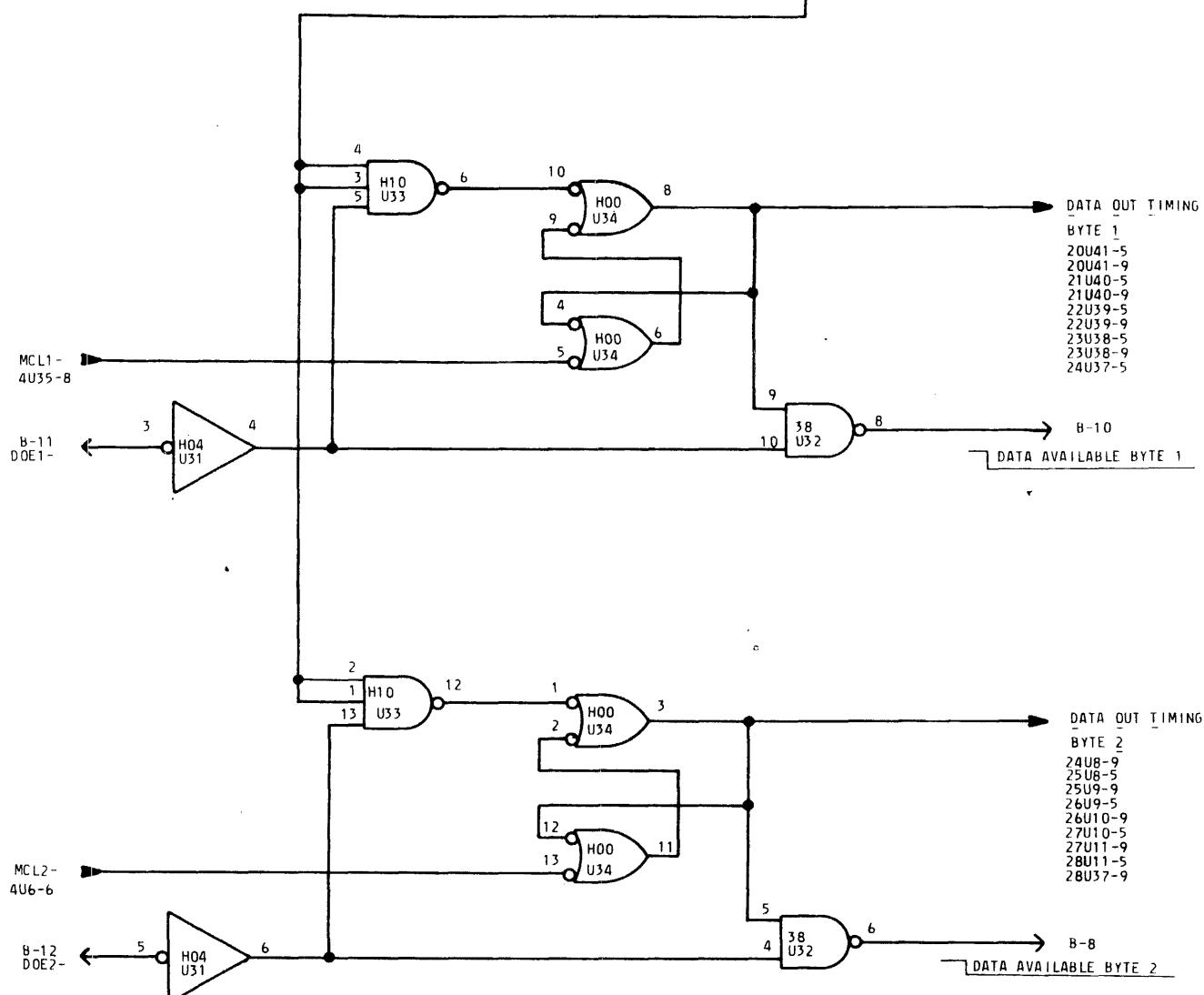
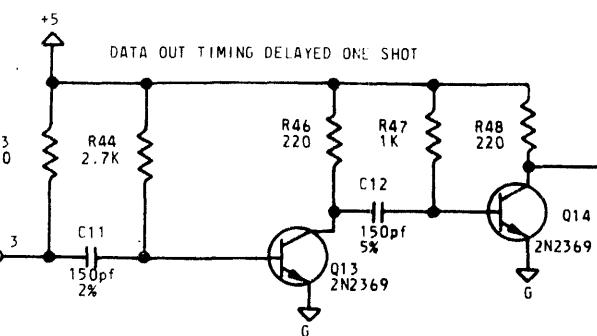


\* F.S. MEANS FACTORY SELECT. THE VALUE OF THIS RESISTOR IS DETERMINED BY THE FACTORY DURING TEST.

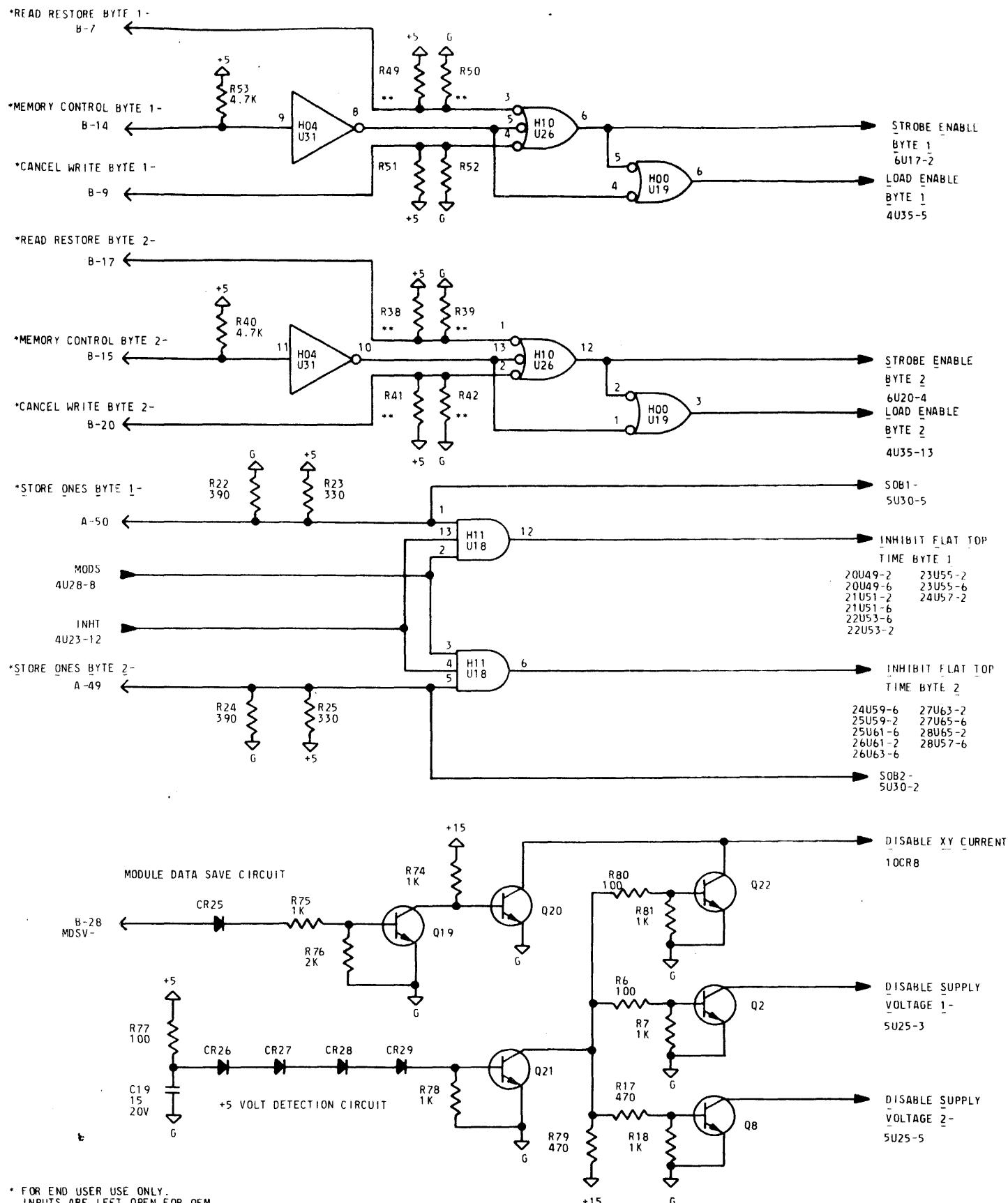
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20R112 26R124  
21R113 27R125  
21R114 27R126  
22R115 28R127  
22R116 28R128  
23R117 25R122  
23R118 24R119  
24R120 25R121



\* F.S. MEANS FACTORY SELECT. THE VALUE OF THIS RESISTOR IS DETERMINED BY THE FACTORY DURING TEST.



|        |                 |   |   |   |   |
|--------|-----------------|---|---|---|---|
| E.C.O. | 100015723 KEY 3 | 2 | 3 | 4 | 5 |
| HIST.  |                 |   |   |   |   |



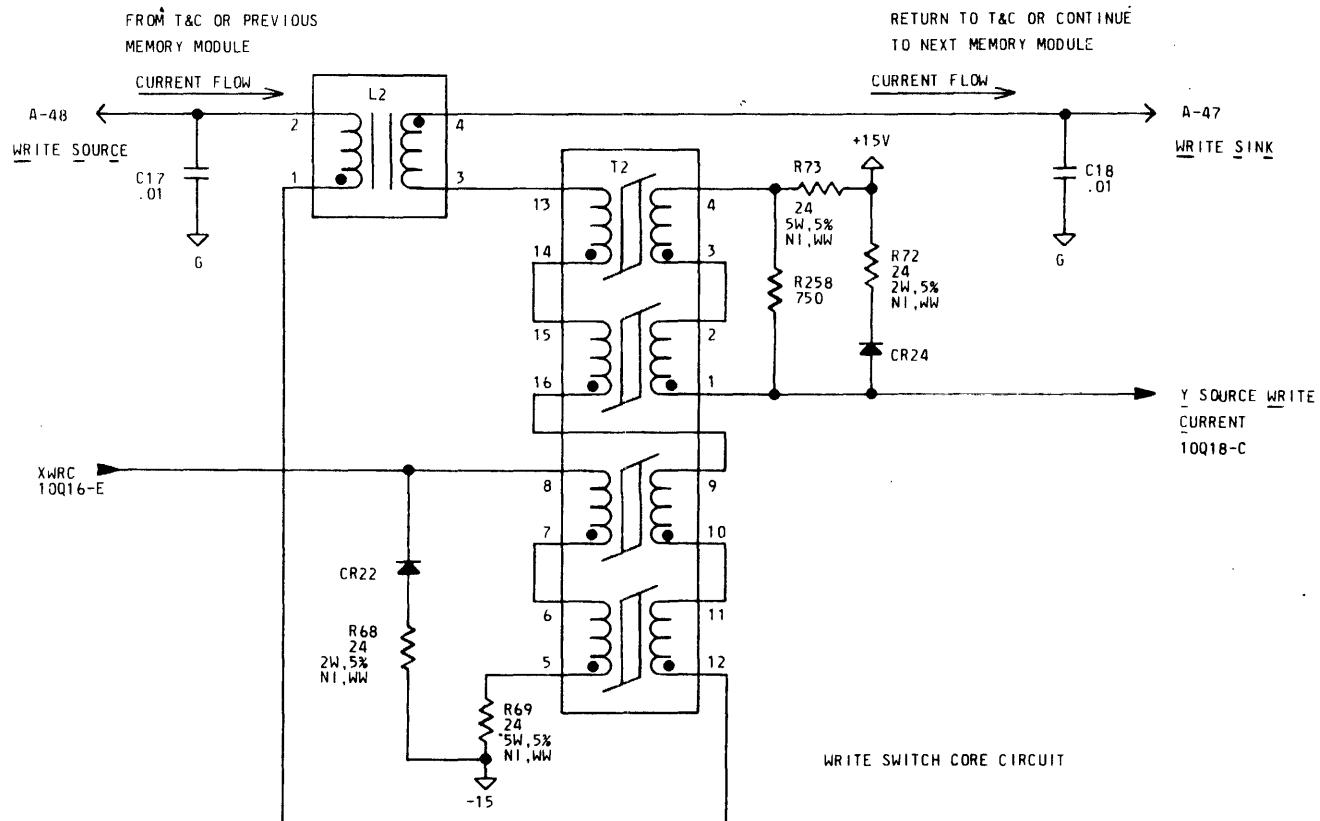
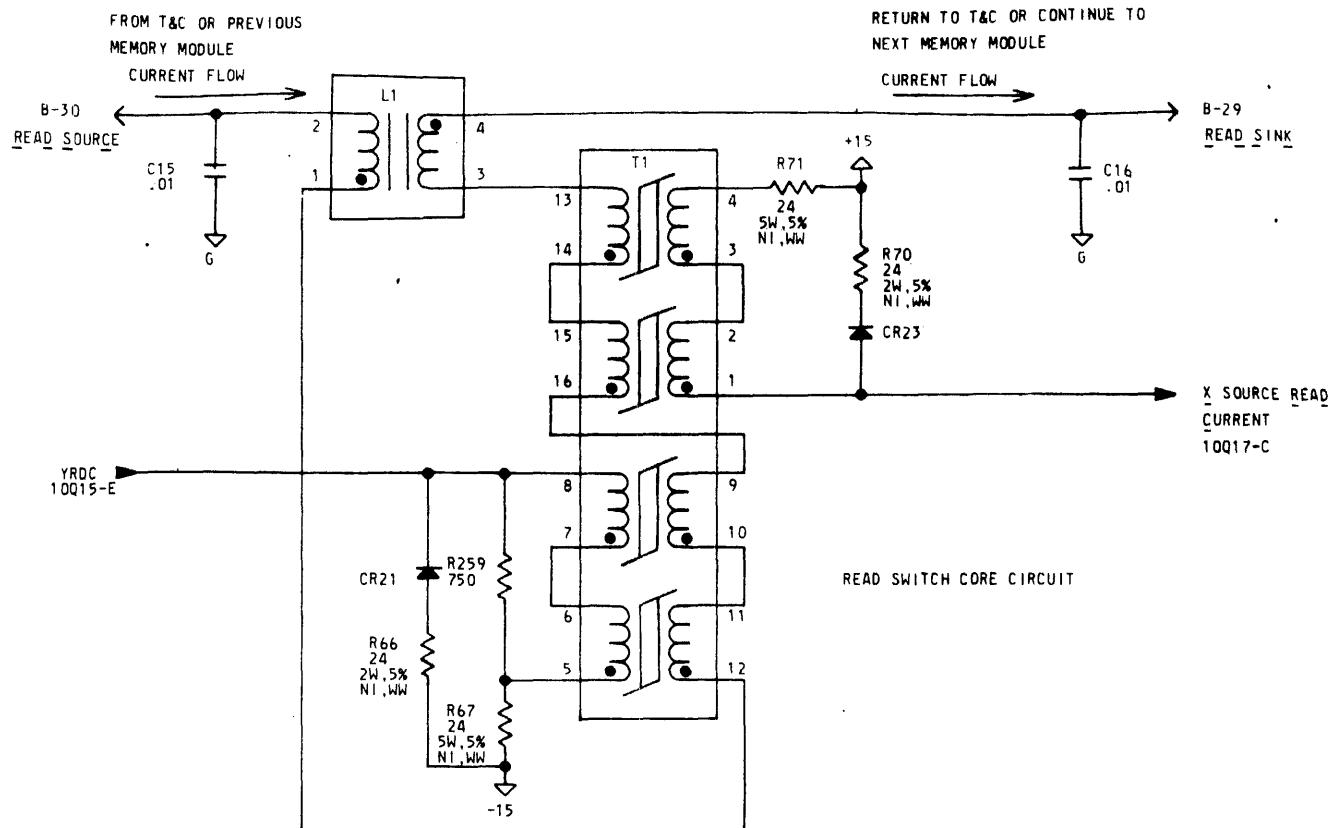
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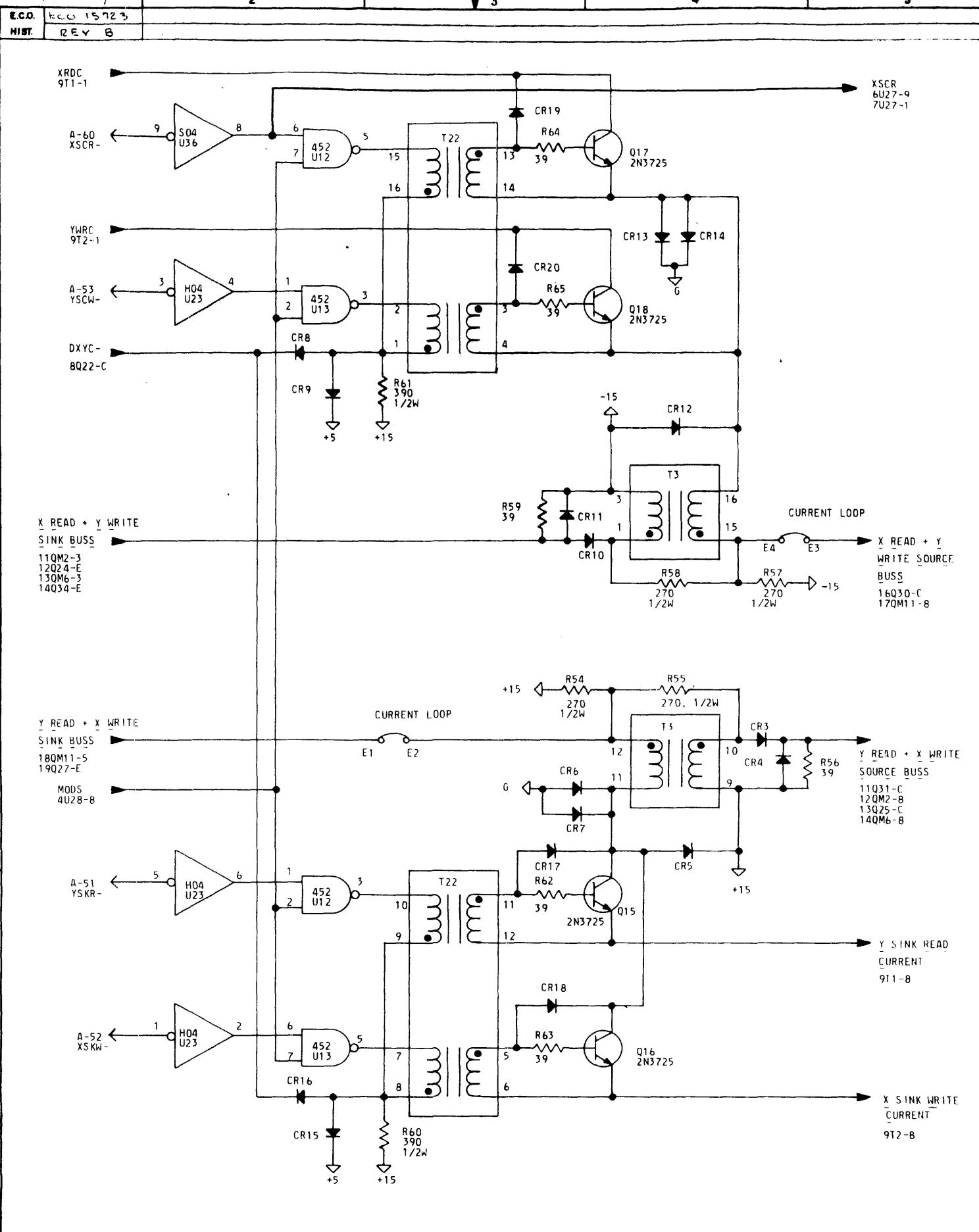
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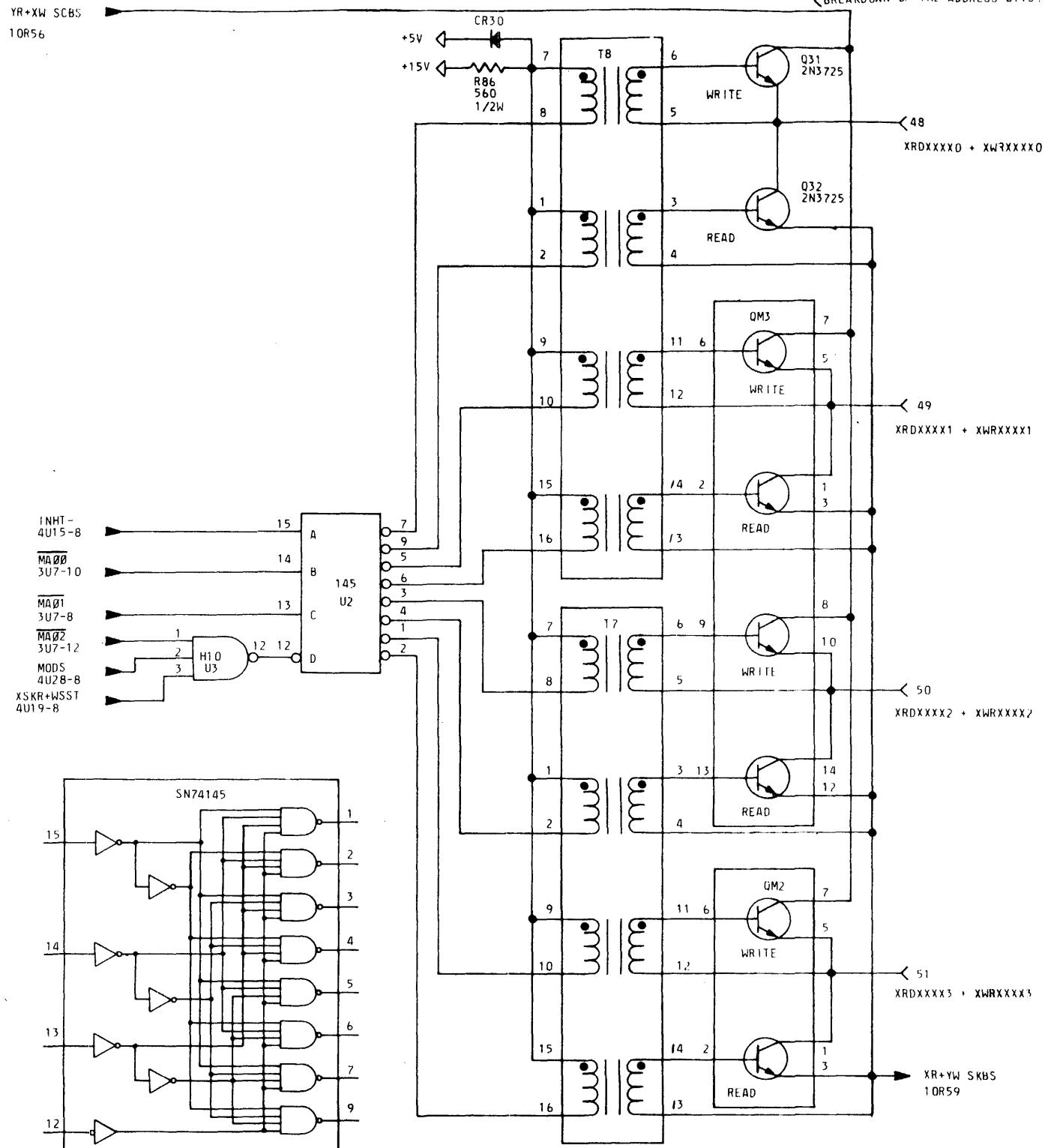
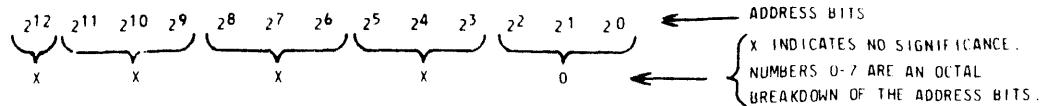
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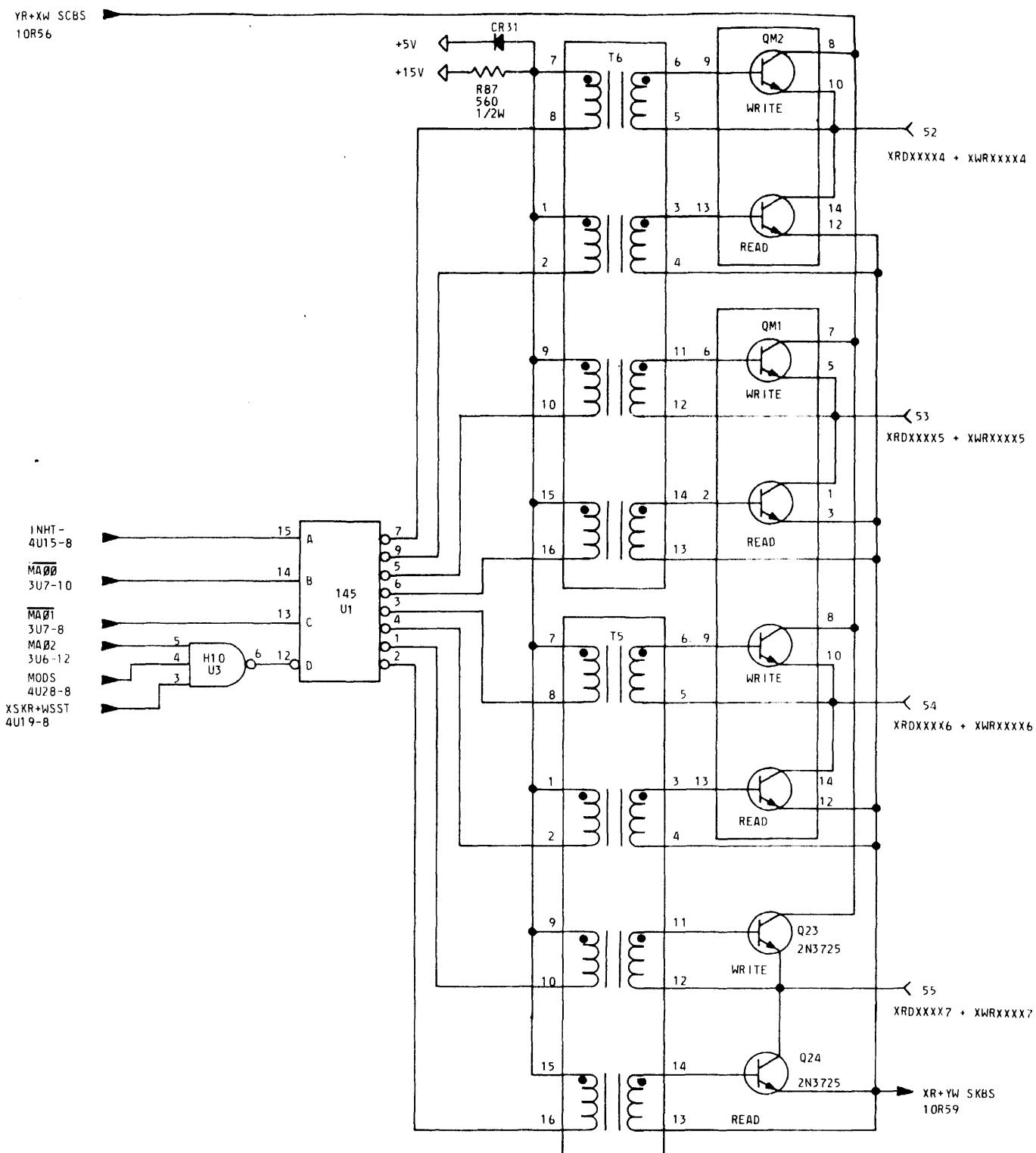


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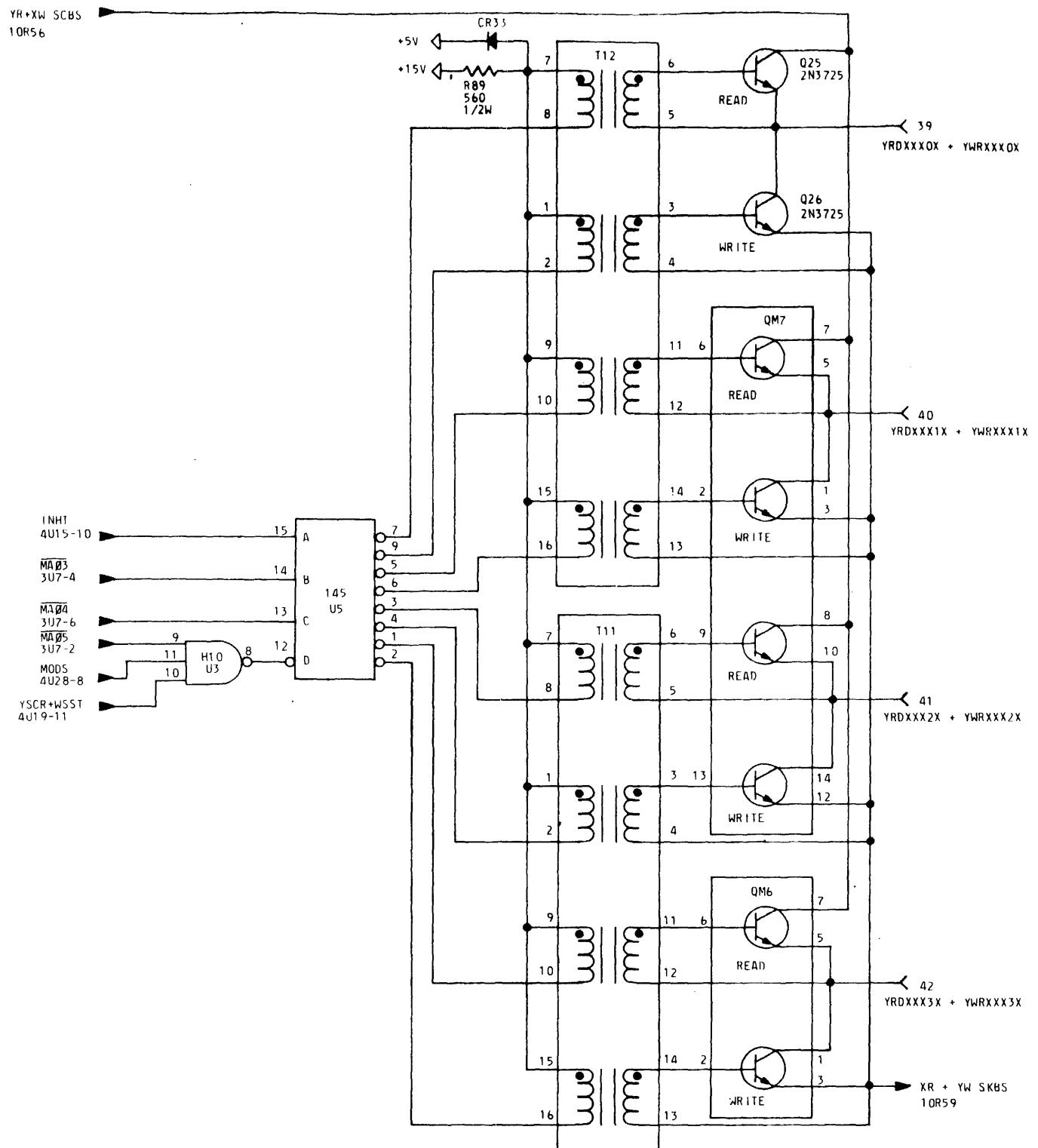
REV 01E



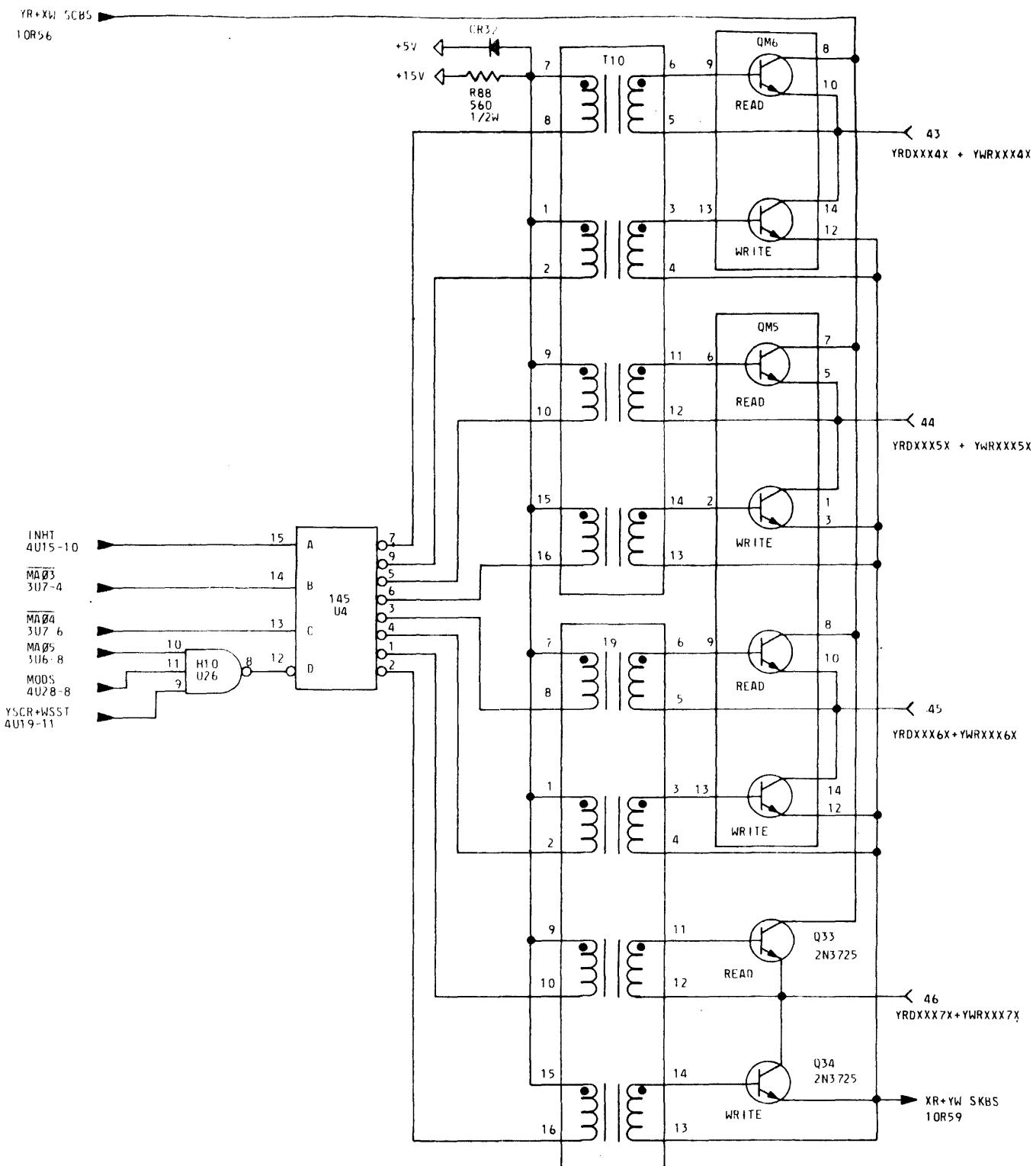
X READ - WRITE SELECTION



X READ - WRITE SELECTION

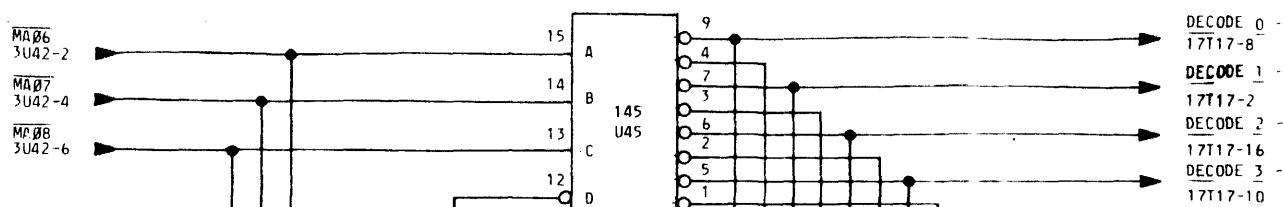


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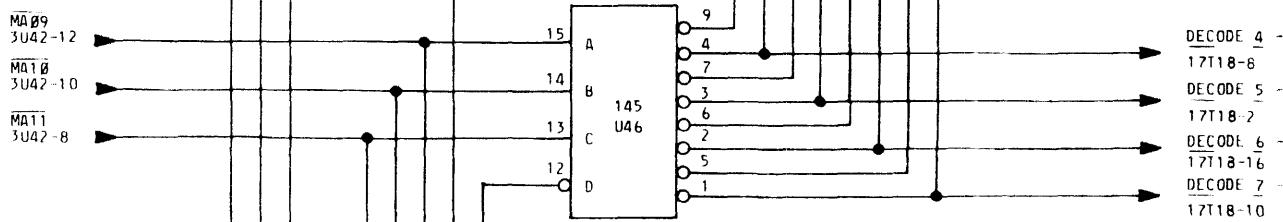


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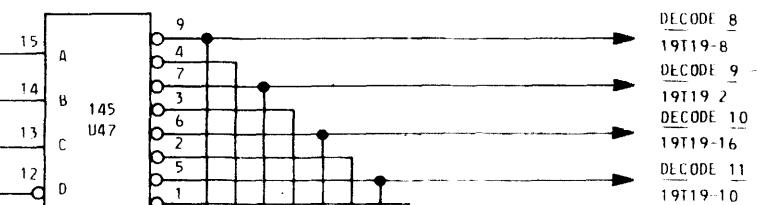
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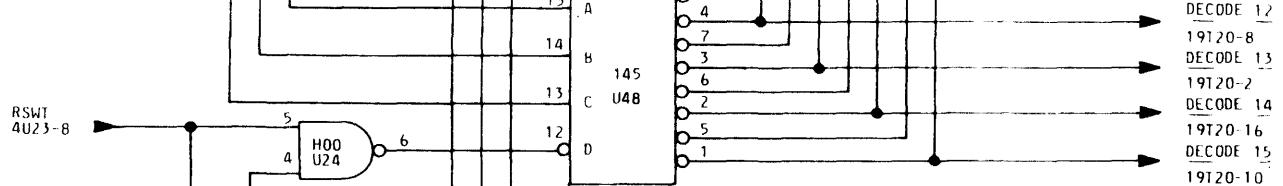
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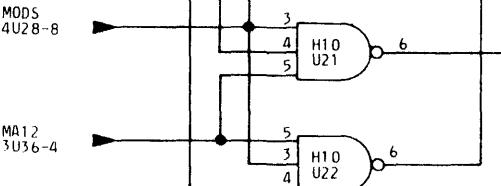
C



D



E



F

XR+YW 50BS  
10T3 15

MA09  
3U42-12

MA10  
3U42-10

MA11  
3U42-8

MA12  
3U42-2

MODS  
4U28-8

RSWT  
4U23-8

15

14

13

12

11

10

A

B

C

D

E

F

## TITLE

SCHEMATIC MEMORY ELECTRONICS ASSEMBLY

DWG. NO.

C

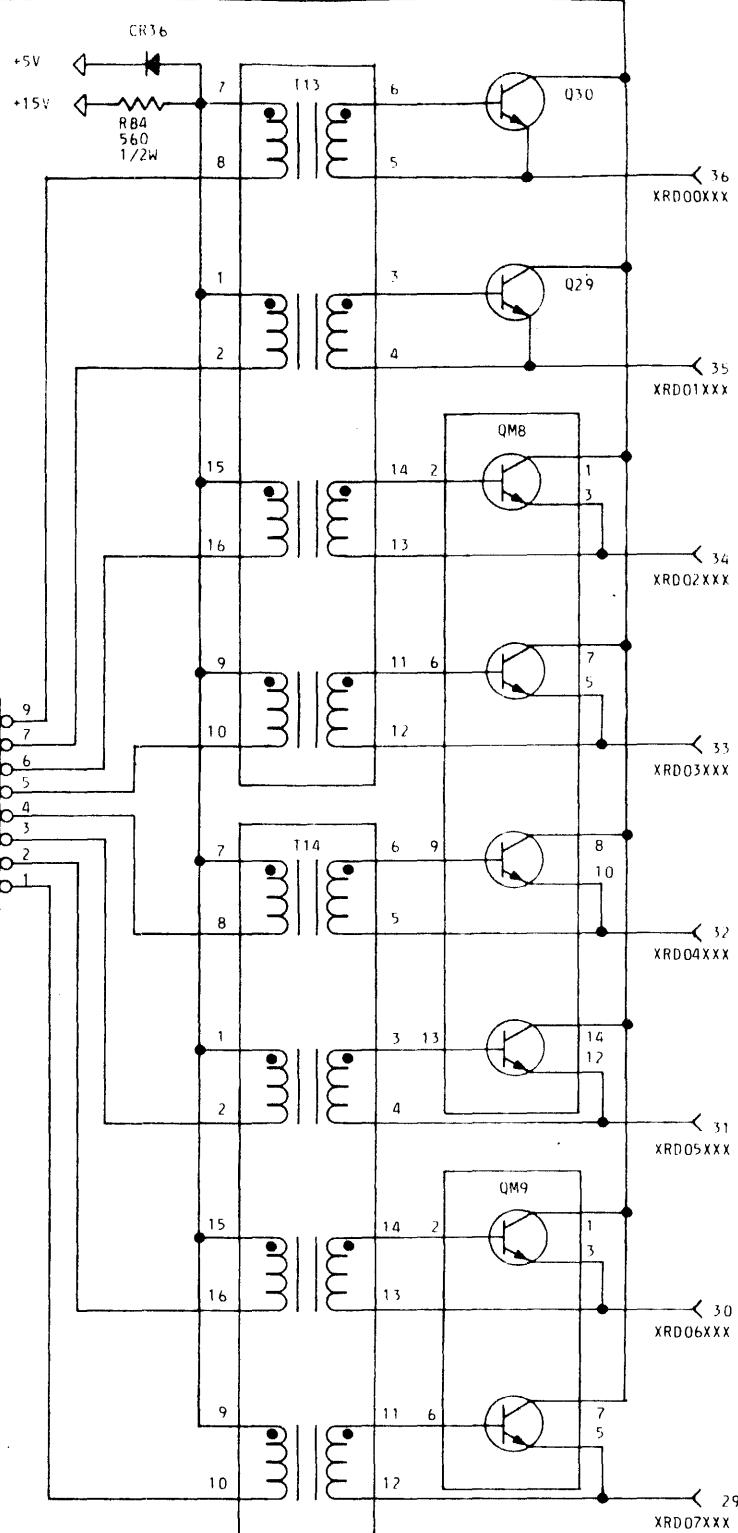
138-001706

MODEL

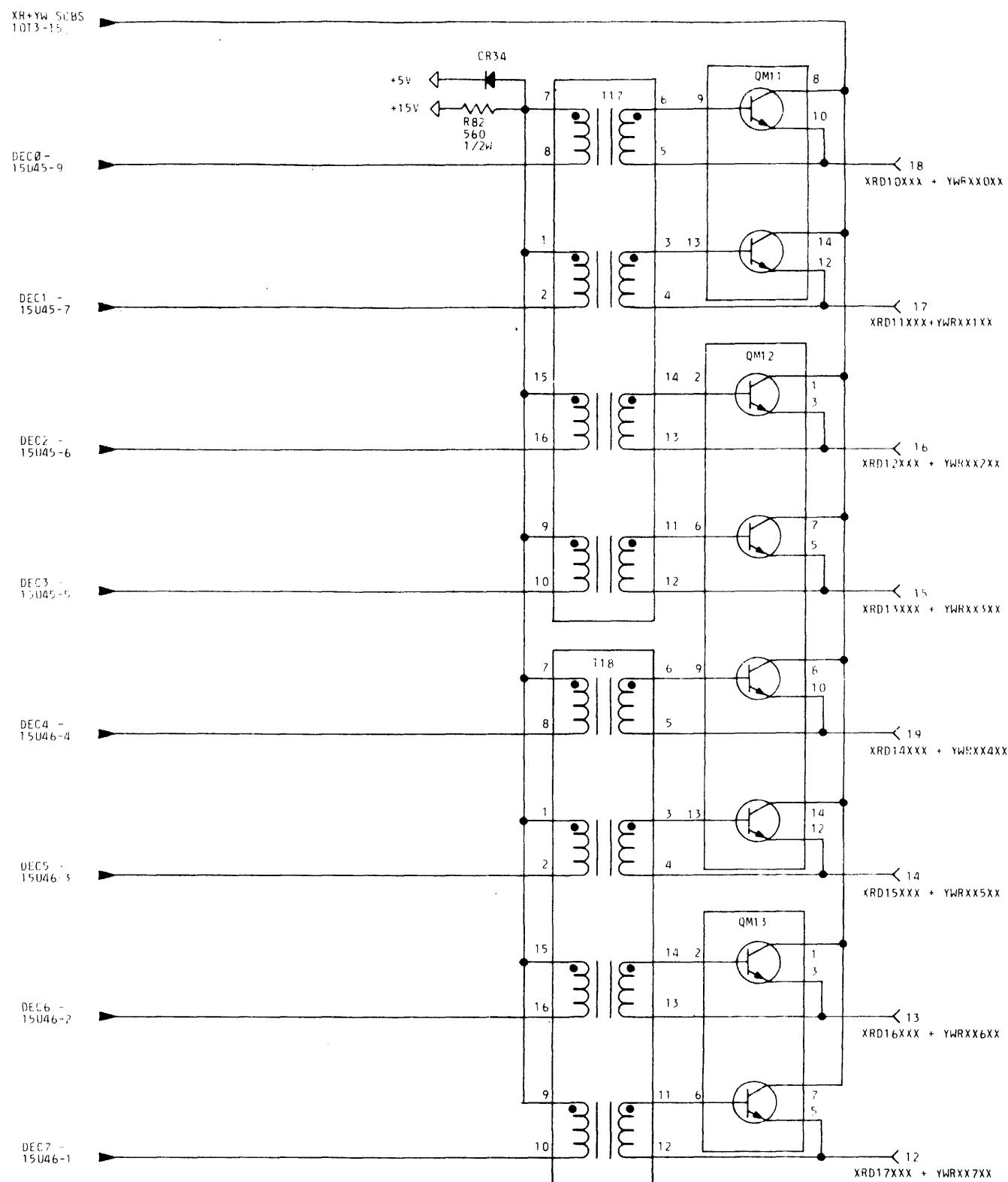
VERS.

PAGE

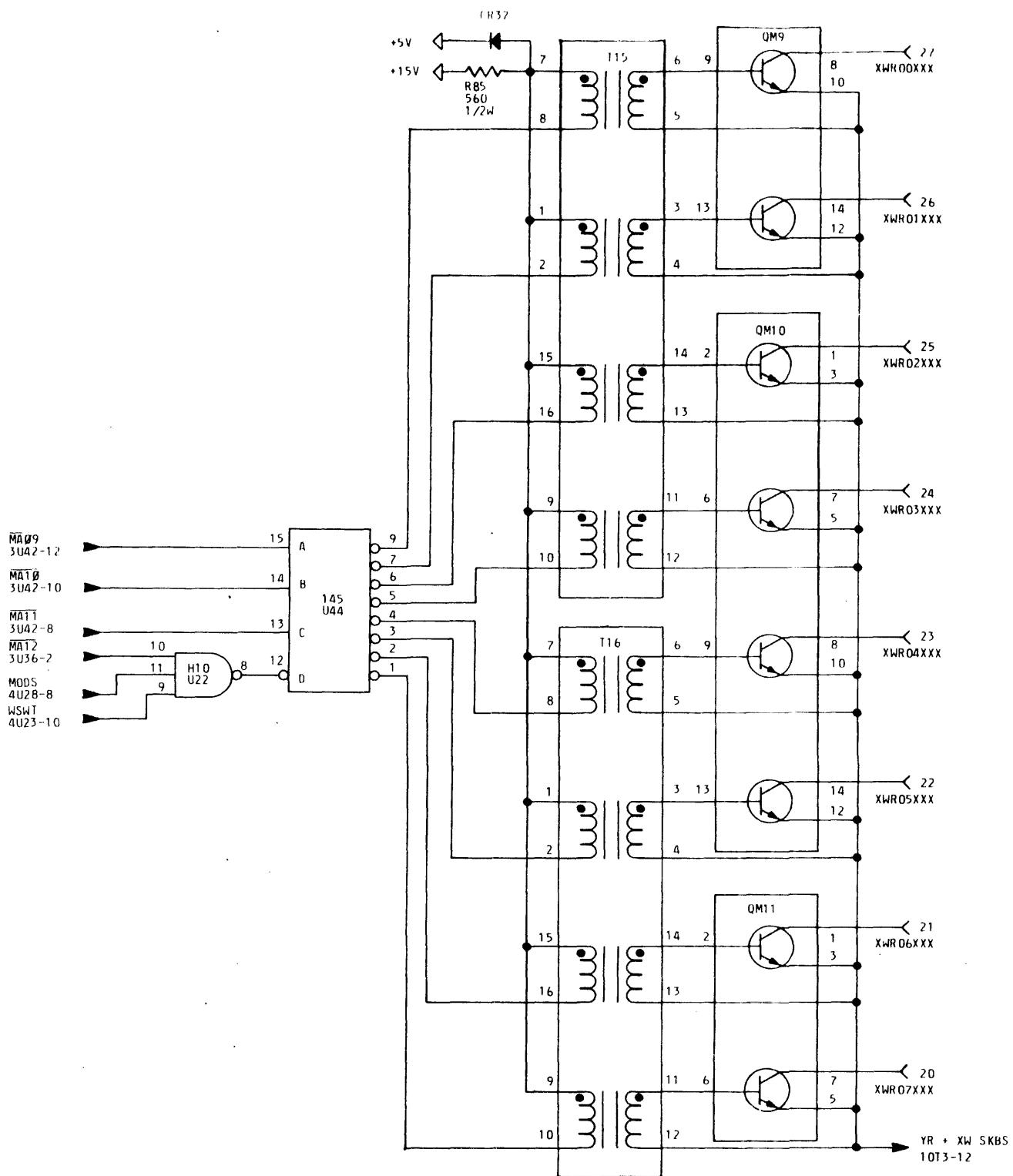
16



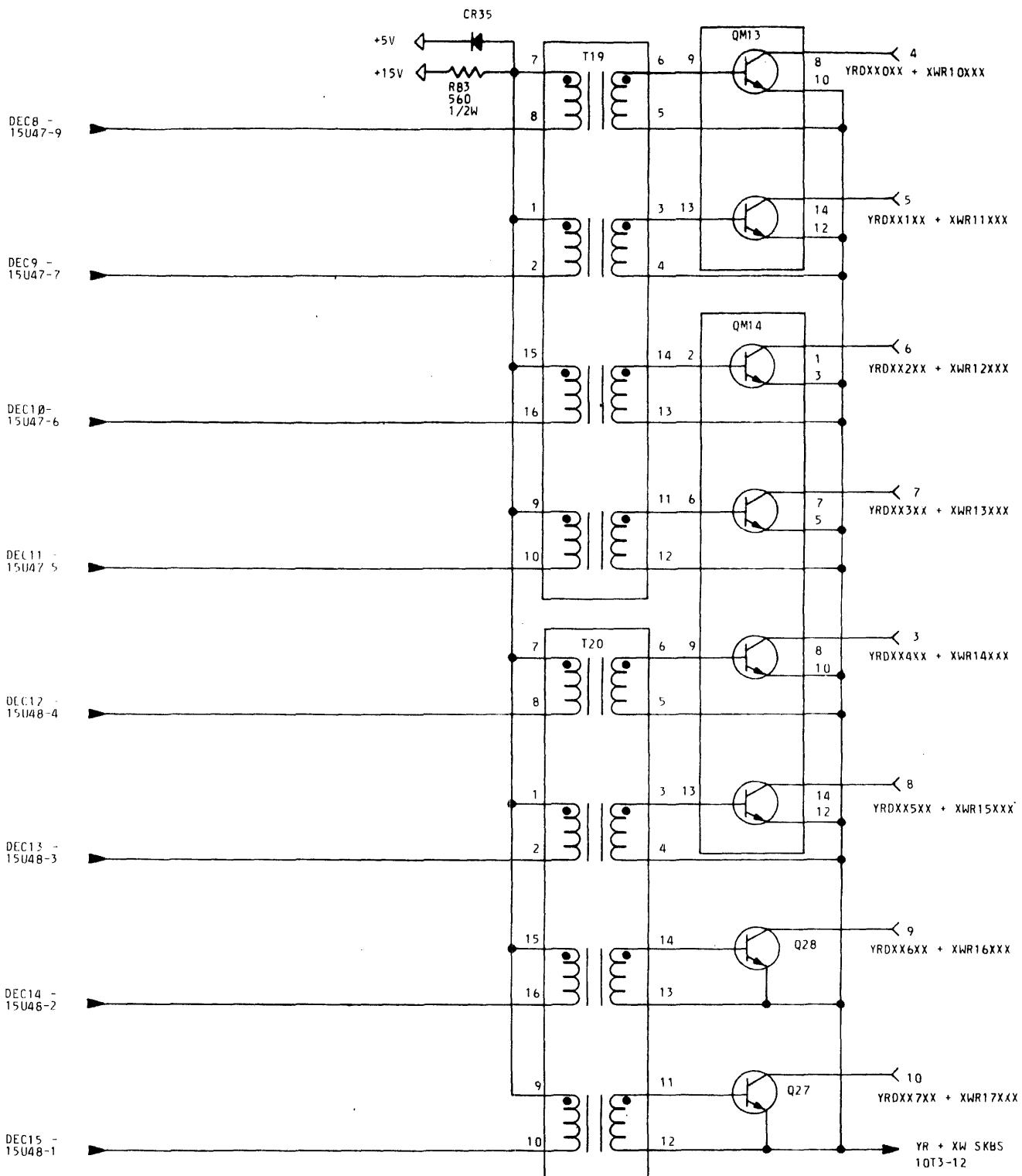
X READ SELECTION



X READ - Y WRITE SELECTION



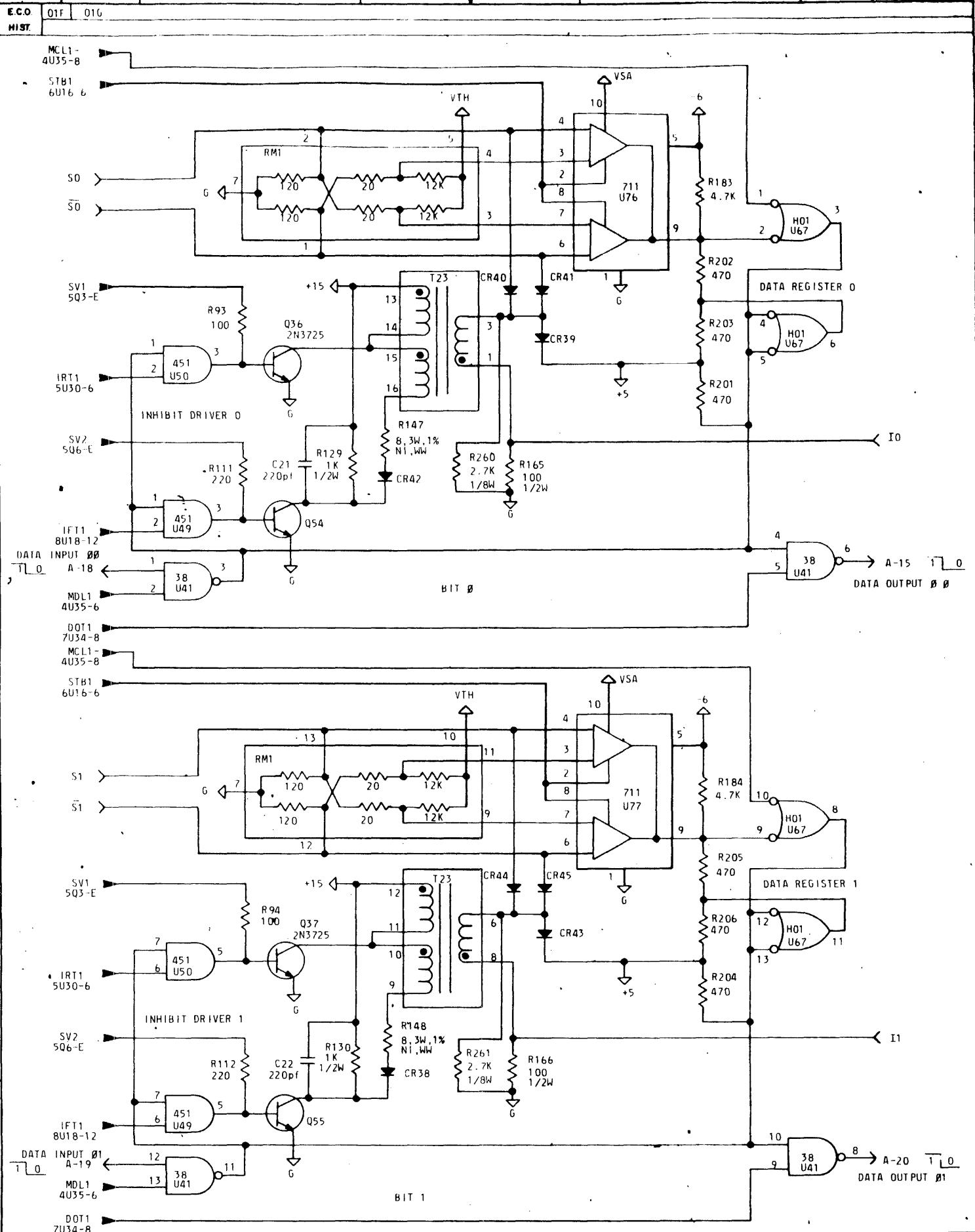
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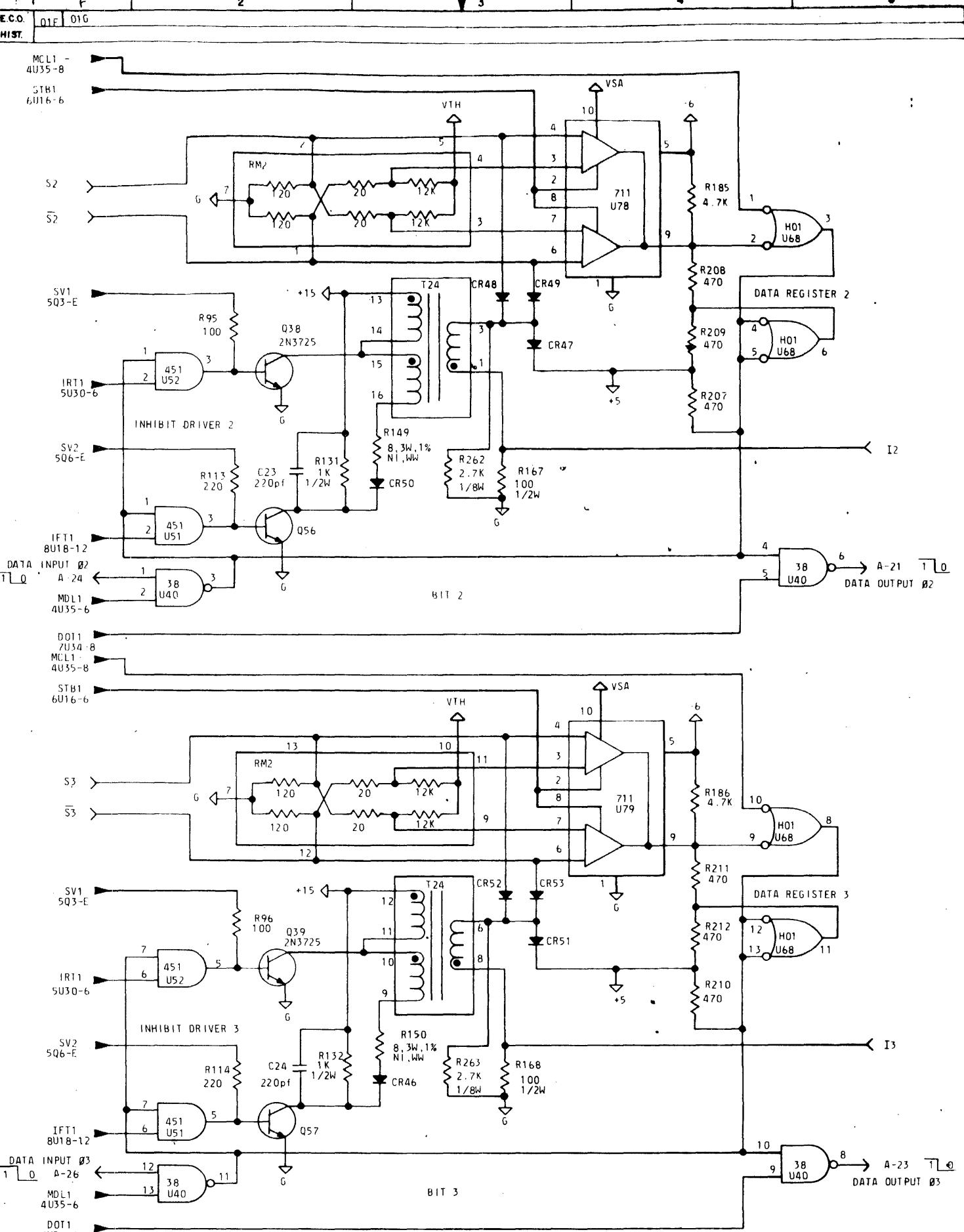


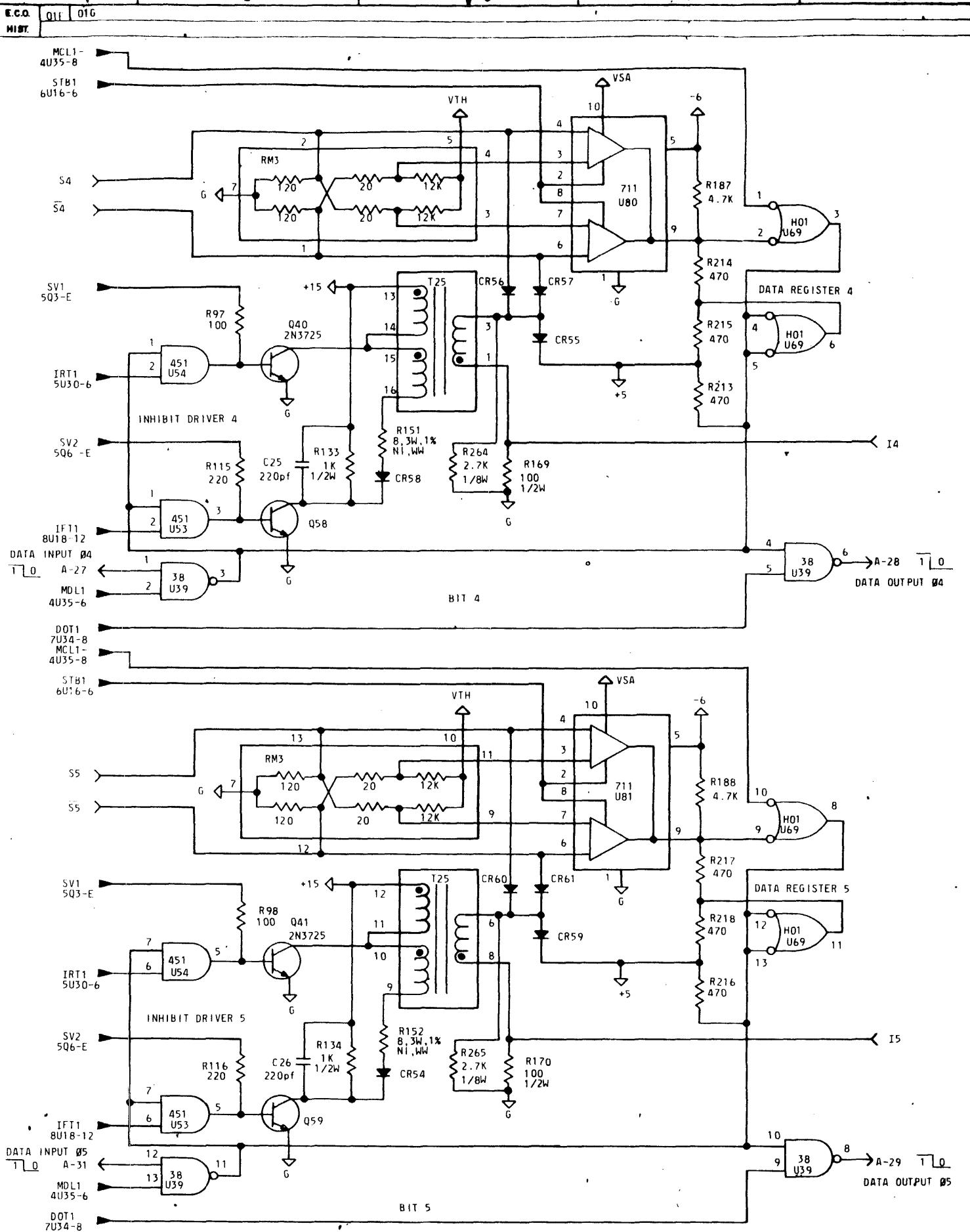
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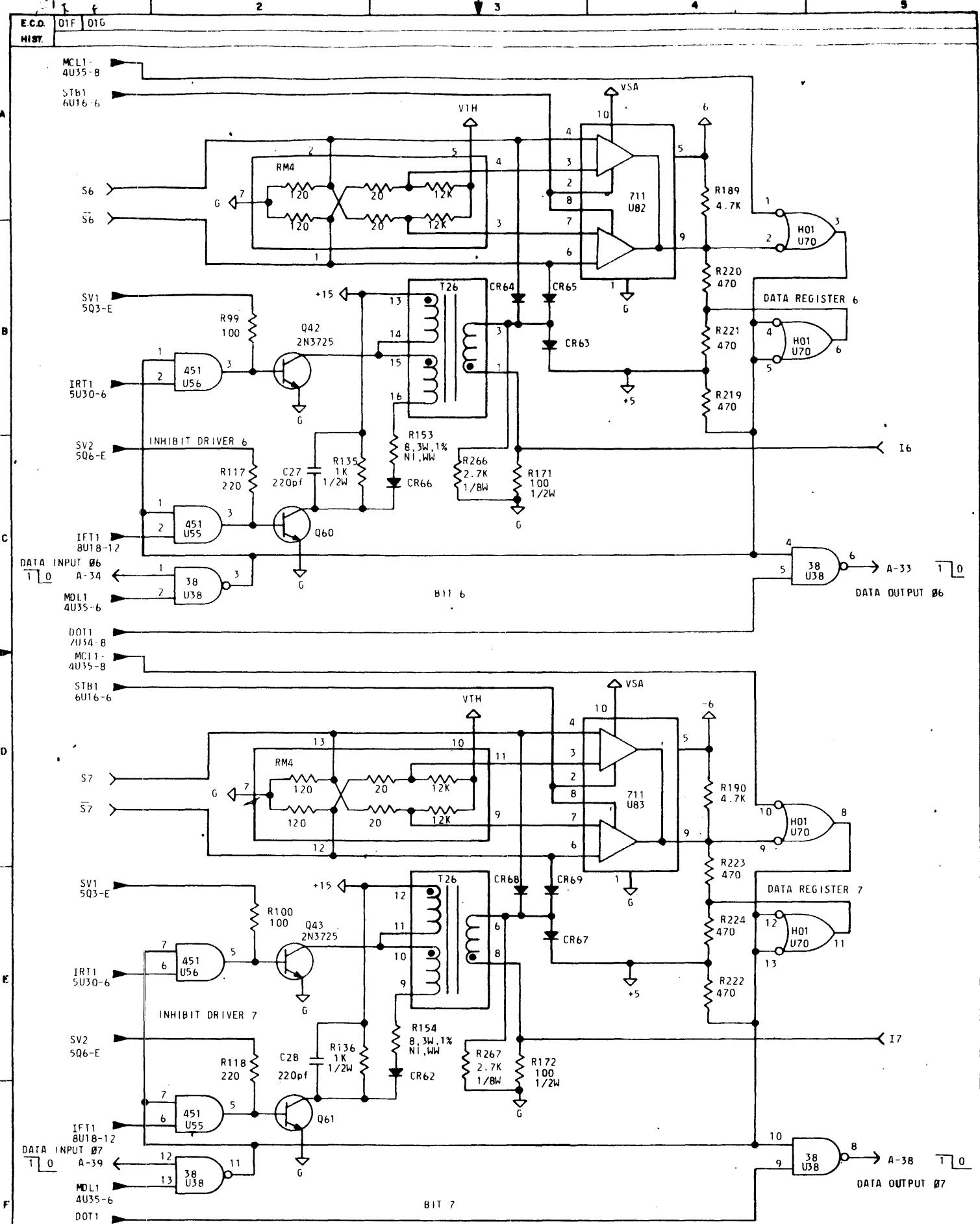

**FABRI-TEK INC.**  
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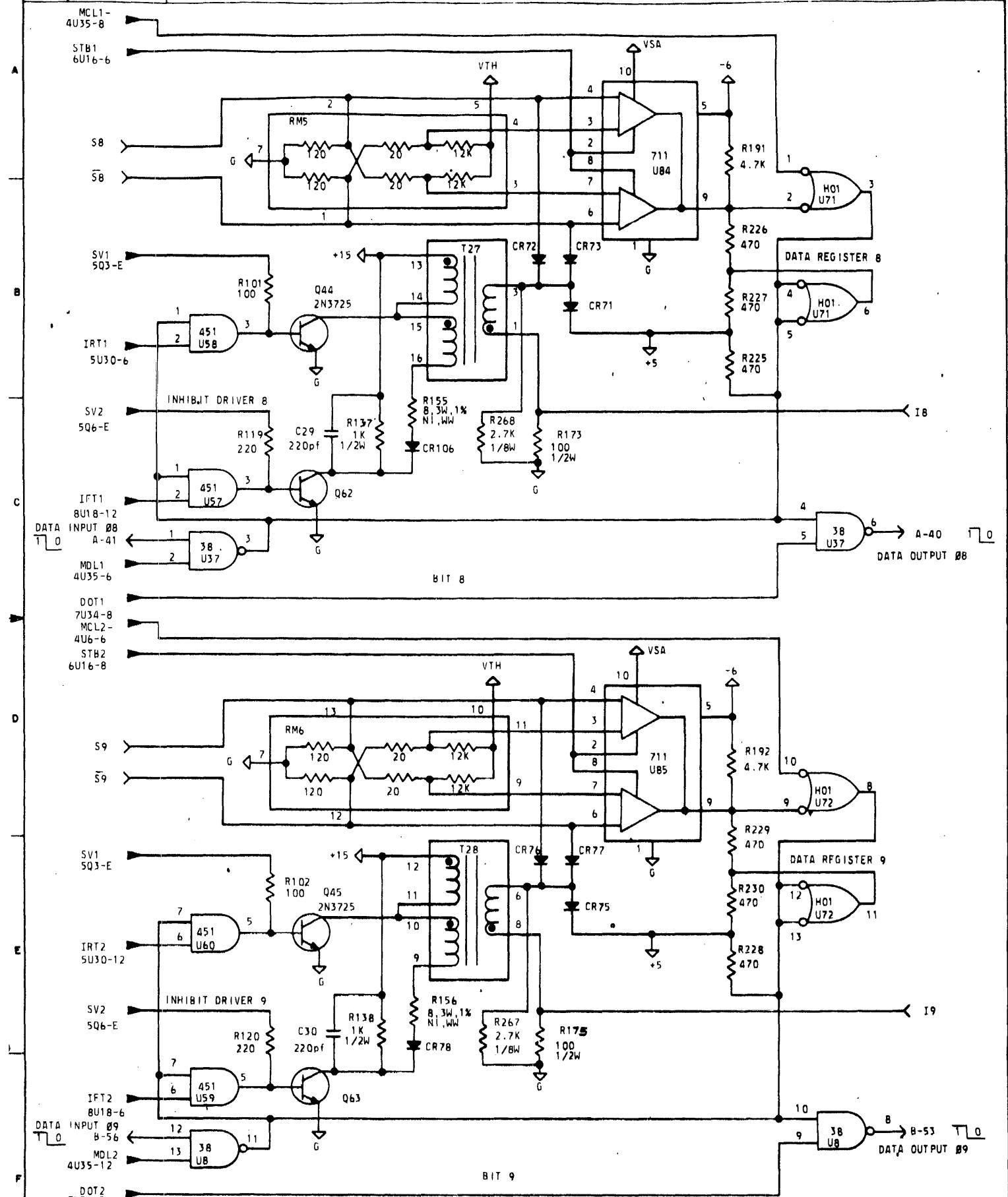
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|-----------|---|------------|-------|------|
| DRAW. NO. | C | MODEL      | VERS. | PAGE |
|           |   |            |       | 19   |





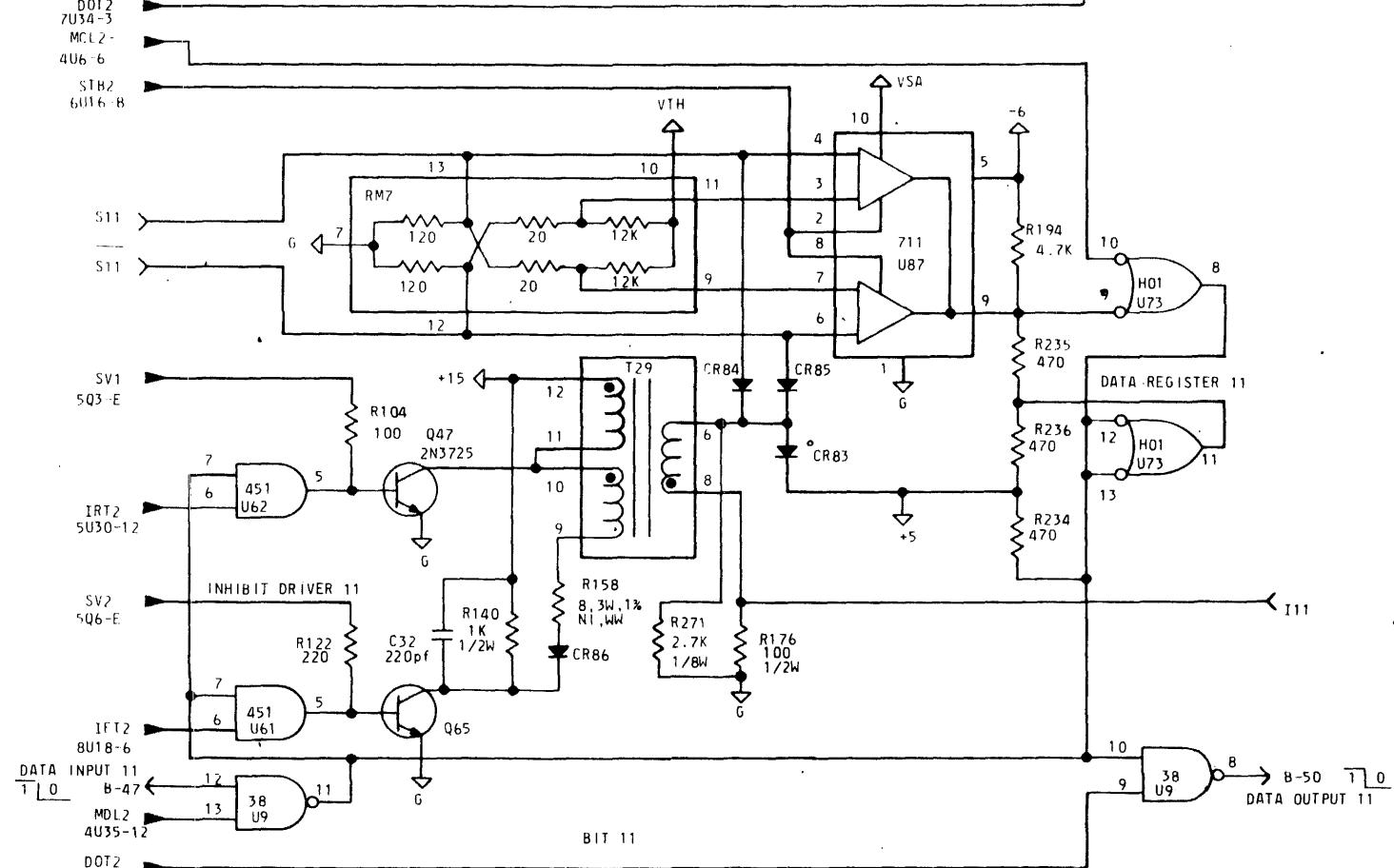
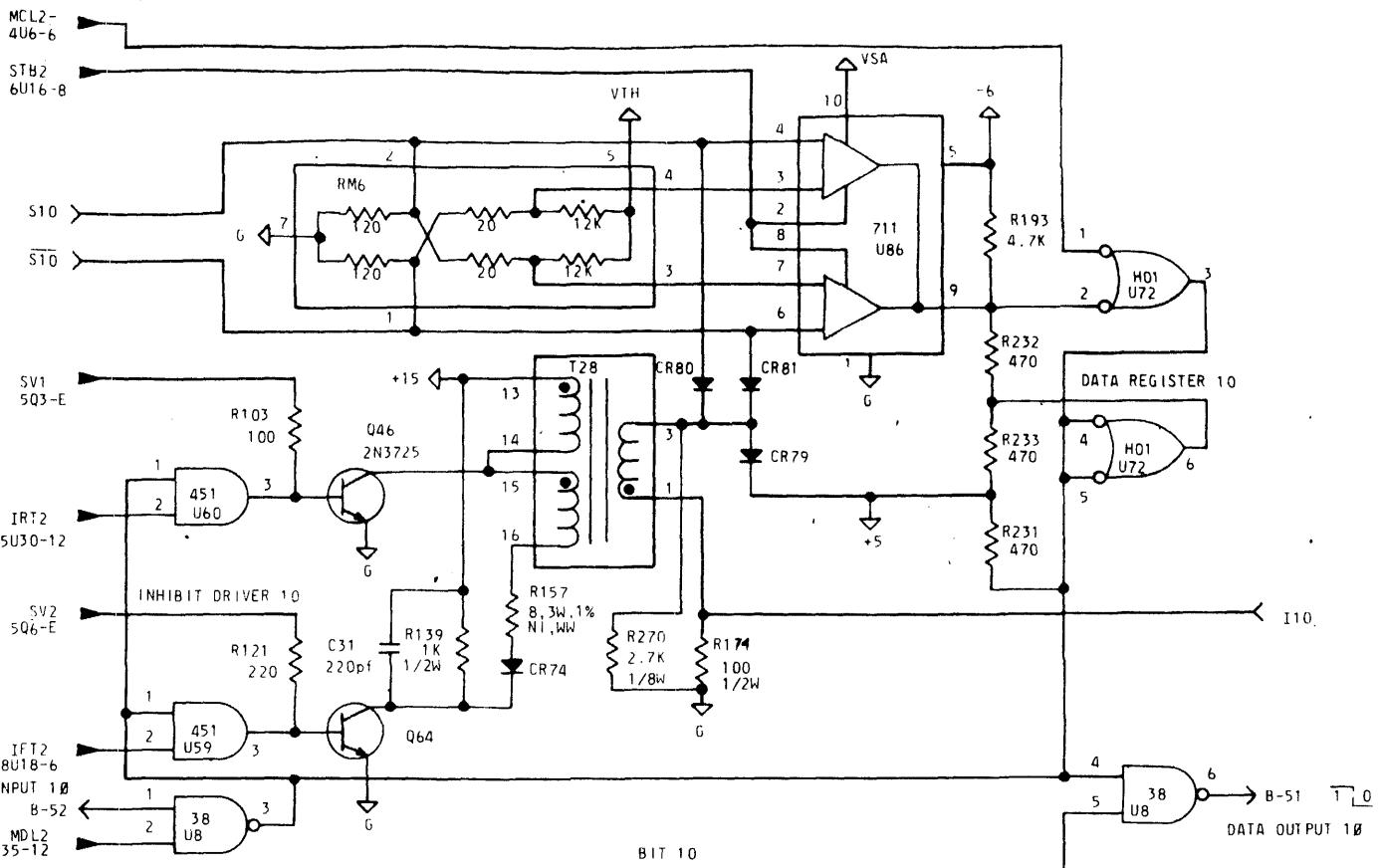


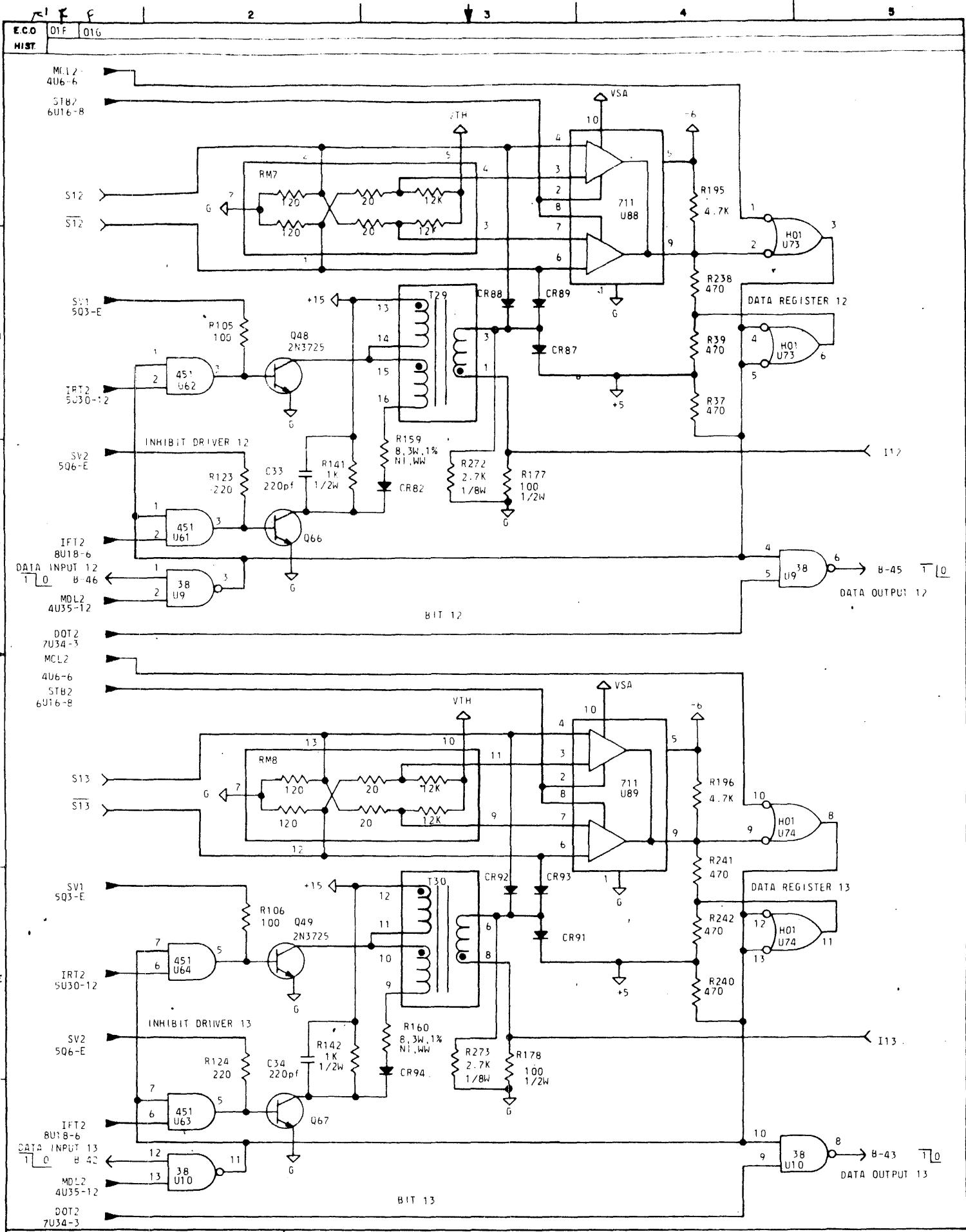


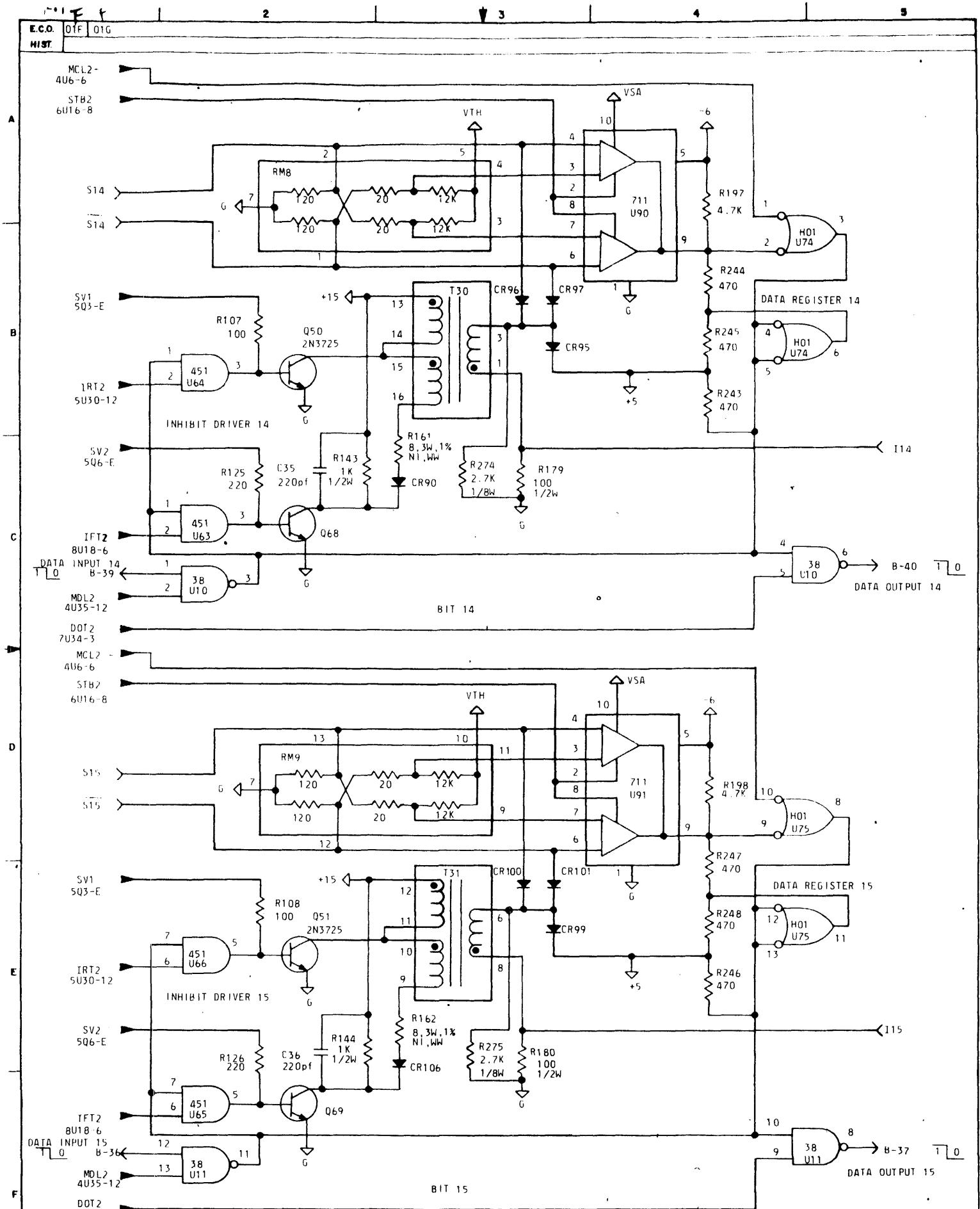


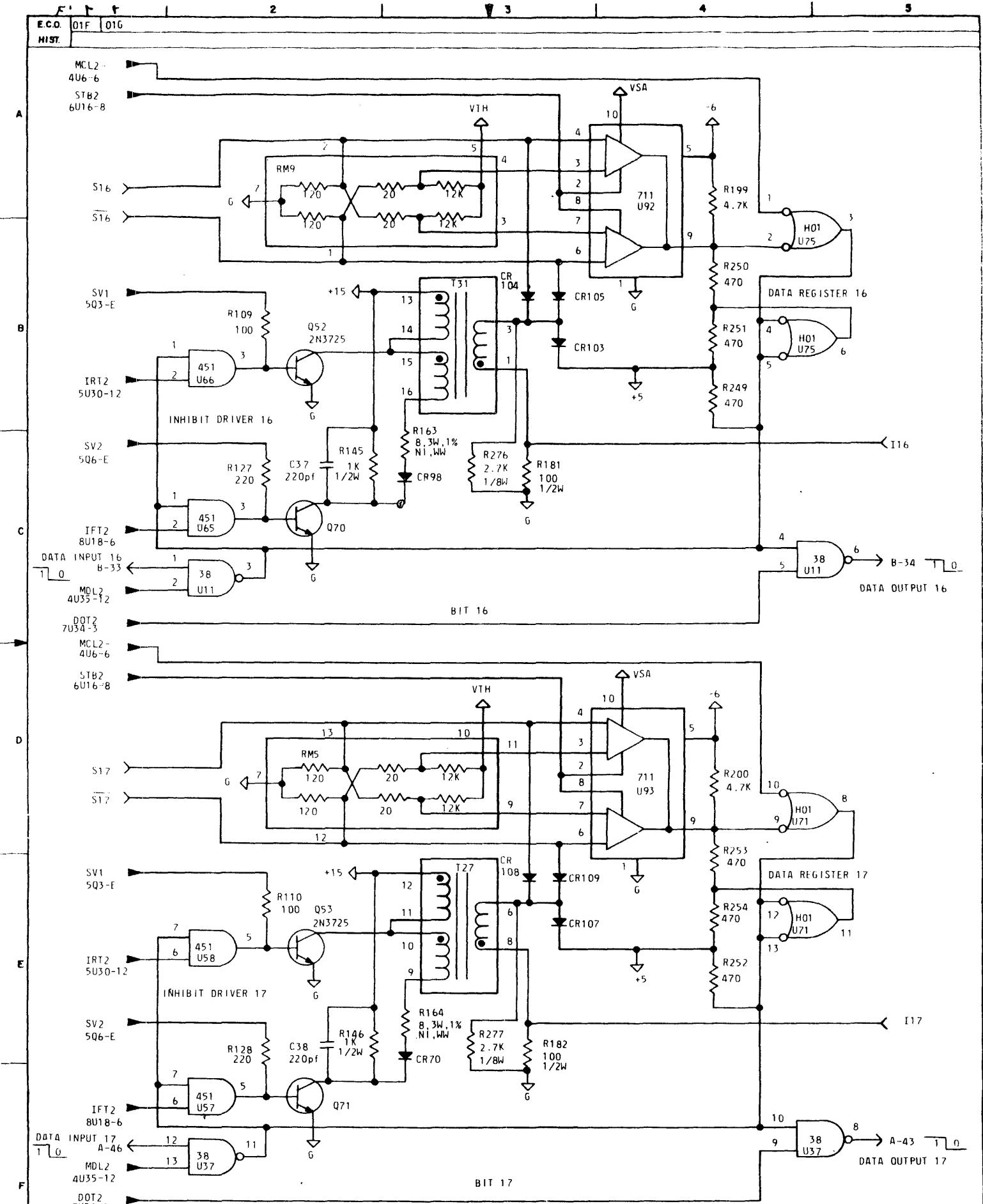
E.G.O. EC17039  
HIST. AREV. OIE

01F 01G









E.C.O. # 15462 REV A # 15473 REV B ECO 15637 REV C E.C. # 15845 REV D EC # 15971 REV E OOF-EC 17569 006-EC 18479  
HIST 304-EC 19532E

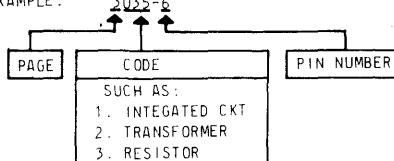
1. UNLESS OTHERWISE SPECIFIED:
    2. ALL RESISTORS 1/4 W, 5% AND IN OHMS.
    3. ALL CAPACITORS IN MICROFARADS.
    4. ALL TRANSISTORS 2N4014.
    5. ALL DIODES 1N4607.
  2. LAST REFERENCE DESIGNATION USED C24,CR11,Q38,  
R138,U93,T3,RY11.

## INTEGRATED CIRCUIT CODE BREAKDOWN.

| CODE | MANUFACTURER'S PART NUMBER | FTI PART NUMBER |
|------|----------------------------|-----------------|
| 38   | SN743BN                    | 134-0195-00     |
| H00  | SN74H00N                   | 134-0185-00     |
| H04  | SN74H04N                   | 134-0173-00     |
| H05  | SN74H05N                   | 134-0191-00     |
| H10  | SN74H10N                   | 134-0167-00     |
| H11  | SN74H11N                   | 134-0168-00     |
| H20  | SN74H20N                   | 134-0169-00     |
| H21  | SN74H21N                   | 134-0170-00     |
| H40  | SN74H40N                   | 134-0171-00     |
| H51  | SN74H51N                   | 134-0220-00     |
| H74  | SN74H74N                   | 134-0188-00     |
| S00  | SN74S00N                   | 134-0207-00     |
| S04  | SN74S04N                   | 134-0209-00     |
| S11  | SN74S11N                   | 134-0213-00     |
| S20  | SN74S20N                   | 134-0206-00     |
| S40  | SN74S40N                   | 134-0205-00     |
| 452  | SN75452N                   | 134-0212-00     |
| 304  | LM304                      | 134-0255-00     |

TRANSFORMER BREAKDOWN BY REFERENCE DESIGNATION

| REFERENCE DESIGNATION | FTI PART NUMBER |
|-----------------------|-----------------|
| T1                    | 151-0007-00     |
| T2 , T3               | 019-0223-00     |



6. → THIS SYMBOL WILL BE FOUND ON THE RIGHT BORDER.  
IT INDICATES DIRECTION OF SIGNAL FLOW. TO THE  
RIGHT OF THE ARROWHEAD WILL BE THE FULL ENGLISH  
NAME AND THE LETTERS UNDERLINED THAT WILL MAKE UP  
THE MNEMONIC. EXAMPLE: LATCH INTERFACE.  
A LIST OF ALL DESTINATIONS WILL BE PRESENT.

ECO #15473 REV B ECO 15637 REV C

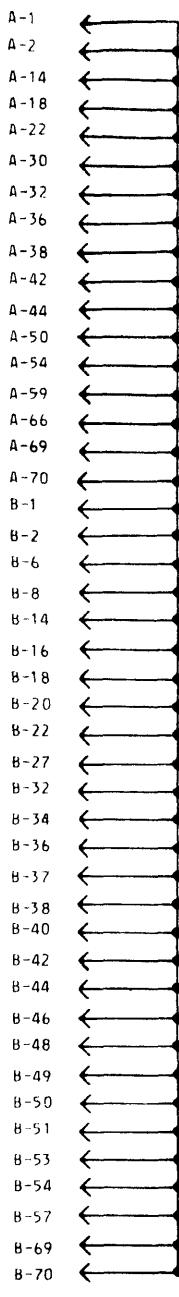
2 F

3

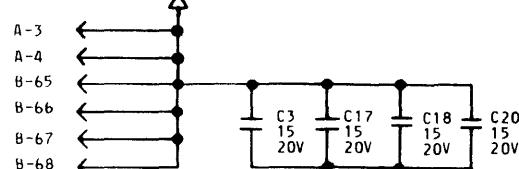
4

5

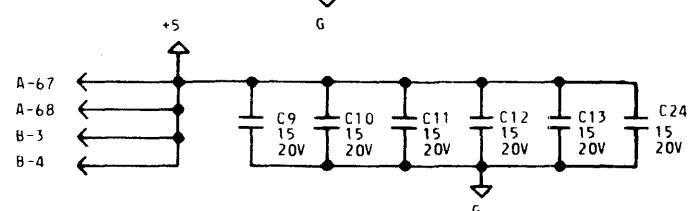
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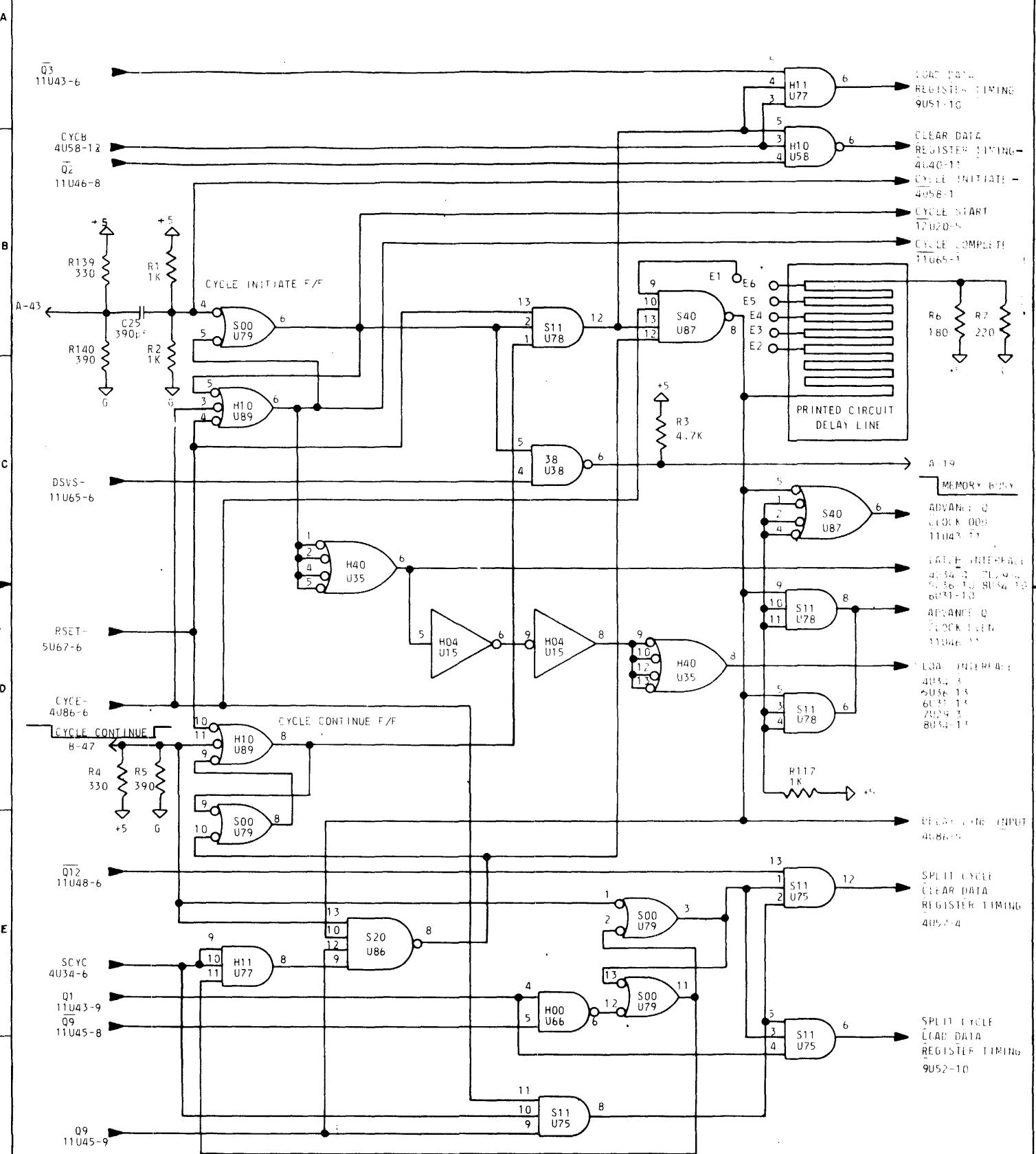
B



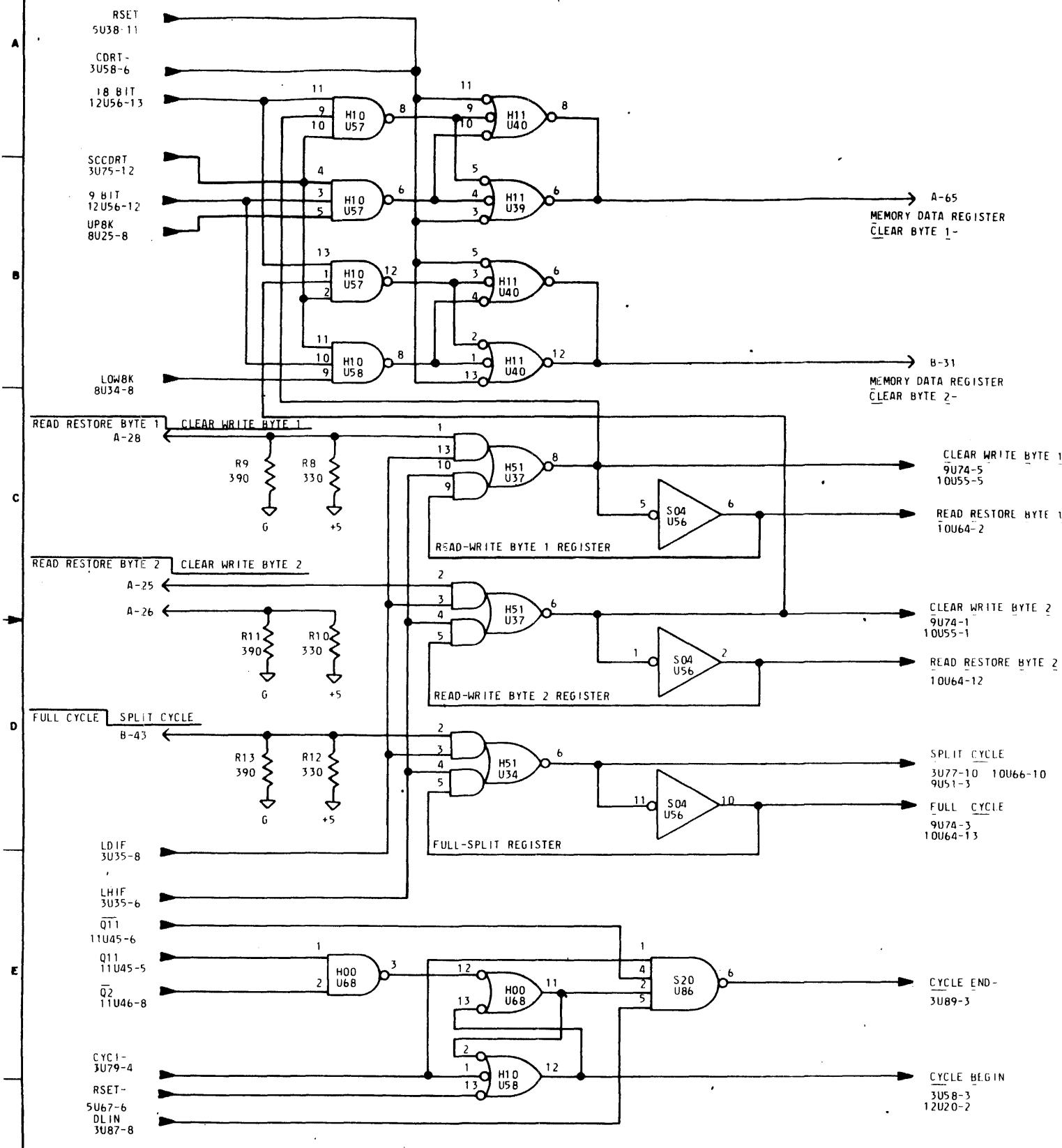
C

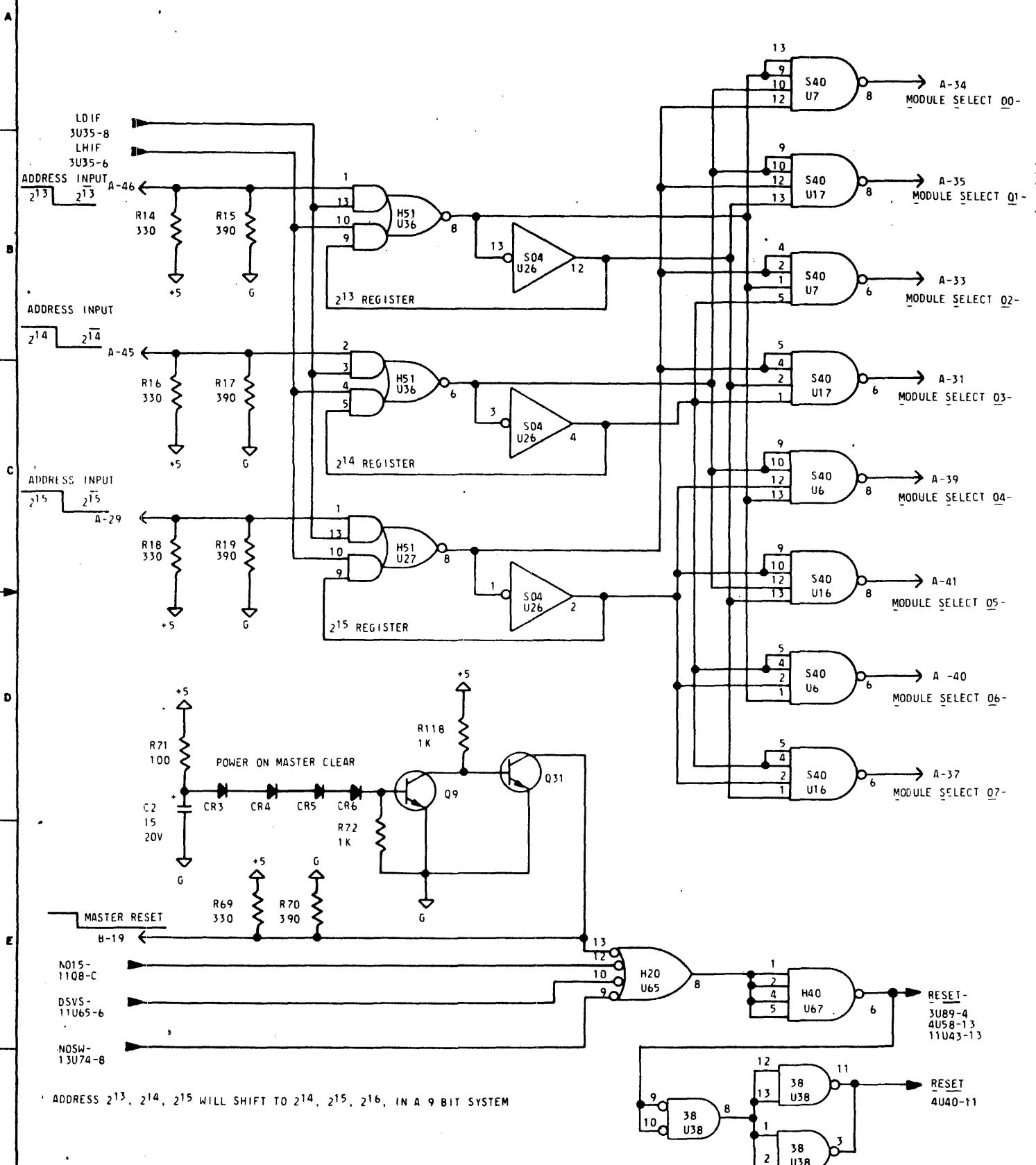


F



F THE PRINTED CIRCUIT DELAY LINE IS ADJUSTED BY PLACING A JUMPER WIRE BETWEEN E1 AND ONE OF THE FOLLOWING: E2, E3, E4, E5, E6.





ADDRESS INPUT

$\overline{20}$   $\overline{20}$

B-10 ← R36 330 R37 390 +5 G → 1 13 H51 U33 10 9 → 8 → 9 10 12 13 H40 U3 8 → B-61 MEMORY ADDRESS 00

20 REGISTER

ADDRESS INPUT

$\overline{21}$   $\overline{21}$

B-9 ← R38 330 R39 390 +5 G → 2 3 H51 U33 4 5 → 6 → 1 2 4 5 H40 U3 6 → B-60 MEMORY ADDRESS 01

21 REGISTER

ADDRESS INPUT

$\overline{22}$   $\overline{22}$

B-17 ← R40 330 R41 390 +5 G → 1 13 H51 U32 10 9 → 8 → 9 10 12 13 H40 U2 8 → B-62 MEMORY ADDRESS 02

22 REGISTER

ADDRESS INPUT

$\overline{23}$   $\overline{23}$

B-15 ← R42 330 R43 390 +5 G → 2 3 H51 U32 4 5 → 6 → 1 2 4 5 H40 U2 6 → B-58 MEMORY ADDRESS 03

23 REGISTER

ADDRESS INPUT

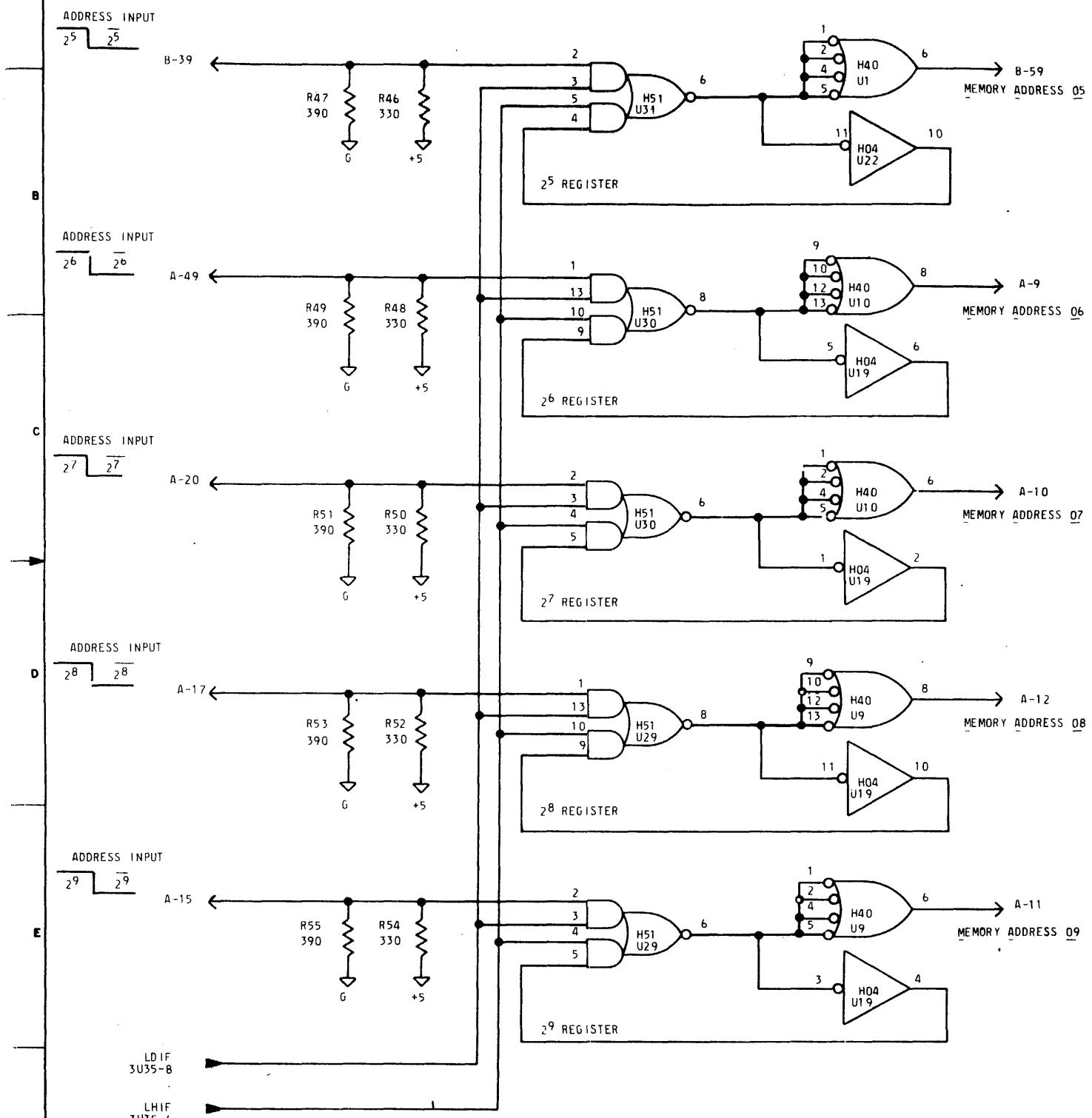
$\overline{24}$   $\overline{24}$

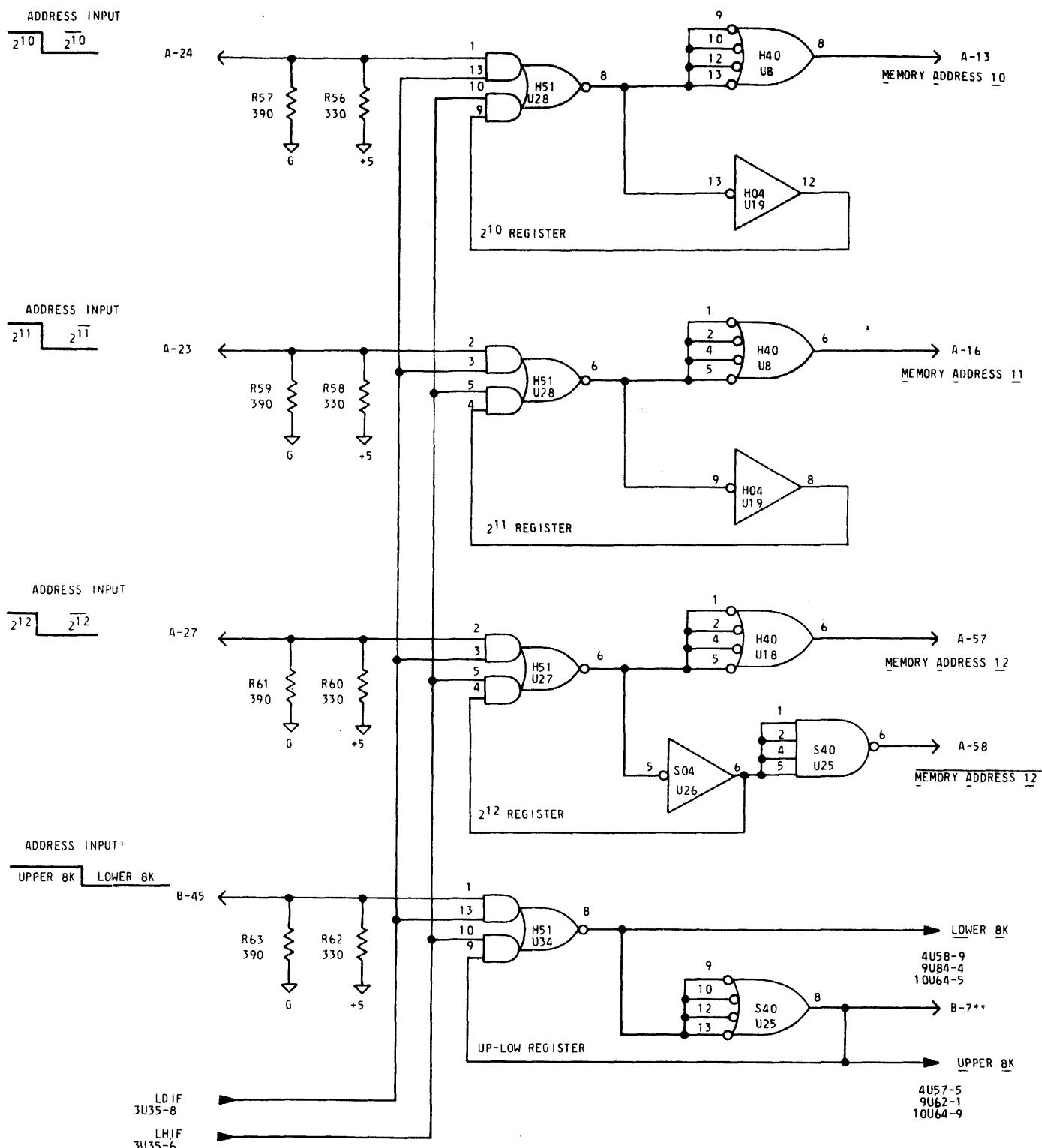
B-41 ← R44 330 R45 390 +5 G → 1 13 H51 U31 10 9 → 8 → 9 10 12 13 H40 U1 8 → B-55 MEMORY ADDRESS 04

24 REGISTER

LDIF  
3U35-8

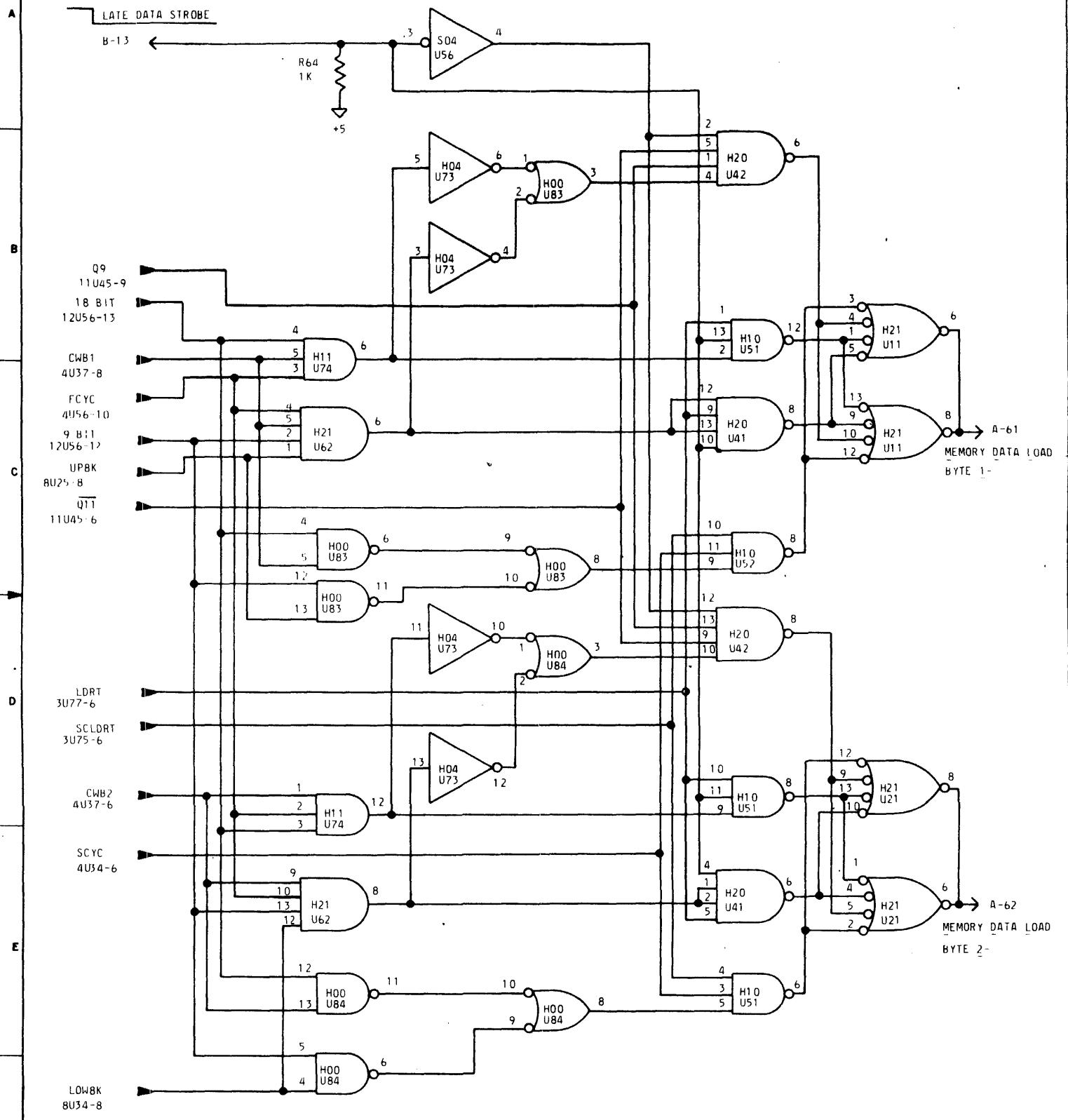
LHIF  
3U35-6

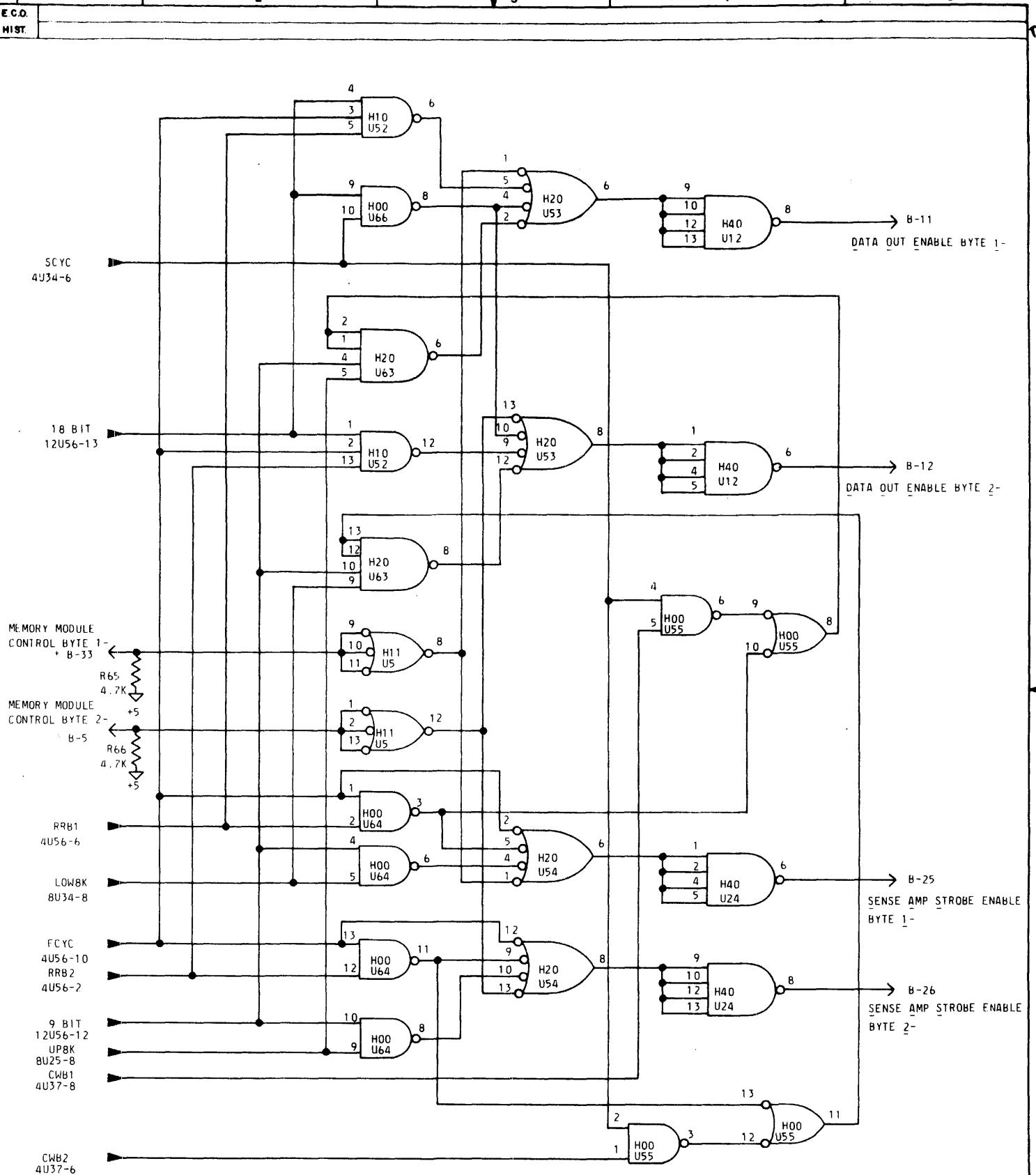


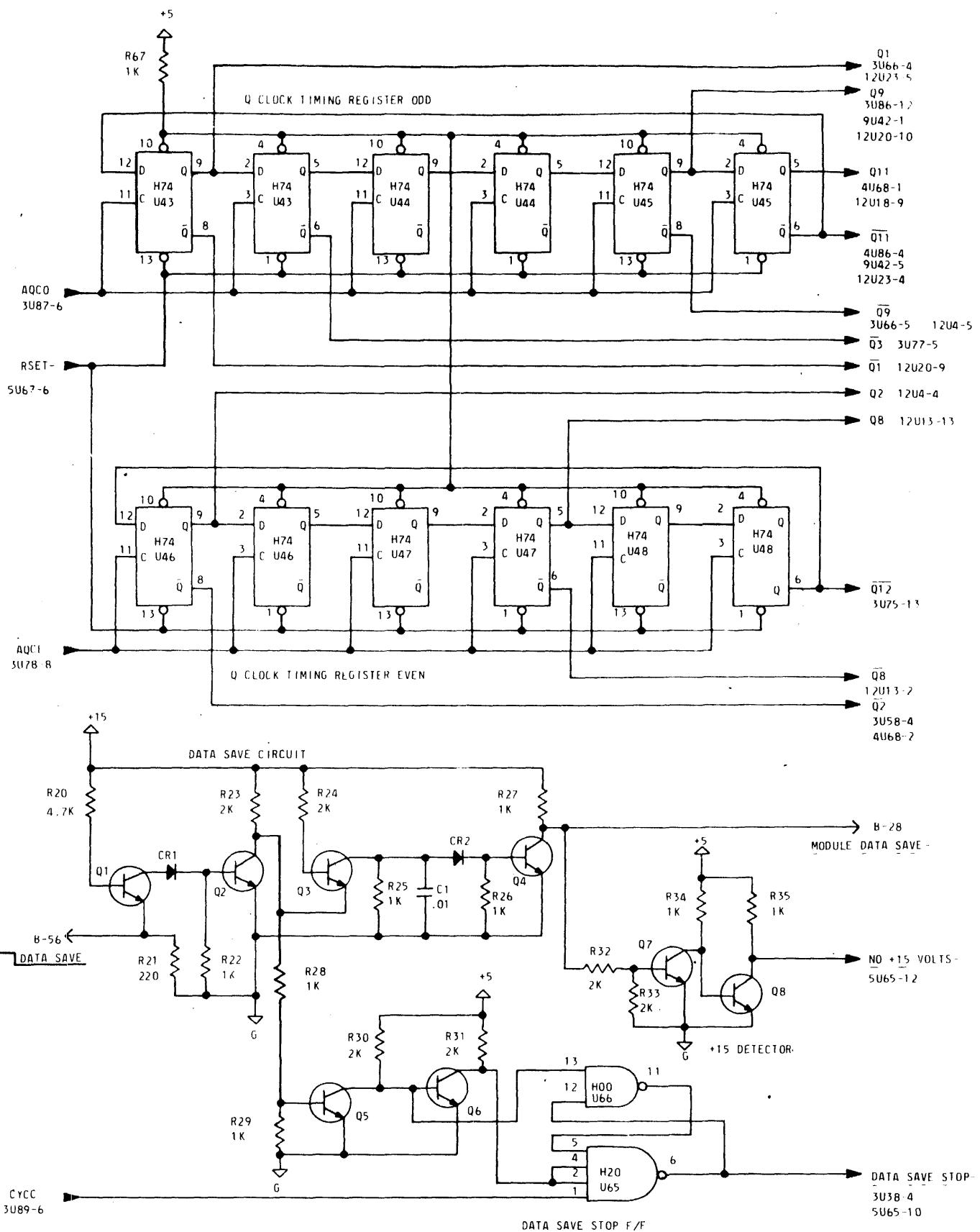
\* USE ONLY WITH 9 BIT SYSTEM, WILL BE DRIVEN BY  $2^{13}$ .

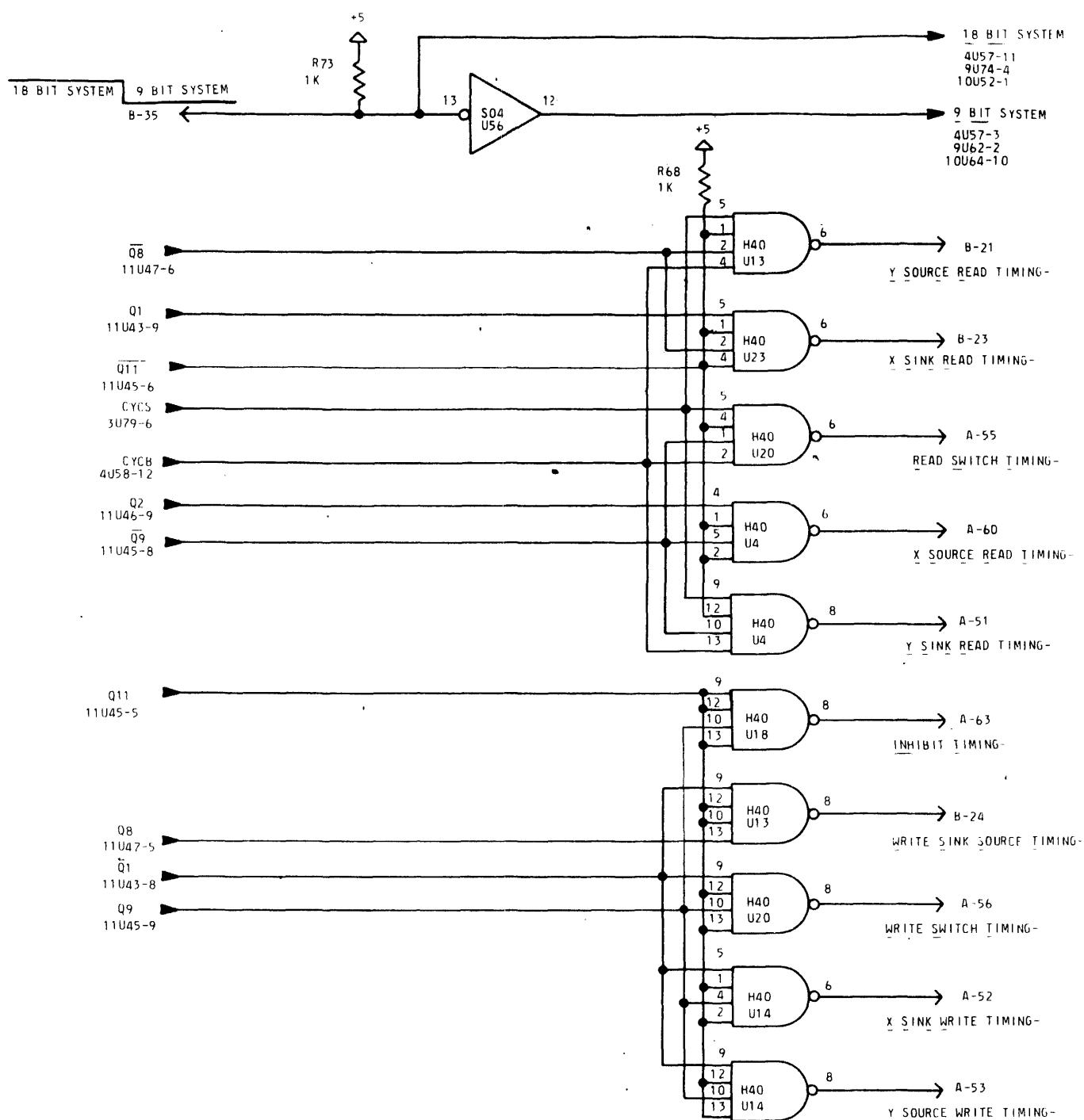
\*\* NOT USED

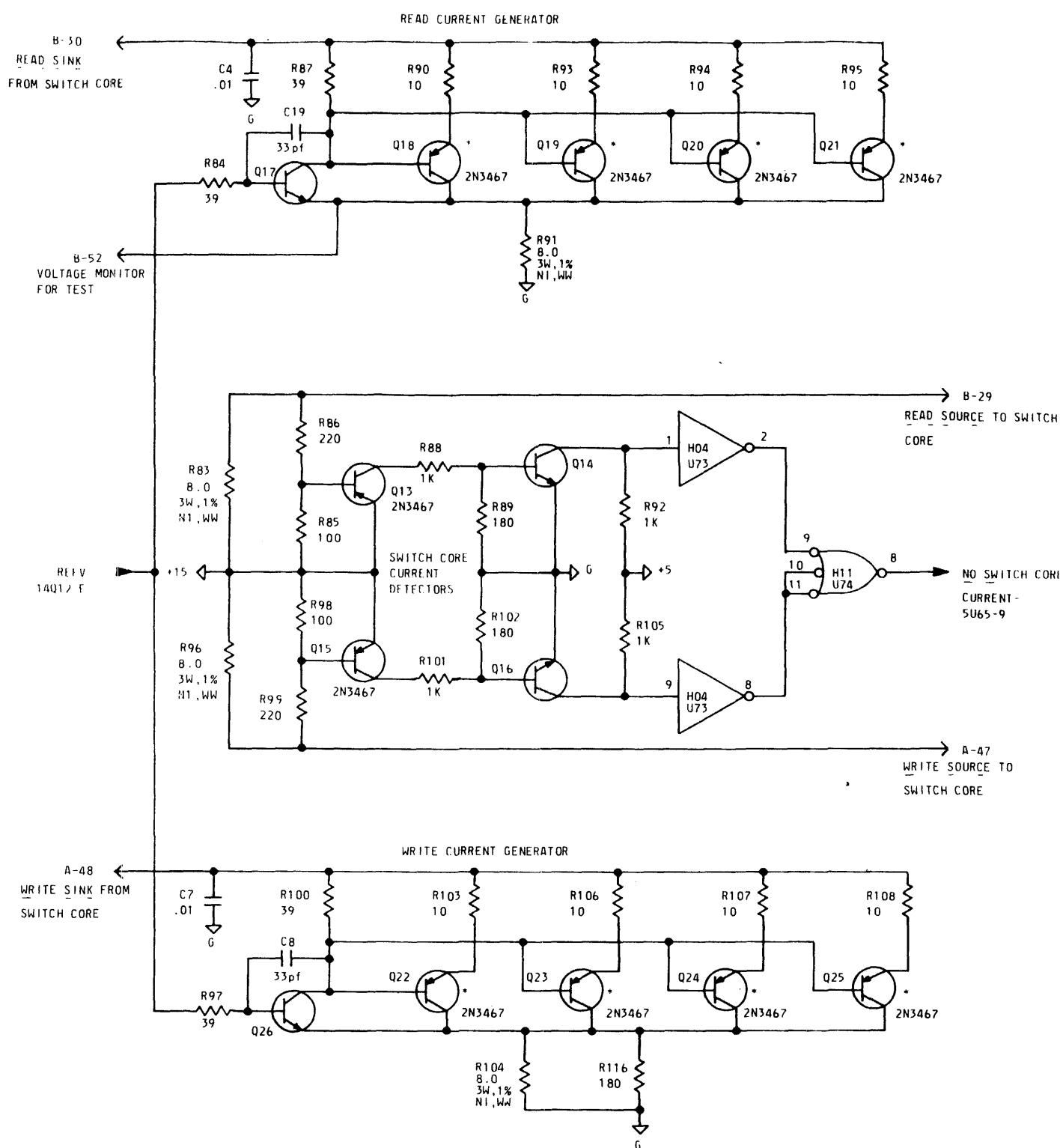
E.C.O. F 2 3 4 5  
HIST.



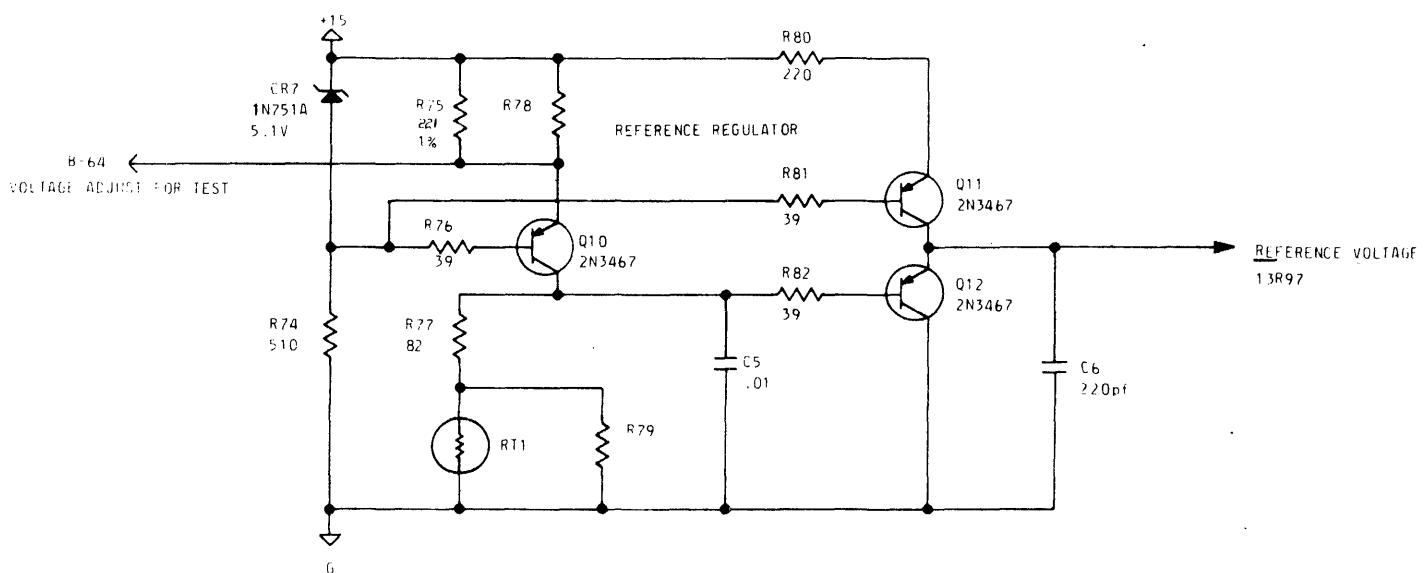
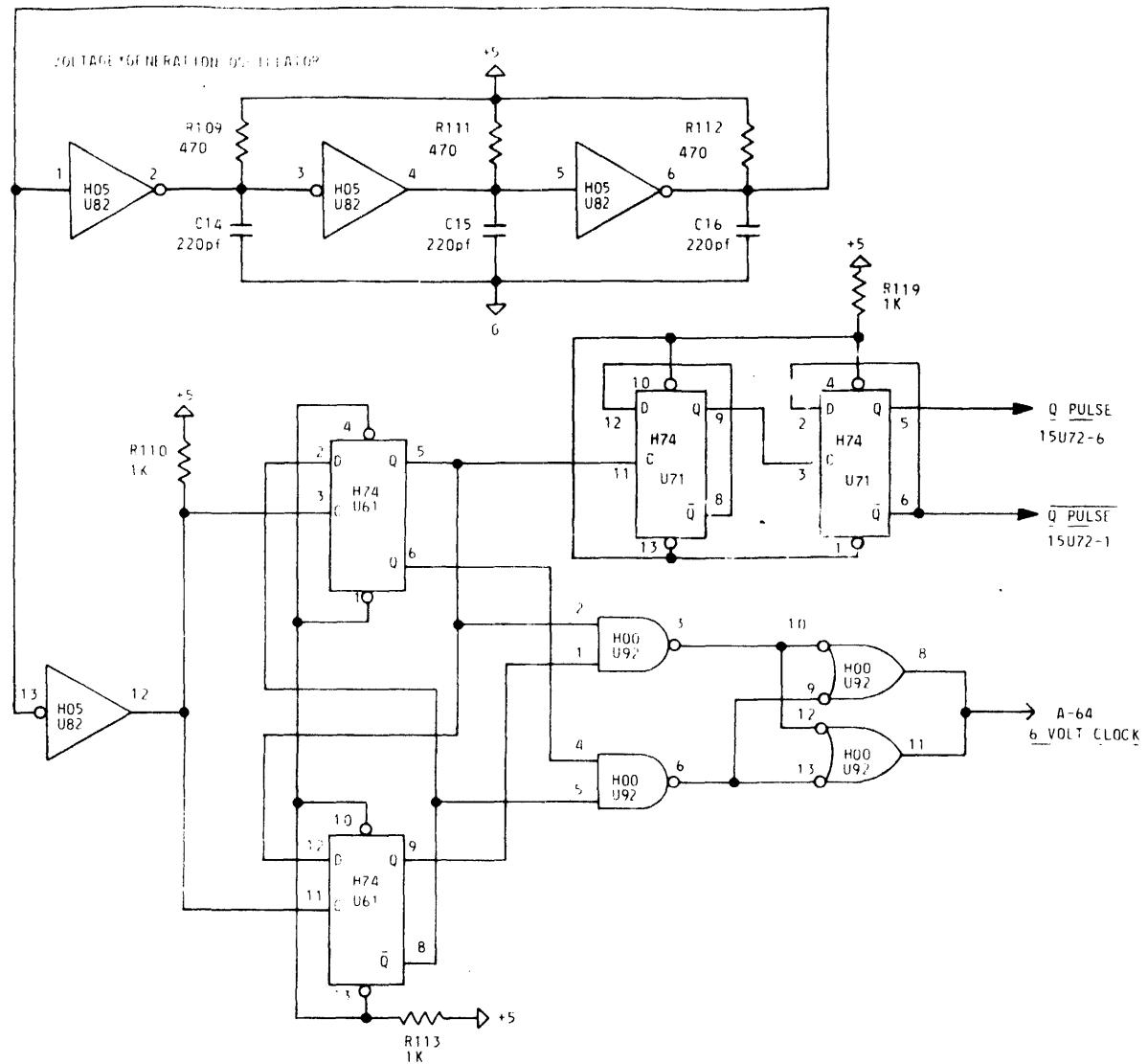




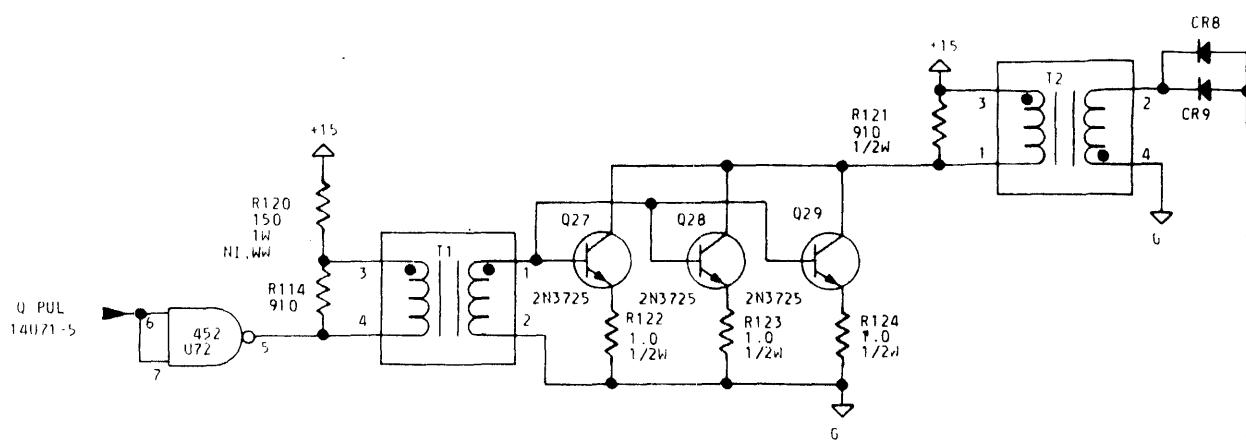




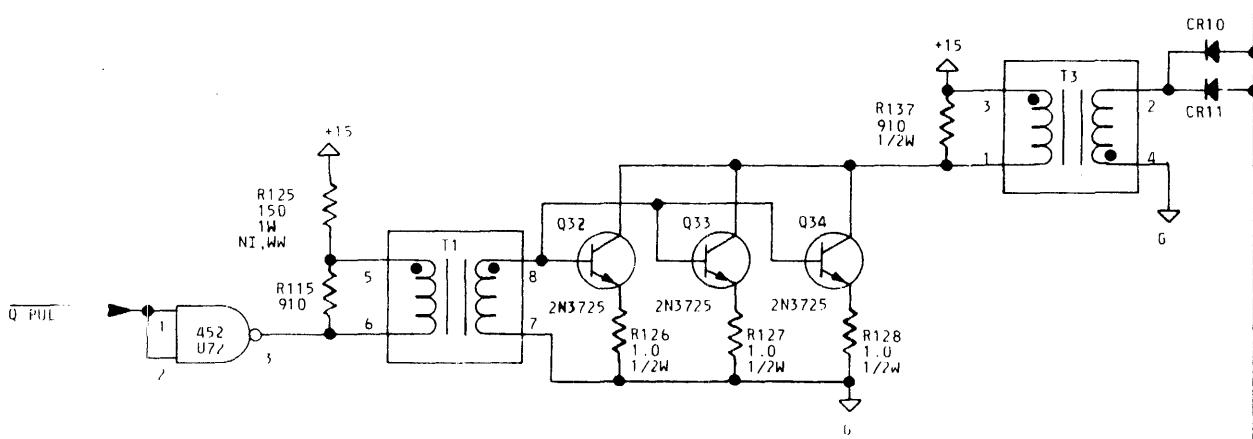
\* HEAT SUNKED



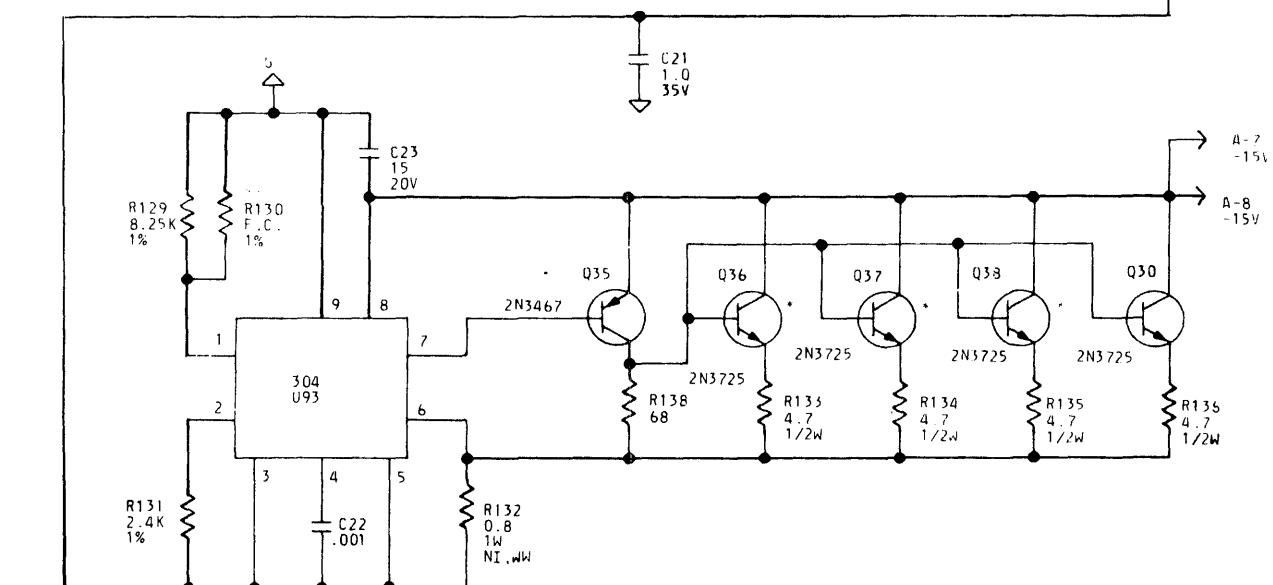
A



B



C



D

\* HEAT SINK

\*\* F.C. MEANS FACTORY SELECT. THE VALUE OF THIS RESISTOR IS DETERMINED BY THE FACTORY DURING TEST.

7

F

NOTES: APPLICABLE THROUGHOUT THIS SCHEMATIC.

1. UNLESS OTHERWISE STATED:

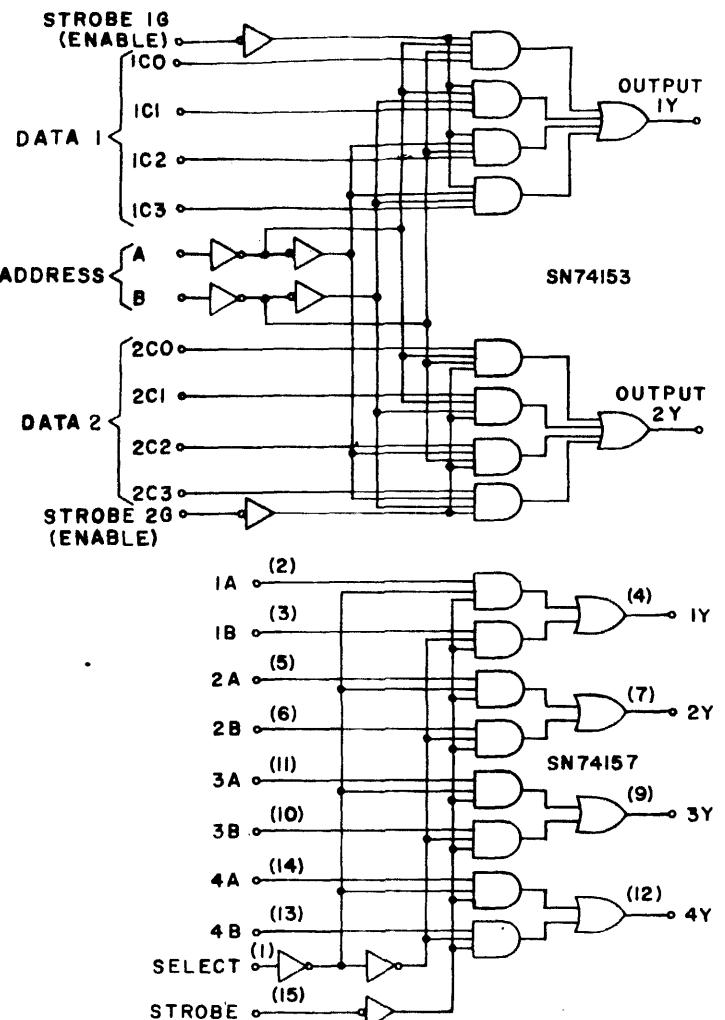
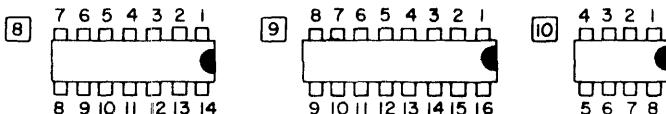
    - A. RESISTANCE VALUES ARE IN OHMS. RESISTORS ARE 5% TOLERANCE, 1/4 WATT.
    - B. CAPACITANCE VALUES ARE IN MICROFARADS.
    - C. ALL RESISTORS TO +5 ARE 330.  
ALL RESISTORS TO GND ARE 390.
  2. JEDEC OR MANUFACTURER'S PART NUMBERS ARE FOR REFERENCE ONLY. FOR EXPLICIT DESCRIPTION OF THE DEVICE CHARACTERISTICS, REFER TO THE FABRI-TEK SPECIFICATION FOR THE FABRI-TEK PART NUMBER.

|                         | DATE    |
|-------------------------|---------|
| DRAWN D. HANSEN         | 2-16-73 |
| CHECKED <i>D Hansen</i> | 3-26-73 |

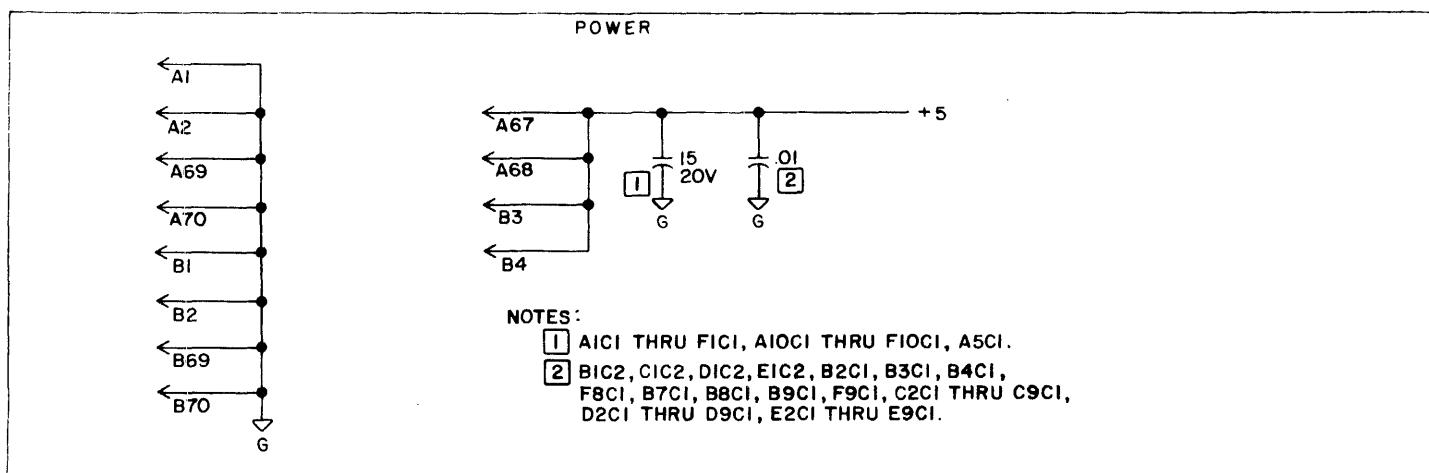
**TITLE** SCHEMATIC, 24K X 12 MULTIPLEXER  
**DWG. NO.** C 138-001880      **TYPE** 960-0500-00      **VERS.**      **PAGE** 1 OF 12

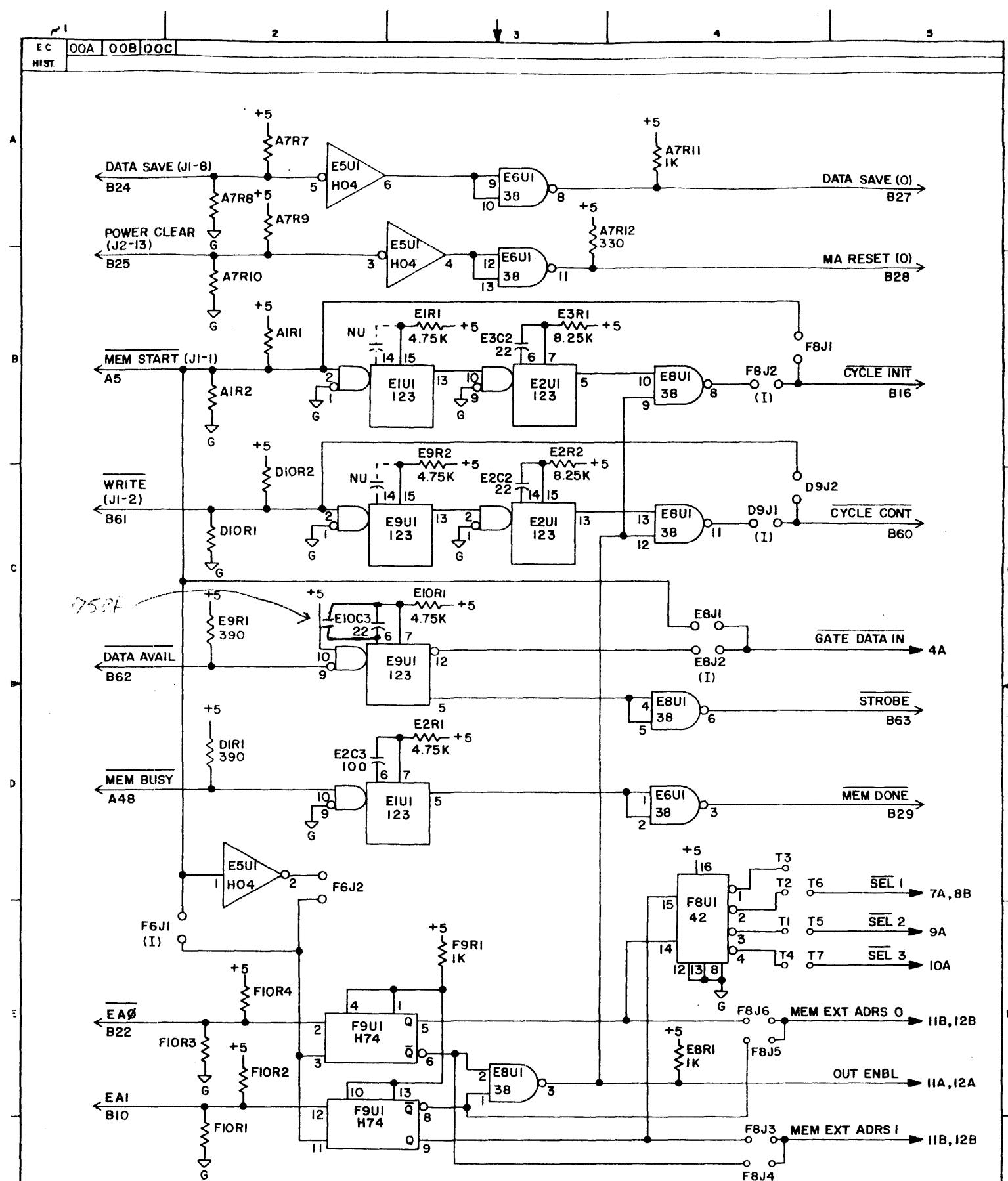
**NOTES: FOR REFERENCE ONLY**

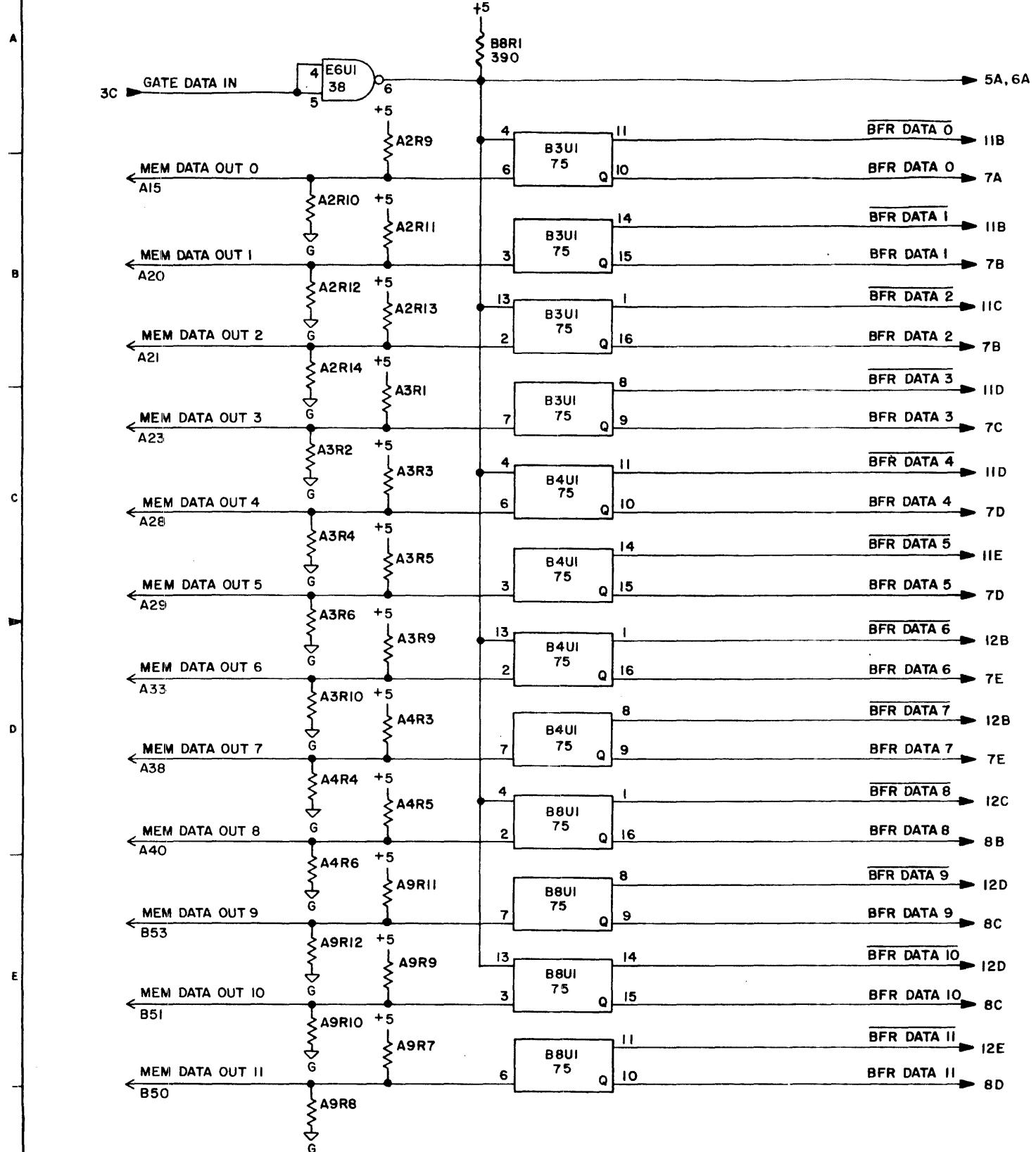
- 1 TEXAS INSTRUMENTS INC.
  - 2 SPRAGUE ELECTRIC CO.
  - 3 TTL IC.H CODE PREFIX INDICATES HIGH SPEED, S PREFIX  
INDICATES SCHOTTKY-CLAMPED VERY HIGH SPEED
  - 4 +5 VDC TERMINAL 14, GROUND TERMINAL 7
  - 5 +5VDC TERMINAL 16, GROUND TERMINAL 8
  - 6 +5VDC TERMINAL 5, GROUND TERMINAL 13
  - 7 +5VDC TERMINAL 8, GROUND TERMINAL 4

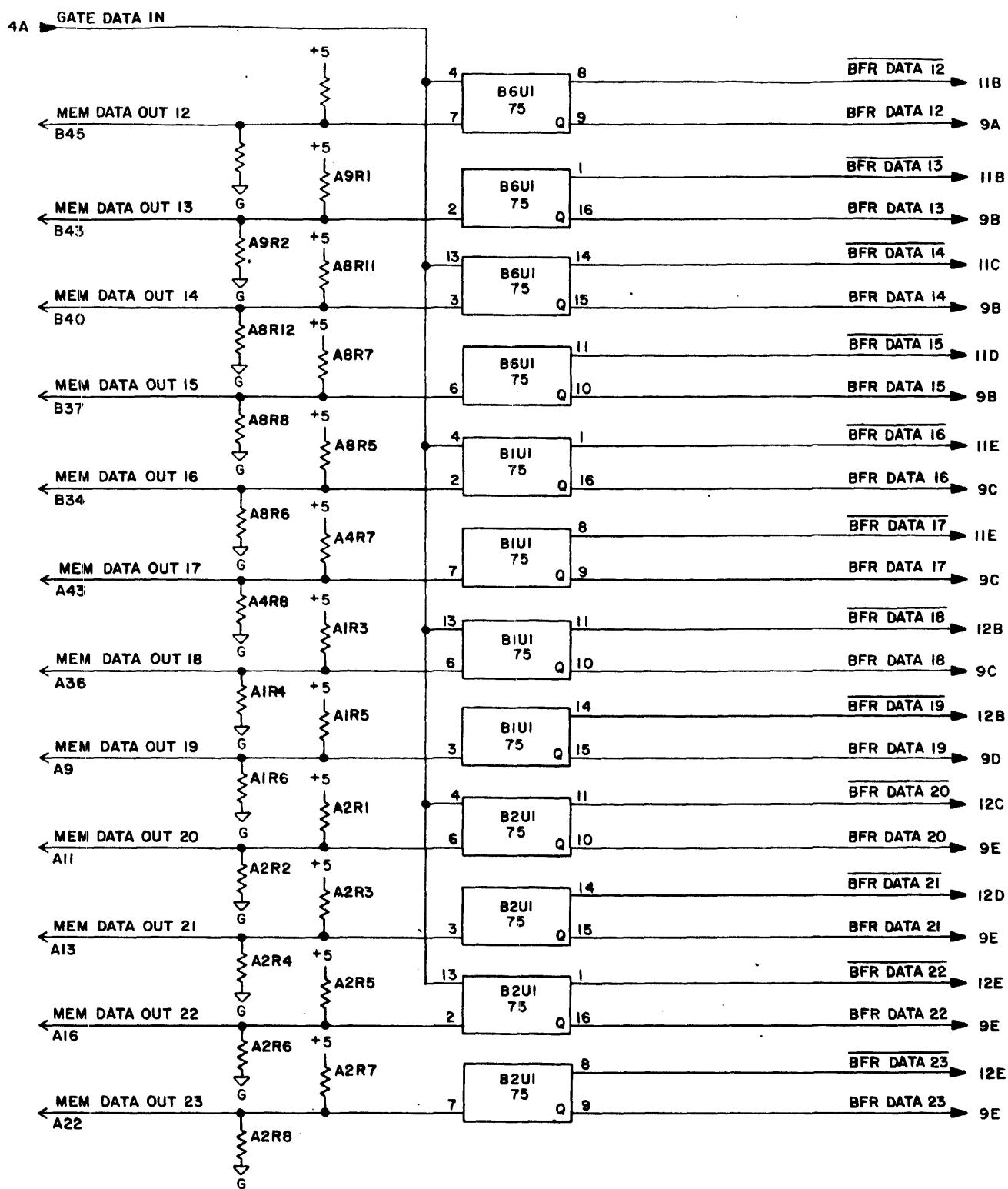


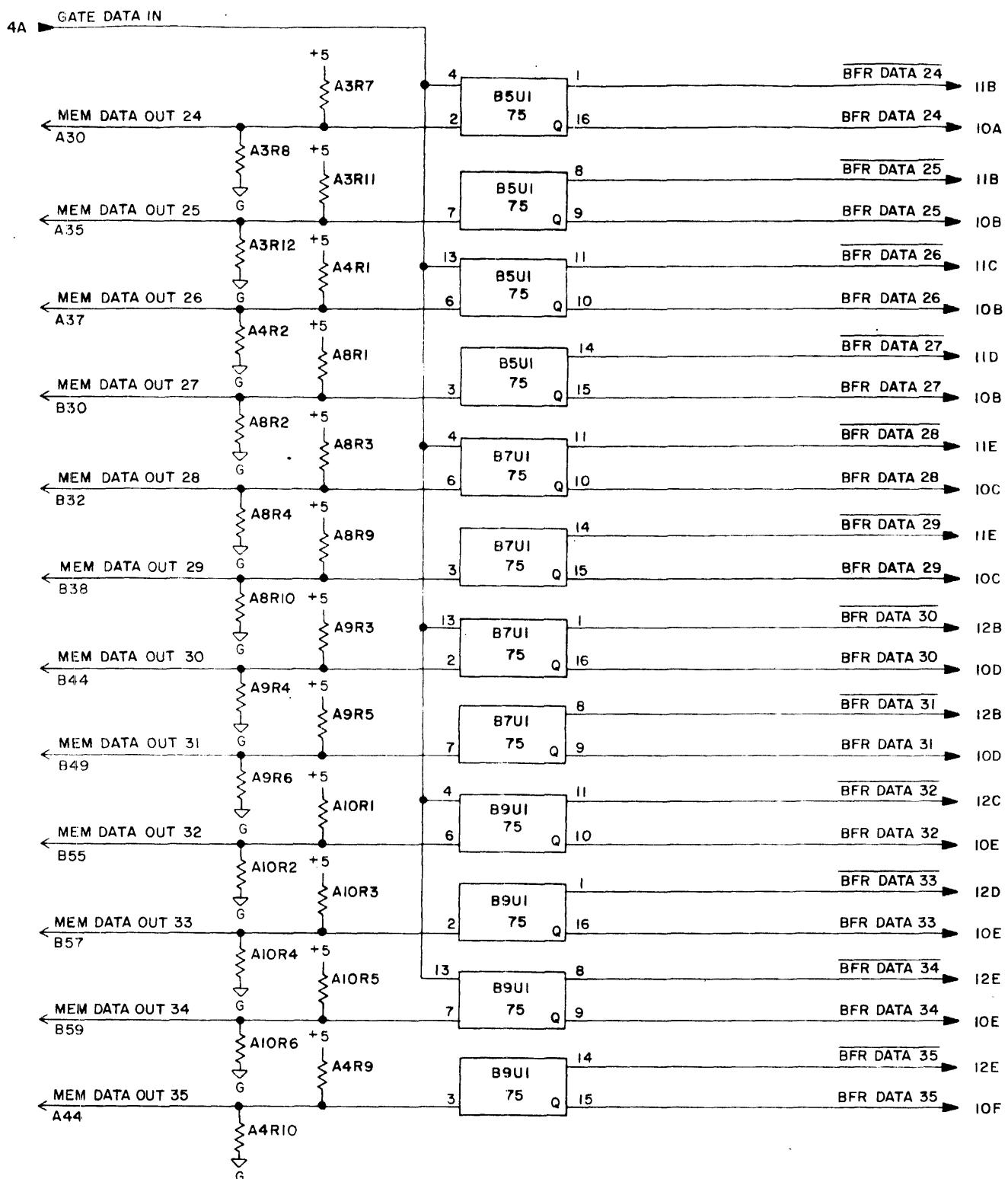
| CODE                   | REF. DESIG. | OUTPUT TERMINAL NO. |
|------------------------|-------------|---------------------|
| UNUSED MODULE ELEMENTS |             |                     |

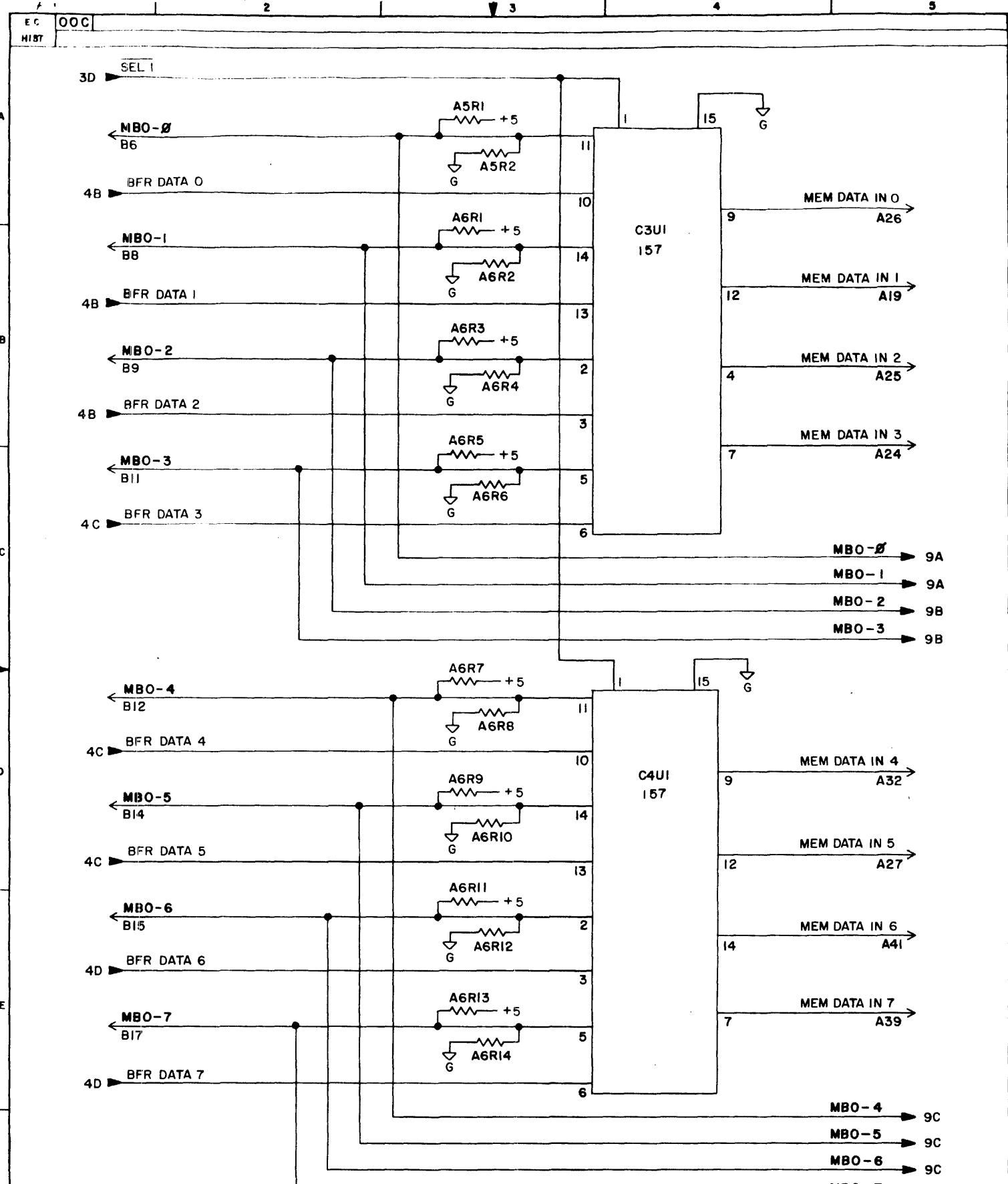


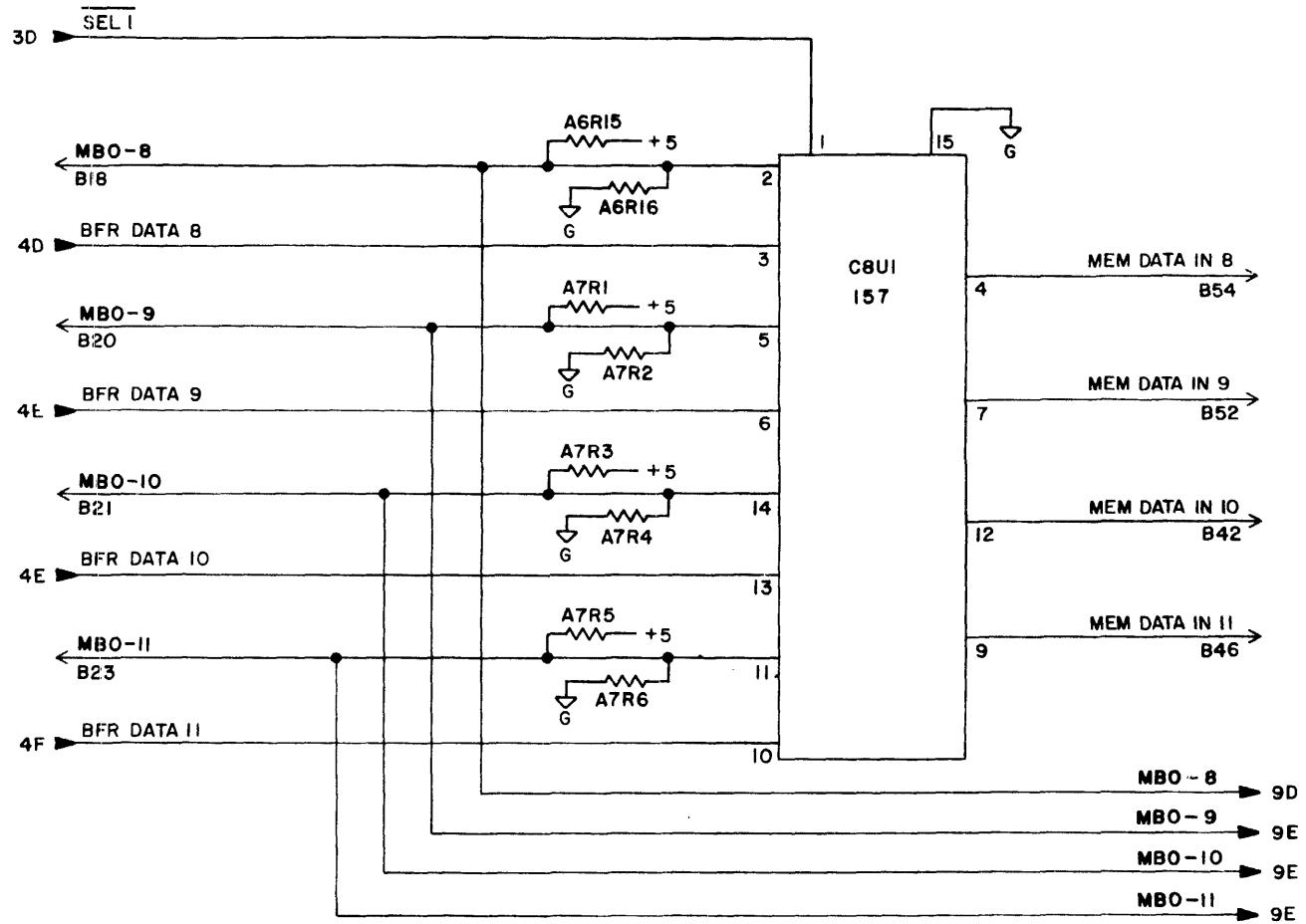










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## TITLE SCHEMATIC, 24K X 12 MULTIPLEX

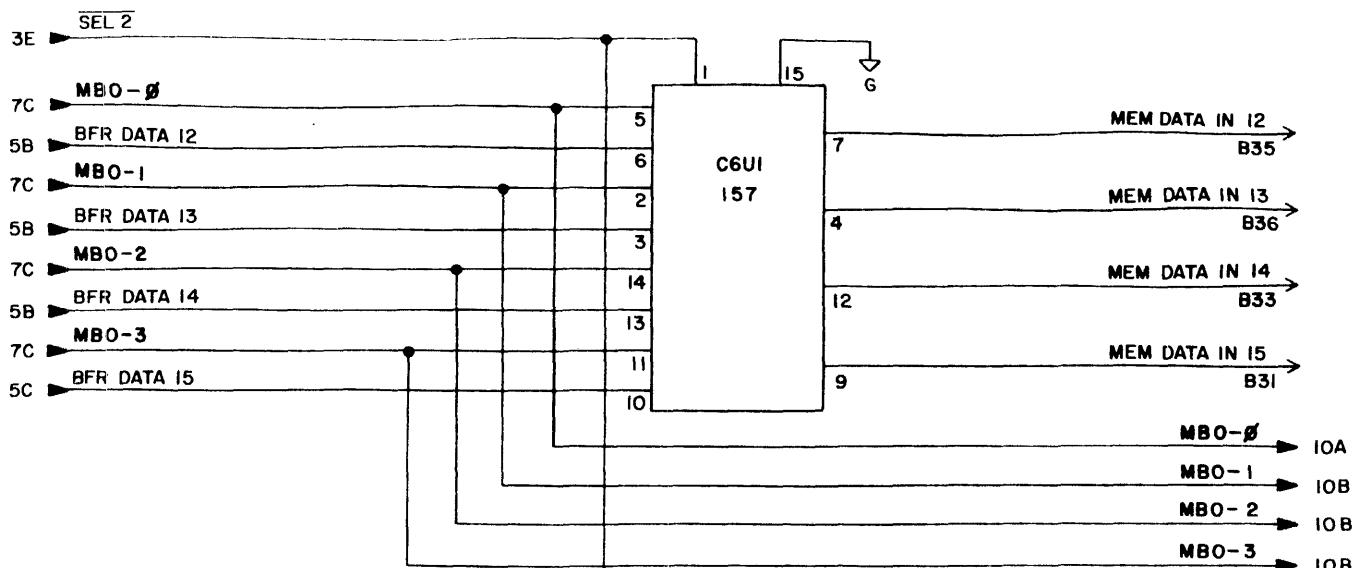
DWG. NO. C 138-001880

TYPE

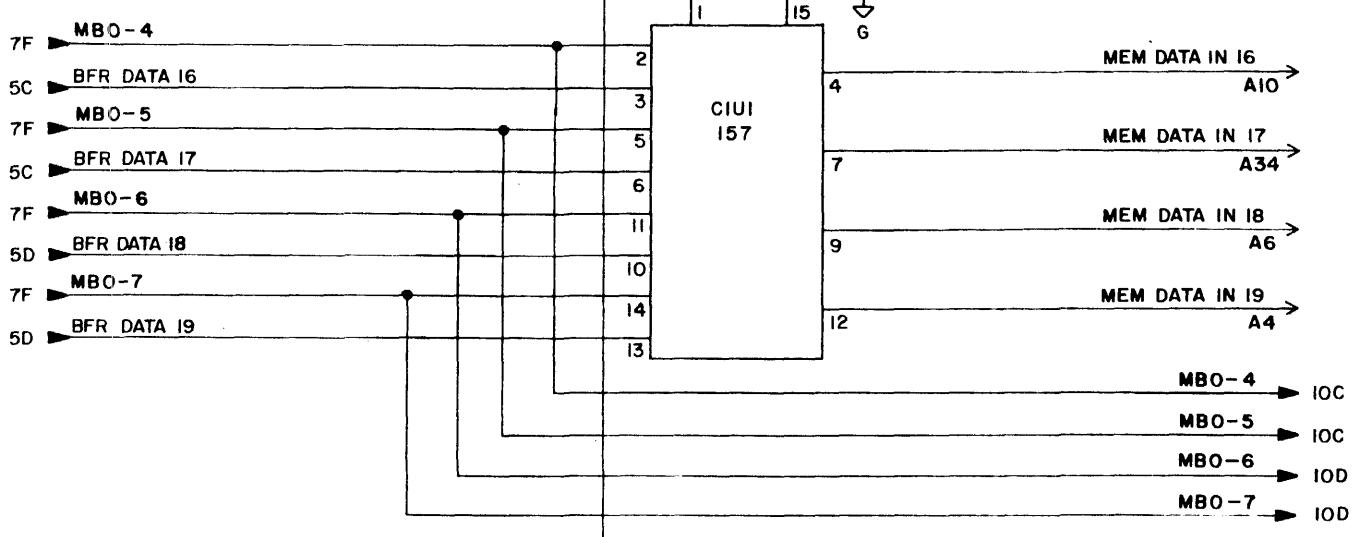
VERS.

PAGE 8

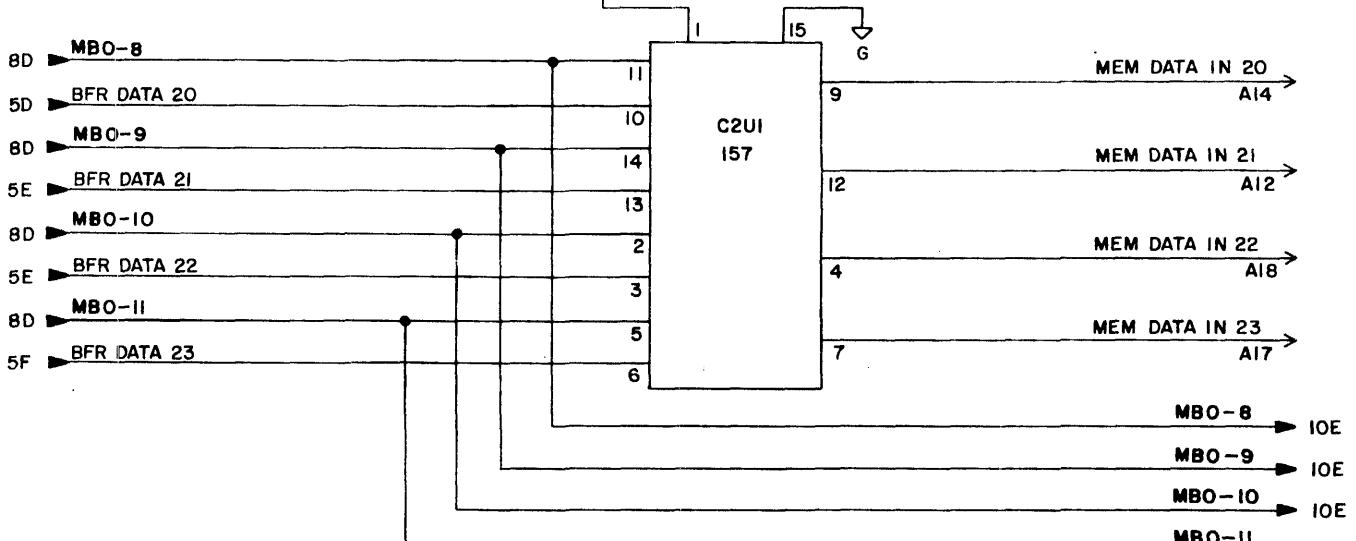
A



B



D



E

F

FABRI-TEK INC.  
MEMORY PRODUCTS DIVISION

## TITLE SCHEMATIC, 24K X 12 MULTIPLEXER

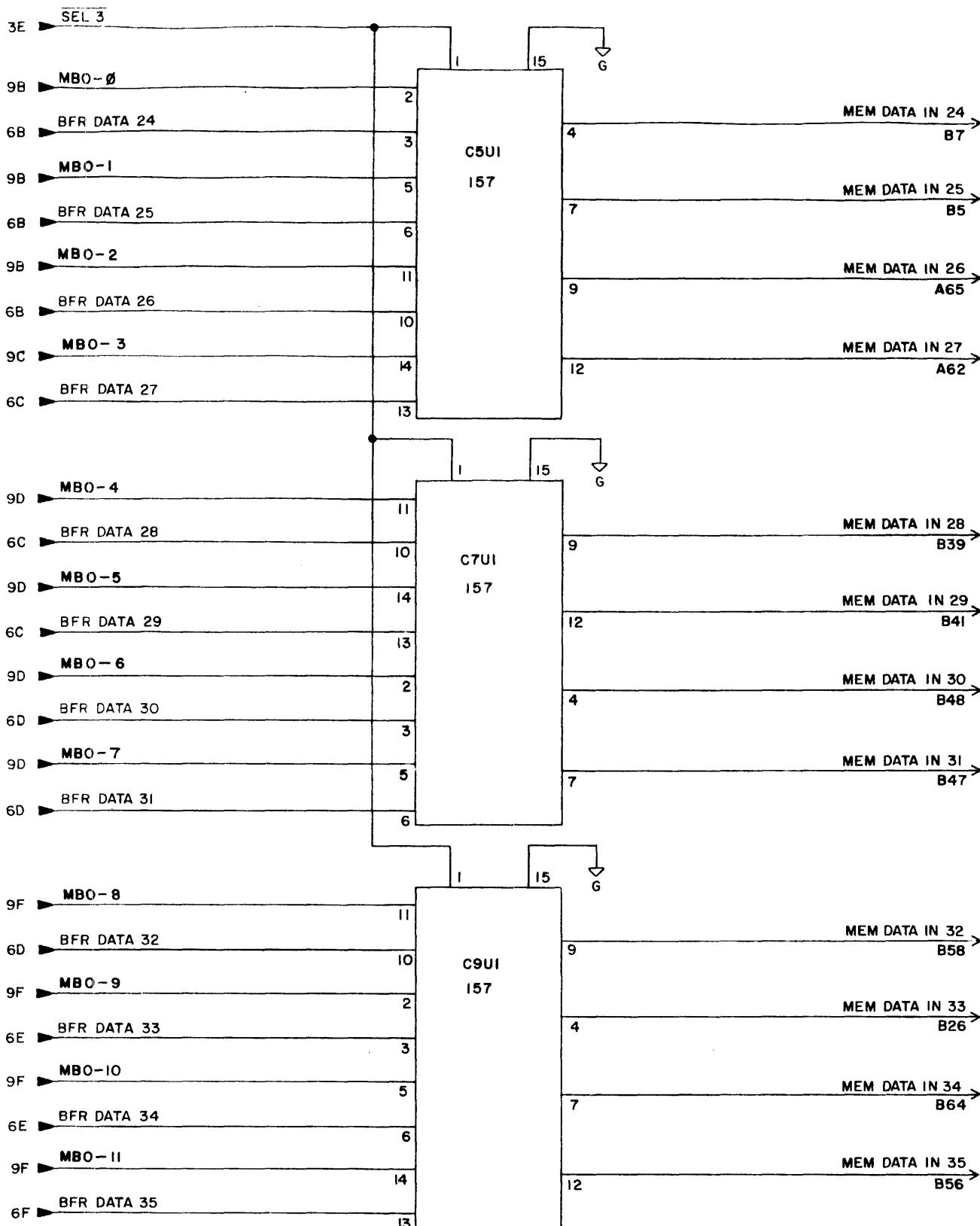
DWG NO.

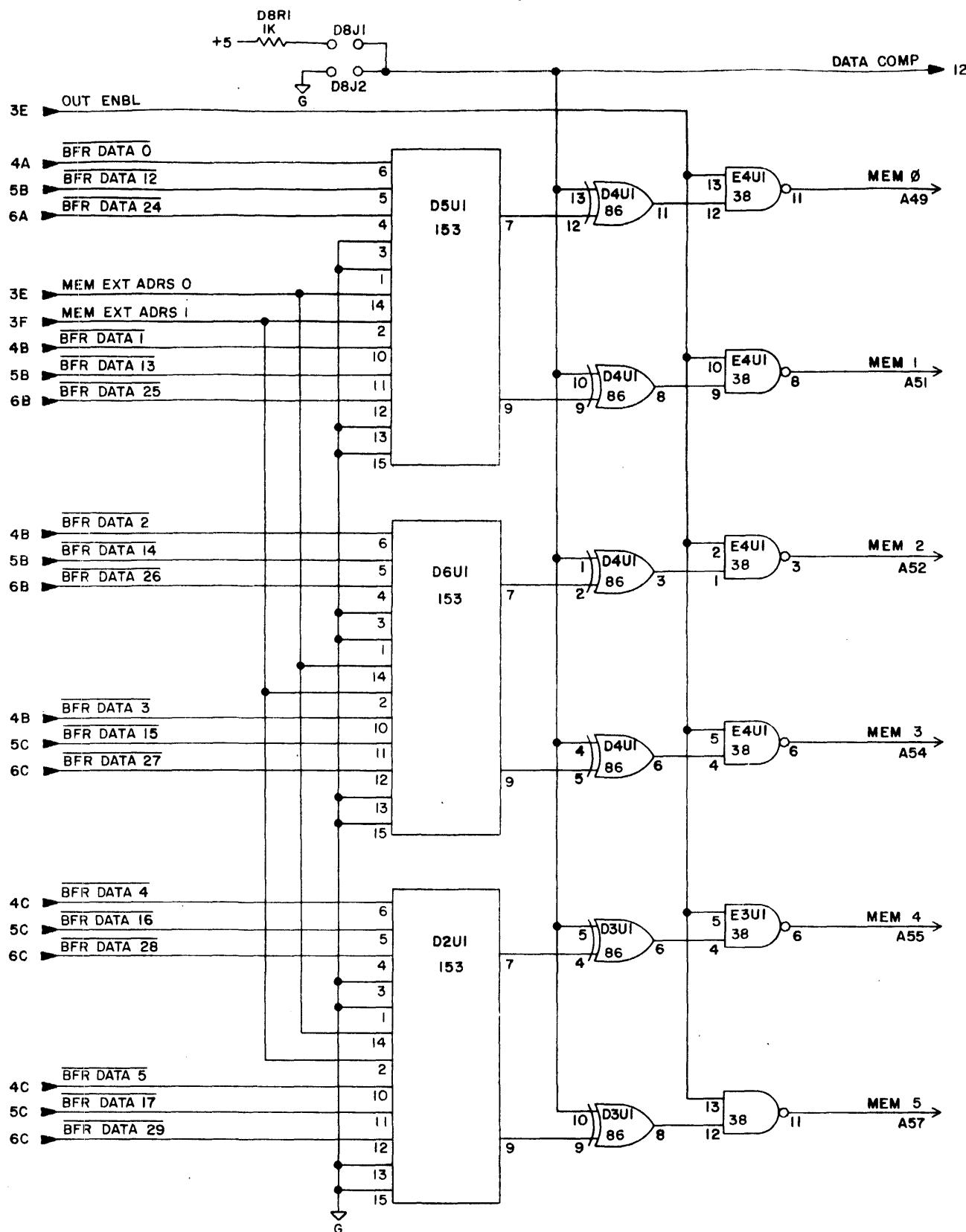
C 138-001880

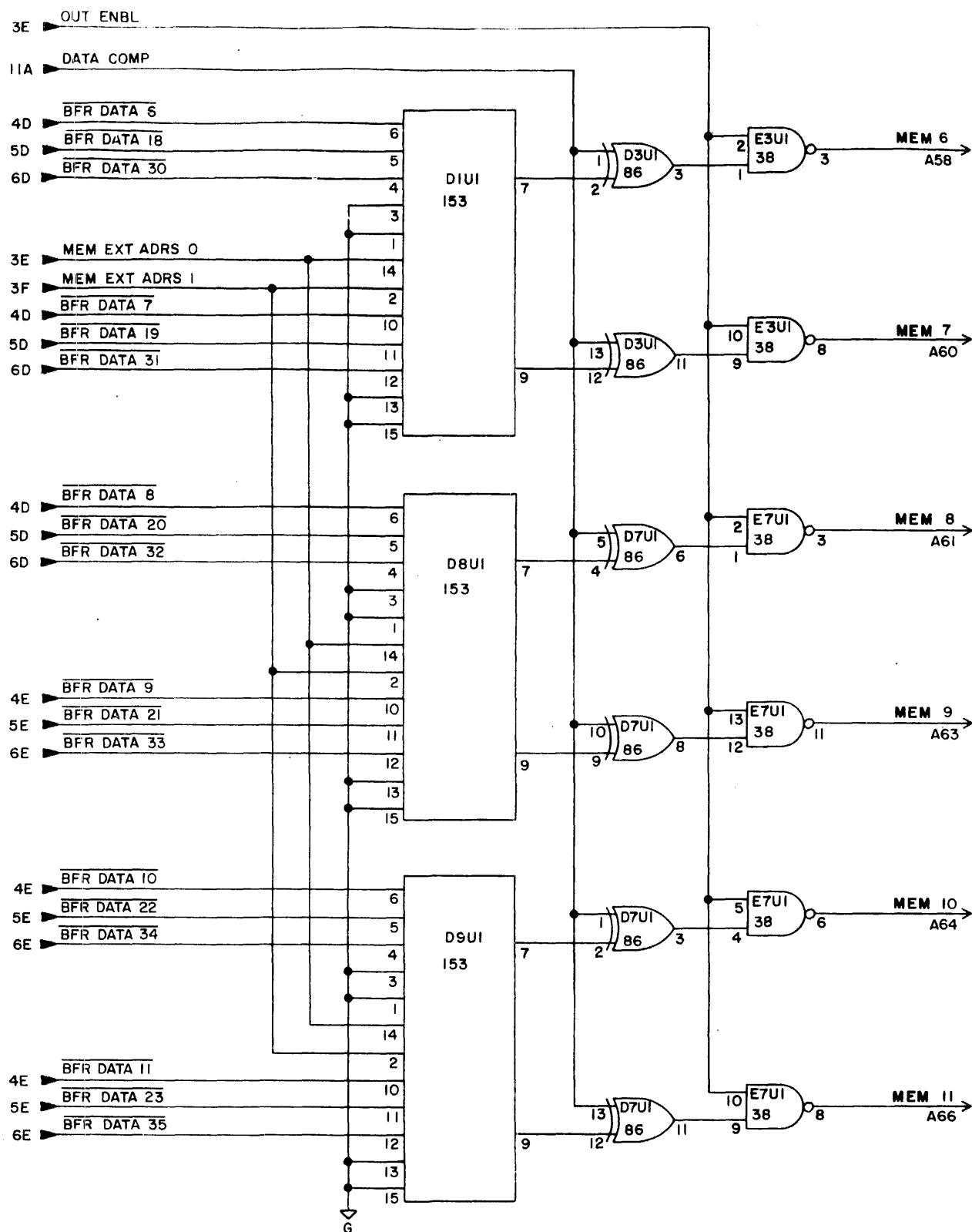
TYPE

VERS.

PAGE 9







**APPENDIX A**  
**ALPHABETICAL LISTING OF MEMORY SYSTEM MNEMONICS**

|       |                                   |          |                                    |
|-------|-----------------------------------|----------|------------------------------------|
| AQCE  | Advance Q Clock Even              | PUP1     | Pull Up 1                          |
| AQCO  | Advance Q Clock Odd               | QPL1     | Q Pulse 1                          |
| CDRT  | Clear Data Reg. Timing            | QPL2     | Q Pulse 2                          |
| CWB1  | Clear Write Byte 1                | Q(+ No.) | Q Clock Timing                     |
| CWB2  | Clear Write Byte 2                |          | 1, 2, 3, 8, 9, 10, 11, 12          |
| CYCB  | Cycle Begin                       | RDSC     | Read Source to Switch Core         |
| CYCC  | Cycle Complete                    | REFV     | Reference Voltage                  |
| CYCE  | Cycle End                         | RRB1     | Read Restore Byte 1                |
| CYCI  | Cycle Initiate                    | RRB2     | Read Restore Byte 2                |
| CYCS  | Cycle Start                       | RSET     | Reset                              |
| DEC0  | Decode 0 thru                     | RSWT     | Read Switch Timing                 |
| DEC15 | Decode 15                         | SAS1     | Sense Amp Strobe Enable Byte 1     |
| DLIN  | Delay Line Input                  | SAS2     | Sense Amp Strobe Enable Byte 2     |
| DOE1  | Data Out Enable Byte 1            | SCBS     | Source Buss                        |
| DOE2  | Data Out Enable Byte 2            | SCCDRT   | Split Cycle Clear Data Reg. Timing |
| DOT   | Data Out Timing                   | SCLDRT   | Split Cycle Load Data Reg. Timing  |
| DSVS  | Data Save Stop                    | SCYC     | Split Cycle                        |
| FCYC  | Full Cycle                        | SKBS     | Sink Bus                           |
| IFT1  | Inhibit Flat Top Byte 1           | SO       | Sense Line Out                     |
| IFT2  | Inhibit Flat Top Byte 2           | STB1     | Strobe Byte 1                      |
| INHT  | Inhibit Timing                    | STB2     | Strobe Byte 2                      |
| IRT1  | Inhibit Rise Time Byte 1          | SV1      | Sense Voltage 1                    |
| IRT2  | Inhibit Rise Time Byte 2          | SV2      | Sense Voltage 2                    |
| LDIF  | Load Interface                    | UP8K     | Upper 8K                           |
| LDRT  | Load Data Reg. Timing             | VSA      | Voltage - Sense Amplifier          |
| LHIF  | Latch Interface                   | VTH      | Voltage Threshold                  |
| LOW8K | Lower 8K                          | WRSC     | Write Source to Switch Core        |
| MA00  | Memory Address 00 thru            | WSST     | Write Sink Source Timing           |
| MA12  | Memory Address 12                 | WSWT     | Write Switch Timing                |
| MCL1  | Memory Data Register Clear Byte 1 | XSKW     | X Sink Write Timing                |
| MCL2  | Memory Data Register Clear Byte 2 | XSCRT    | X Source Read Timing               |
| MDL1  | Memory Data Load Byte 1           | XSKR     | X Sink Read Timing                 |
| MDL2  | Memory Data Load Byte 2           | YSCR     | Y Source Read Timing               |
| MDSV  | Module Data Save                  | YSCW     | Y Source Write Timing              |
| MODS  | Module Select                     | YSKR     | Y Sink Read Timing                 |
| MS00  | Module Select 00 thru             | 6VCK     | 6 Volt Clock                       |
| MS07  | Module Select 07                  | 9BIT     | 9 Bit System                       |
| NOSW  | No Switch Core Current            | 18BIT    | 18 Bit System                      |
| NO15  | No + 15V                          |          |                                    |

## COMMENT SHEET

Manual Title: \_\_\_\_\_

Publication Number: \_\_\_\_\_ Title Page Revision Letter: \_\_\_\_\_

From: Name \_\_\_\_\_

Business Address \_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_  
\_\_\_\_\_

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